RowHammer

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November 8, 2018

Top Picks in Hardware and Embedded Security

SAFARI

ETH zürich

Carnegie Mellon

The RowHammer Paper (ISCA 2014)

- Yoongu Kim, Ross Daly, Jeremie Kim, Chris Fallin, Ji Hye Lee, Donghyuk Lee, Chris Wilkerson, Konrad Lai, and Onur Mutlu,
  "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors"
  *Proceedings of the 41st International Symposium on Computer Architecture (**ISCA**)*, Minneapolis, MN, June 2014.
  [Slides (pptx) (pdf)] [Lightning Session Slides (pptx) (pdf)] [Source Code and Data]

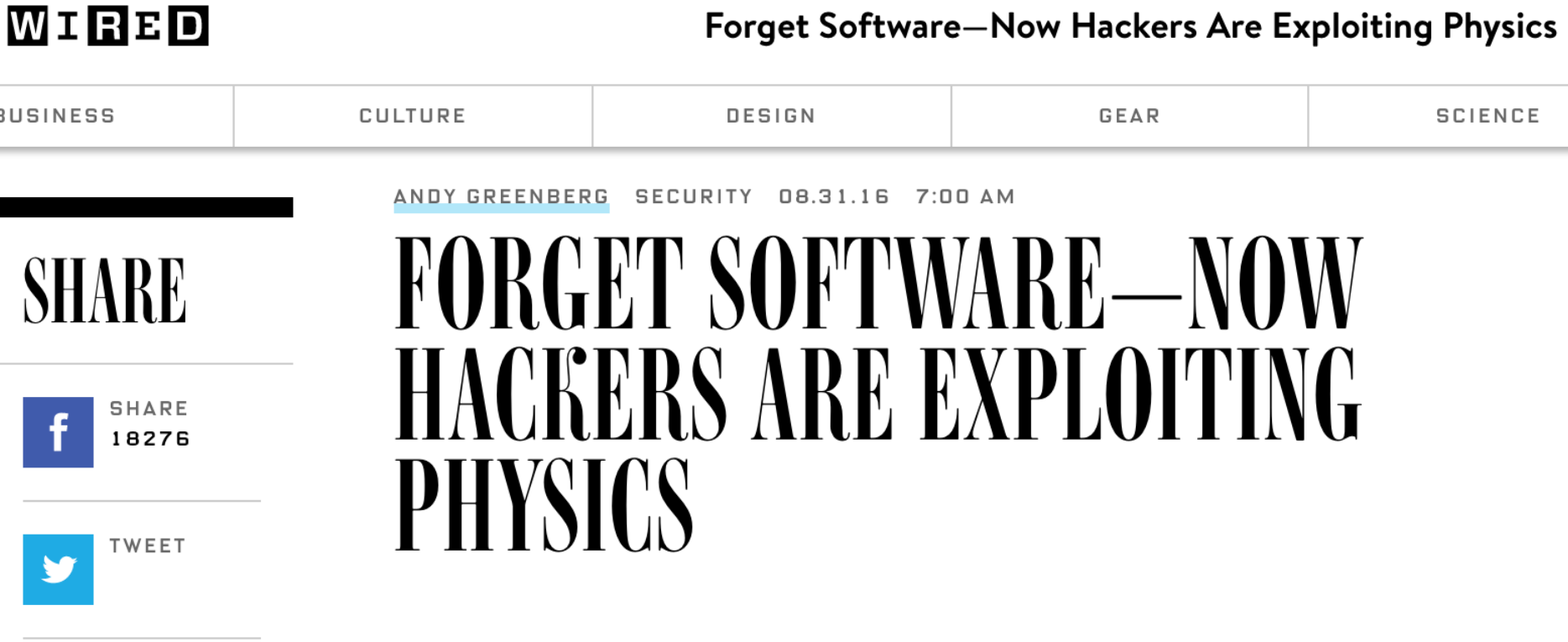
Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors

Yoongu Kim[1] Ross Daly* Jeremie Kim[1] Chris Fallin* Ji Hye Lee[1]
Donghyuk Lee[1] Chris Wilkerson[2] Konrad Lai Onur Mutlu[1]

[1]Carnegie Mellon University [2]Intel Labs

The Story of RowHammer

- One can predictably induce bit flips in commodity DRAM chips
  - >80% of the tested DRAM chips are vulnerable
- First example of how a simple hardware failure mechanism can create a widespread system security vulnerability



WIRED

Forget Software—Now Hackers Are Exploiting Physics

BUSINESS | CULTURE | DESIGN | GEAR | SCIENCE

SHARE

SHARE 18276

TWEET

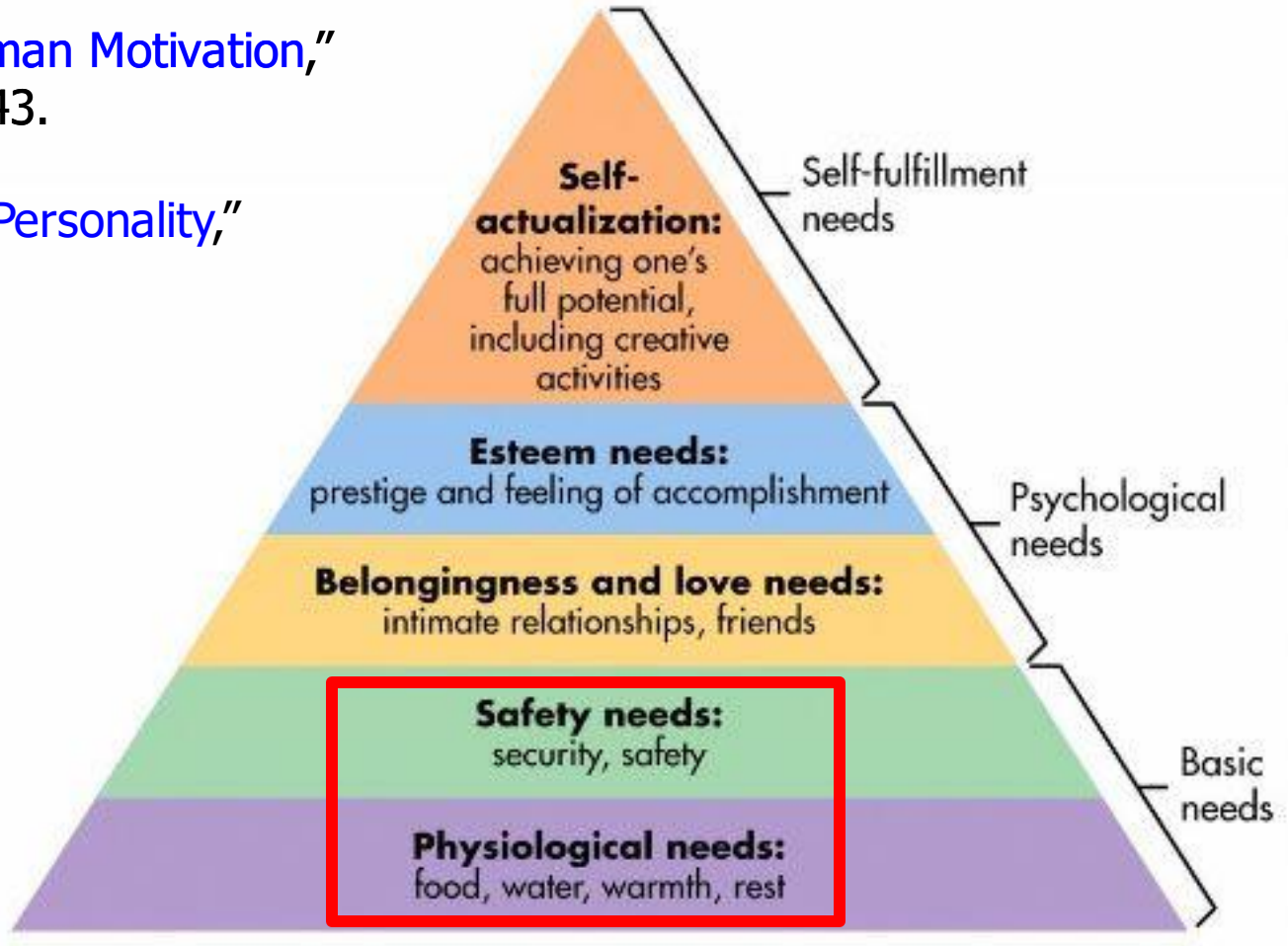
ANDY GREENBERG SECURITY 08.31.16 7:00 AM

FORGET SOFTWARE—NOW HACKERS ARE EXPLOITING PHYSICS

Maslow's (Human) Hierarchy of Needs

Maslow, "A Theory of Human Motivation," Psychological Review, 1943.

Maslow, "Motivation and Personality," Book, 1954-1970.



- We need to start with reliability and security...

Source: https://www.simplypsychology.org/maslow.html

Source: By User:Factoryjoe - Mazlow's Hierarchy of Needs.svg, CC BY-SA 3.0, https://commons.wikimedia.org/w/index.php?curid=7964065

How Reliable/Secure/Safe is This Bridge?

Source: http://www.technologystudent.com/struct1/tacom1.png

Collapse of the "Galloping Gertie"

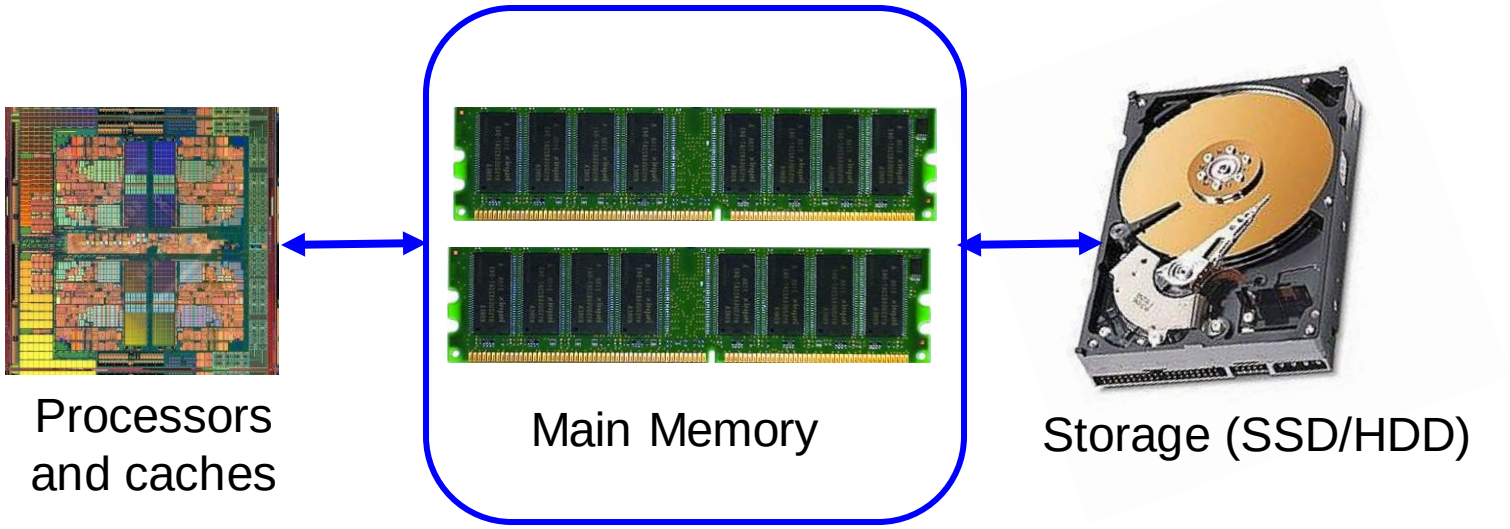
Source: AP
http://www.wsdot.wa.gov/tnbhistory/connections/connections3.htm

How Secure Are These People?

Security is about preventing unforeseen consequences

Source: https://s-media-cache-ak0.pinimg.com/originals/48/09/54/4809543a9c7700246a0cf8acdae27abf.jpg

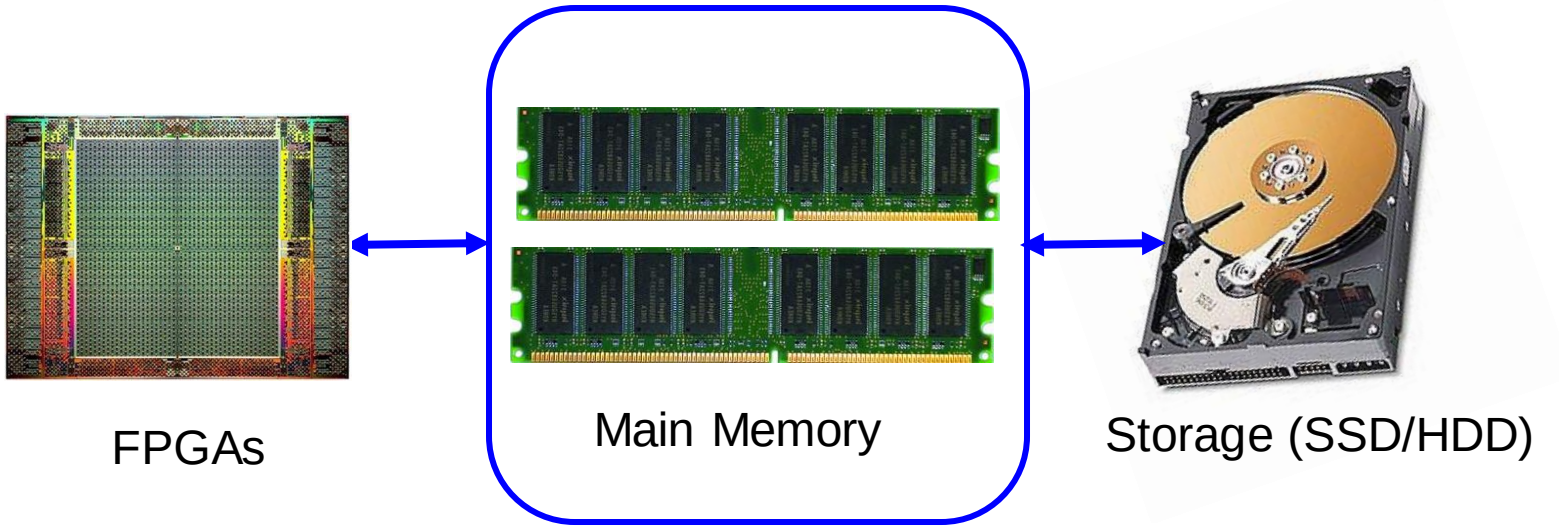
The Main Memory System



- Main memory is a critical component of all computing systems: server, mobile, embedded, desktop, sensor

- Main memory system must scale (in *size*, *technology*, *efficiency*, *cost*, and *management algorithms*) to maintain performance growth and technology scaling benefits

The Main Memory System



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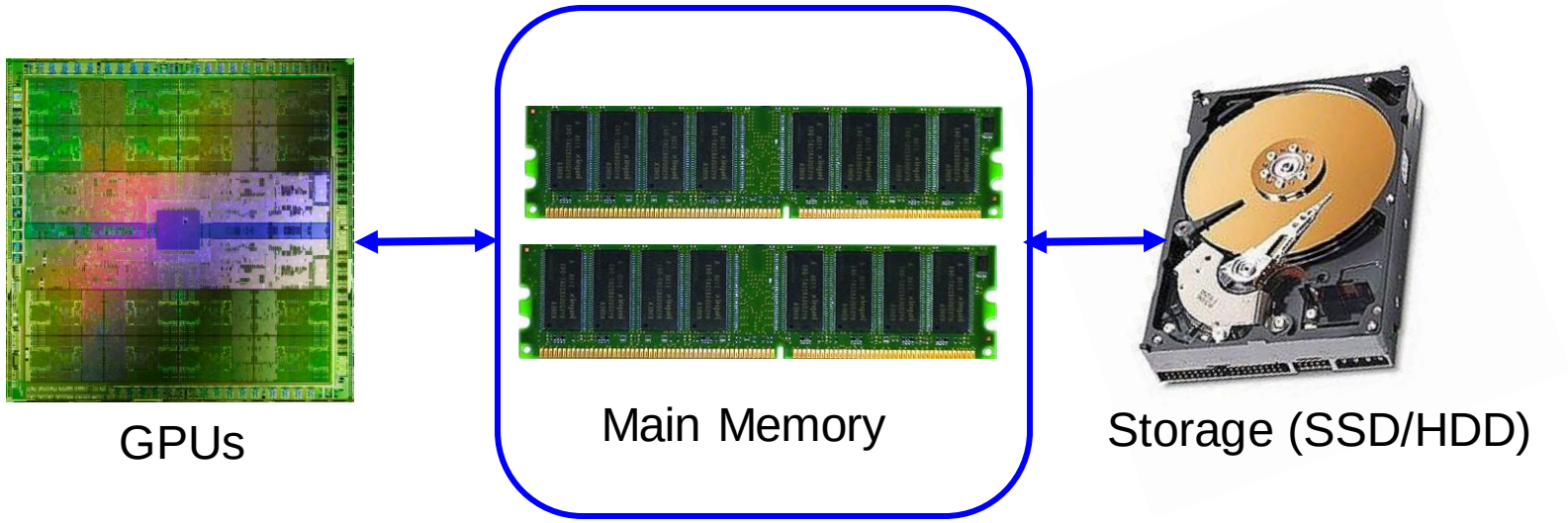


- Main memory is a critical component of all computing systems: server, mobile, embedded, desktop, sensor

- Main memory system must scale (in *size*, *technology*, *efficiency*, *cost*, and *management algorithms*) to maintain performance growth and technology scaling benefits

Major Trends Affecting Main Memory (I)

- Need for main memory capacity, bandwidth, QoS increasing
- Main memory energy/power is a key system design concern
- DRAM technology scaling is ending

Major Trends Affecting Main Memory (II)

- Need for main memory capacity, bandwidth, QoS increasing
  - Multi-core: increasing number of cores/agents
  - Data-intensive applications: increasing demand/hunger for data
  - Consolidation: cloud computing, GPUs, mobile, heterogeneity
- Main memory energy/power is a key system design concern
- DRAM technology scaling is ending

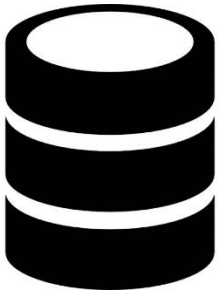
Major Trends Affecting Main Memory (III)

- Need for main memory capacity, bandwidth, QoS increasing

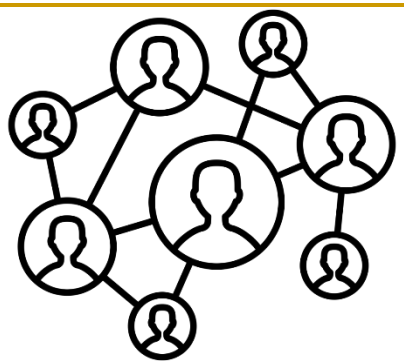
- Main memory energy/power is a key system design concern
  - ~40-50% energy spent in off-chip memory hierarchy [Lefurgy, IEEE Computer'03] >40% power in DRAM [Ware, HPCA'10][Paul,ISCA'15]
  - DRAM consumes power even when not used (periodic refresh)

- DRAM technology scaling is ending

DRAM Is Critical for Performance & Energy

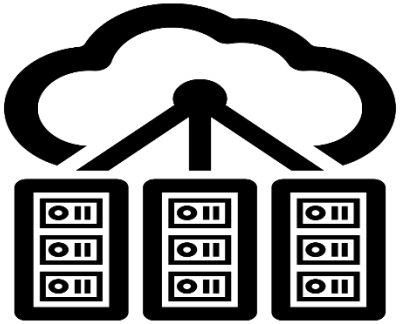


In-memory Databases
[Mao+, EuroSys'12;
Clapp+ (**Intel**), IISWC'15]



Graph/Tree Processing
[Xu+, IISWC'12; Umuroglu+, FPL'15]

In-Memory Data Analytics
[Clapp+ (**Intel**), IISWC'15;
Awan+, BDCloud'15]



Datacenter Workloads
[Kanev+ (**Google**), ISCA'15]

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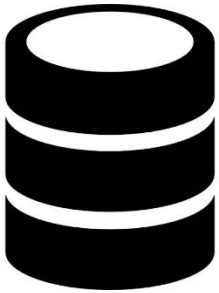

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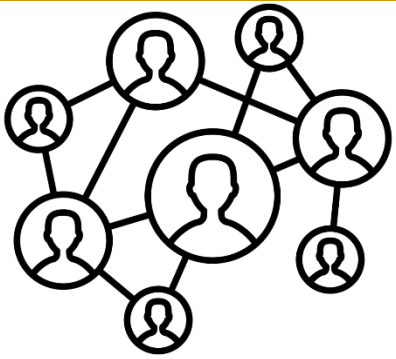
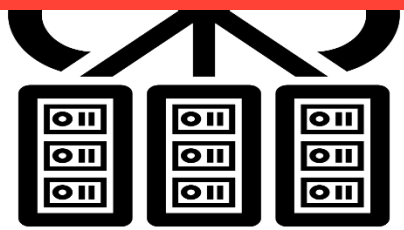


Graph/Tree Processing

Memory → performance & energy bottleneck

In-Memory Data Analytics

[Clapp+ (**Intel**), IISWC'15; Awan+, BDCloud'15]



Datacenter Workloads

[Kanev+ (**Google**), ISCA'15]

Major Trends Affecting Main Memory (IV)

- Need for main memory capacity, bandwidth, QoS increasing

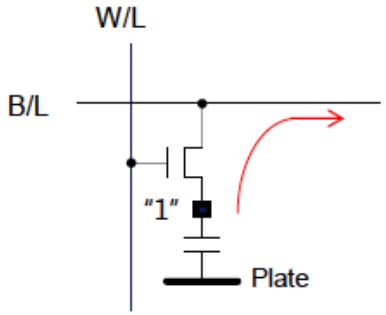
- Main memory energy/power is a key system design concern

- DRAM technology scaling is ending
  - ITRS projects DRAM will not scale easily below X nm
  - Scaling has provided many benefits:
    - higher capacity (density), lower cost, lower energy

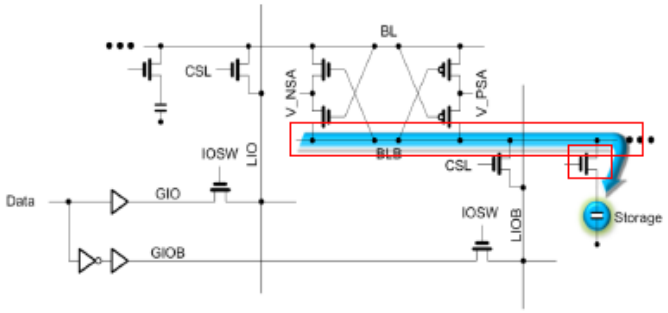
Industry Is Writing Papers About It, Too

DRAM Process Scaling Challenges

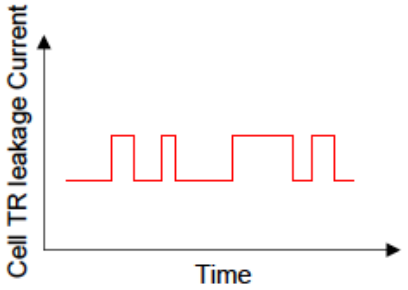
- **Refresh**
  - Difficult to build high-aspect ratio cell capacitors decreasing cell capacitance
  - Leakage current of cell access transistors increasing
- **tWR**
  - Contact resistance between the cell capacitor and access transistor increasing
  - On-current of the cell access transistor decreasing
  - Bit-line resistance increasing
- **VRT**
  - Occurring more frequently with cell capacitance decreasing



Refresh



tWR



VRT

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DRAM Process Scaling Challenges

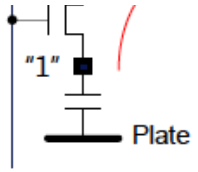
- **Refresh**
  - Difficult to build high-aspect ratio cell capacitors decreasing cell capacitance

THE MEMORY FORUM 2014

Co-Architecting Controllers and DRAM to Enhance DRAM Process Scaling

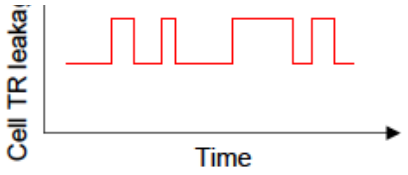
Uksong Kang, Hak-soo Yu, Churoo Park, *Hongzhong Zheng,
**John Halbert, **Kuljit Bains, SeongJin Jang, and Joo Sun Choi

*Samsung Electronics, Hwasung, Korea / *Samsung Electronics, San Jose / **Intel*



Refresh

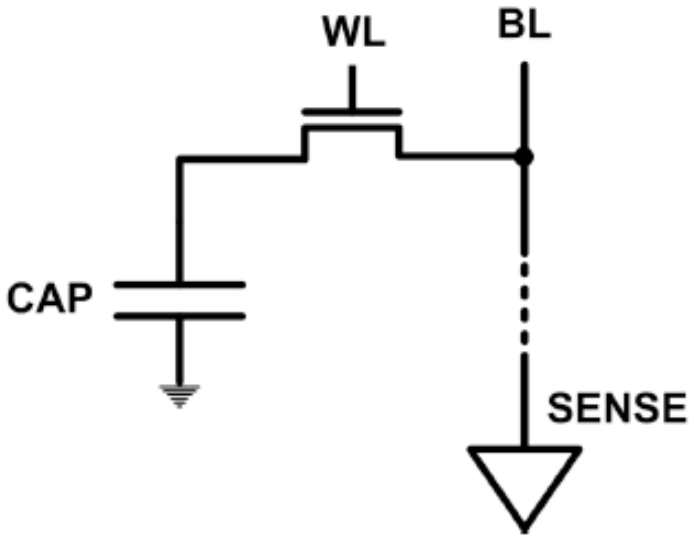
tWR



VRT

The DRAM Scaling Problem

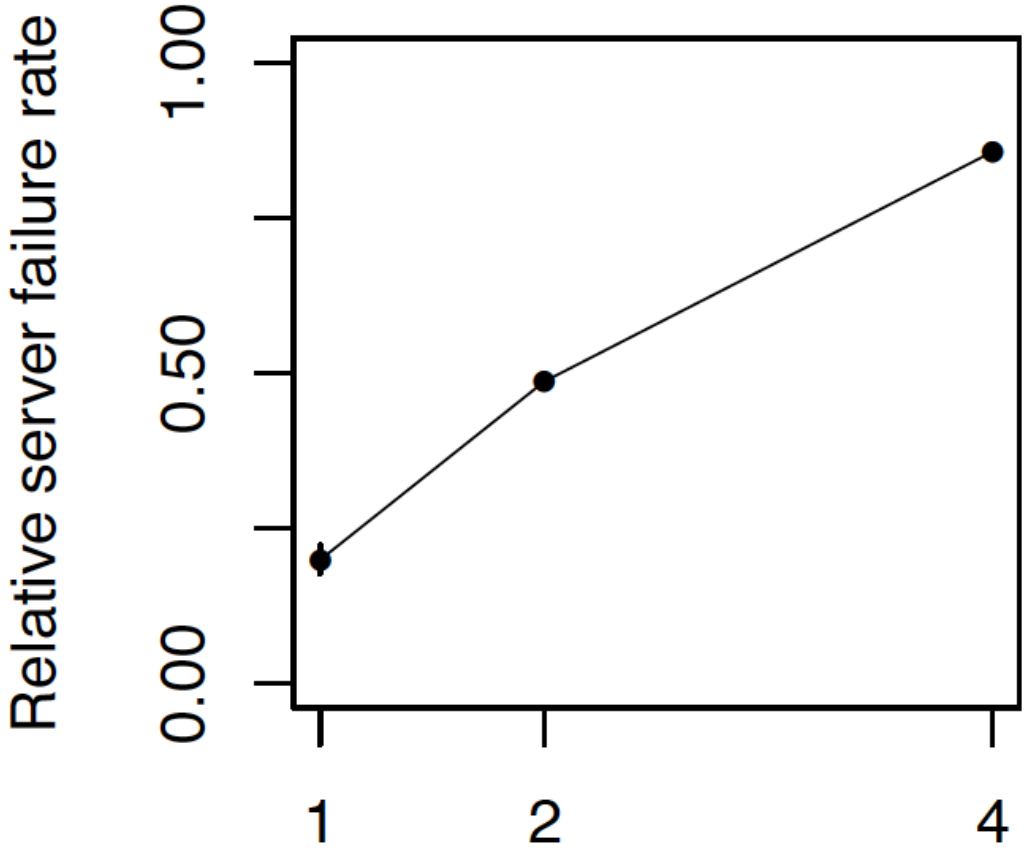
- DRAM stores charge in a capacitor (charge-based memory)
  - Capacitor must be large enough for reliable sensing
  - Access transistor should be large enough for low leakage and high retention time
  - Scaling beyond 40-35nm (2013) is challenging [ITRS, 2009]



- DRAM capacity, cost, and energy/power hard to scale

As Memory Scales, It Becomes Unreliable

- Data from all of Facebook's servers worldwide
- Meza+, "Revisiting Memory Errors in Large-Scale Production Data Centers," DSN'15.

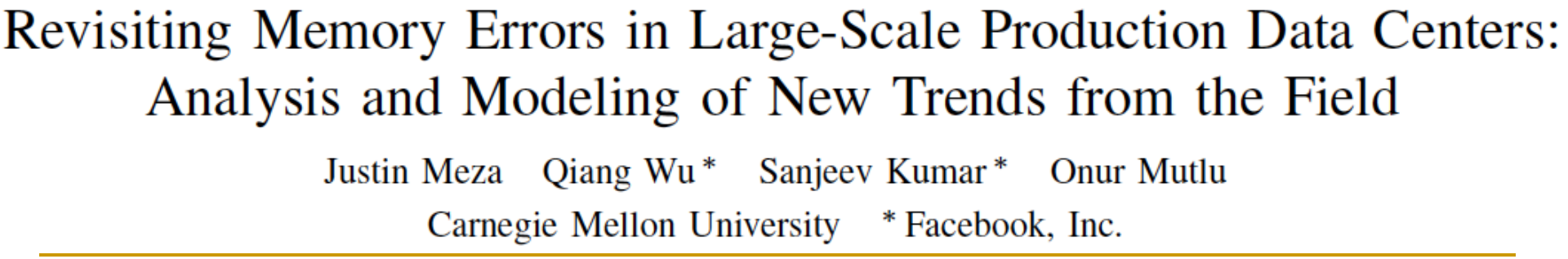


Intuition: quadratic increase in capacity

Large-Scale Failure Analysis of DRAM Chips

- Analysis and modeling of memory errors found in all of Facebook's server fleet

- Justin Meza, Qiang Wu, Sanjeev Kumar, and Onur Mutlu, **"Revisiting Memory Errors in Large-Scale Production Data Centers: Analysis and Modeling of New Trends from the Field"** *Proceedings of the 45th Annual IEEE/IFIP International Conference on Dependable Systems and Networks (**DSN**)*, Rio de Janeiro, Brazil, June 2015.
  [Slides (pptx) (pdf)] [DRAM Error Model]


Revisiting Memory Errors in Large-Scale Production Data Centers: Analysis and Modeling of New Trends from the Field

Justin Meza Qiang Wu * Sanjeev Kumar * Onur Mutlu

Carnegie Mellon University * Facebook, Inc.

Infrastructures to Understand Such Issues

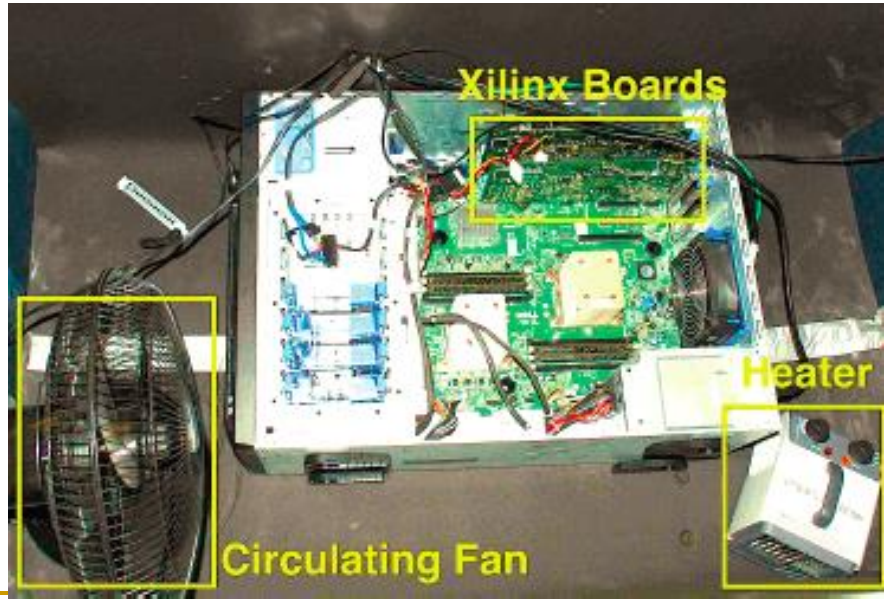
Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)

Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case (Lee et al., HPCA 2015)

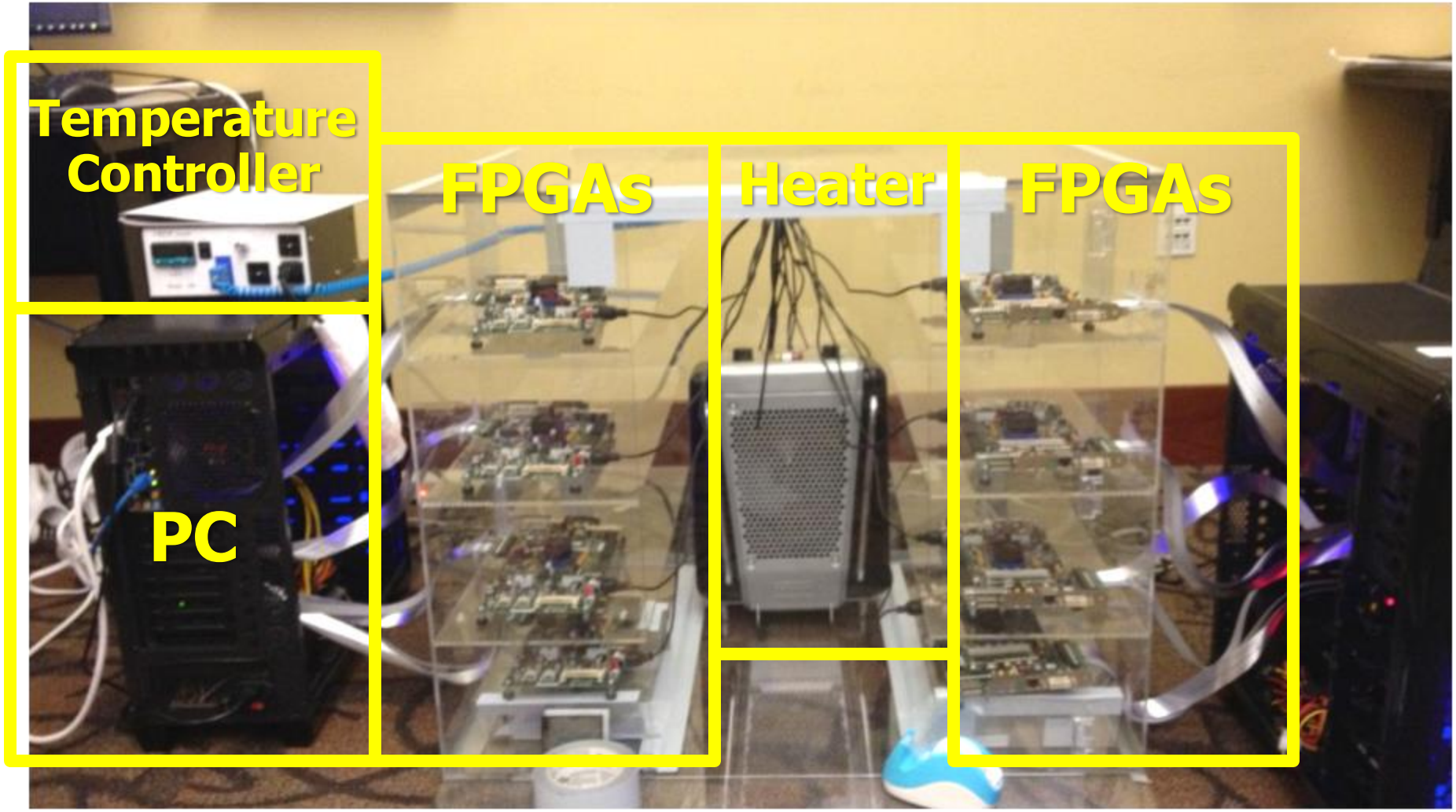
AVATAR: A Variable-Retention-Time (VRT) Aware Refresh for DRAM Systems (Qureshi et al., DSN 2015)

An Experimental Study of Data Retention Behavior in Modern DRAM Devices: Implications for Retention Time Profiling Mechanisms (Liu et al., ISCA 2013)

The Efficacy of Error Mitigation Techniques for DRAM Retention Failures: A Comparative Experimental Study (Khan et al., SIGMETRICS 2014)



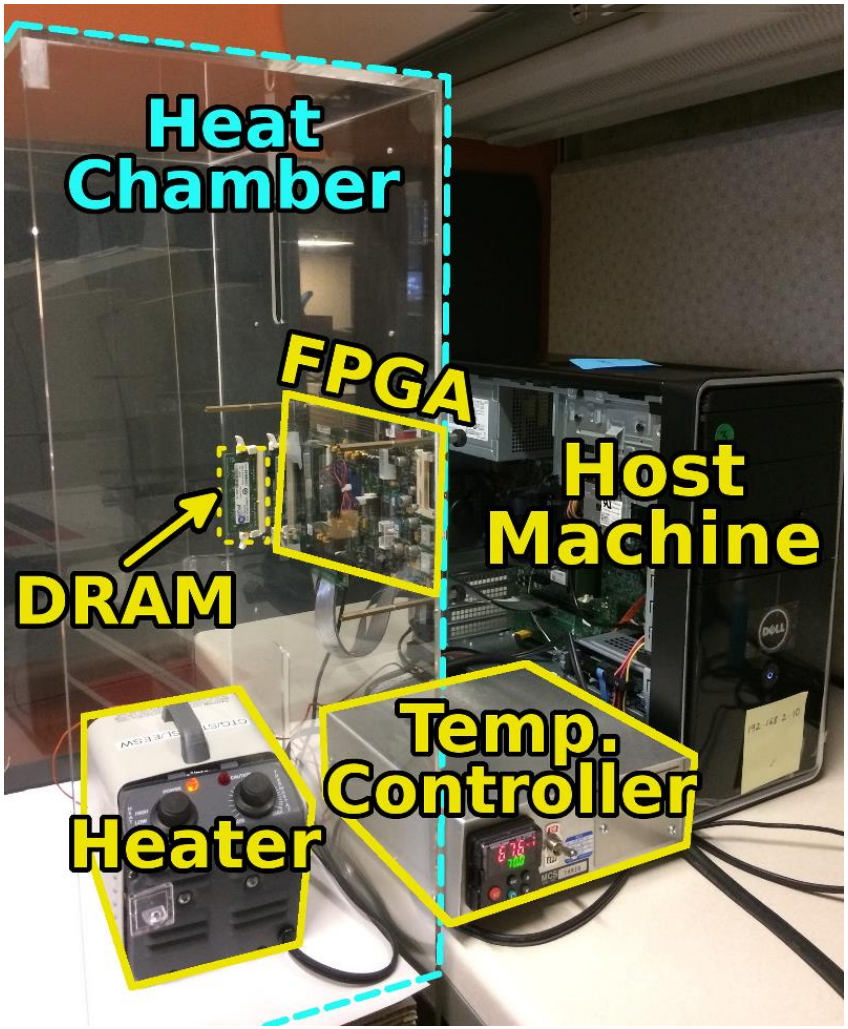
Infrastructures to Understand Such Issues



Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

SoftMC: Open Source DRAM Infrastructure

- Hasan Hassan et al., "**SoftMC: A Flexible and Practical Open-Source Infrastructure for Enabling Experimental DRAM Studies**," HPCA 2017.



- **Flexible**
- **Easy to Use (C++ API)**
- **Open-source**

  github.com/CMU-SAFARI/SoftMC

SoftMC: Open Source DRAM Infrastructure

- https://github.com/CMU-SAFARI/SoftMC

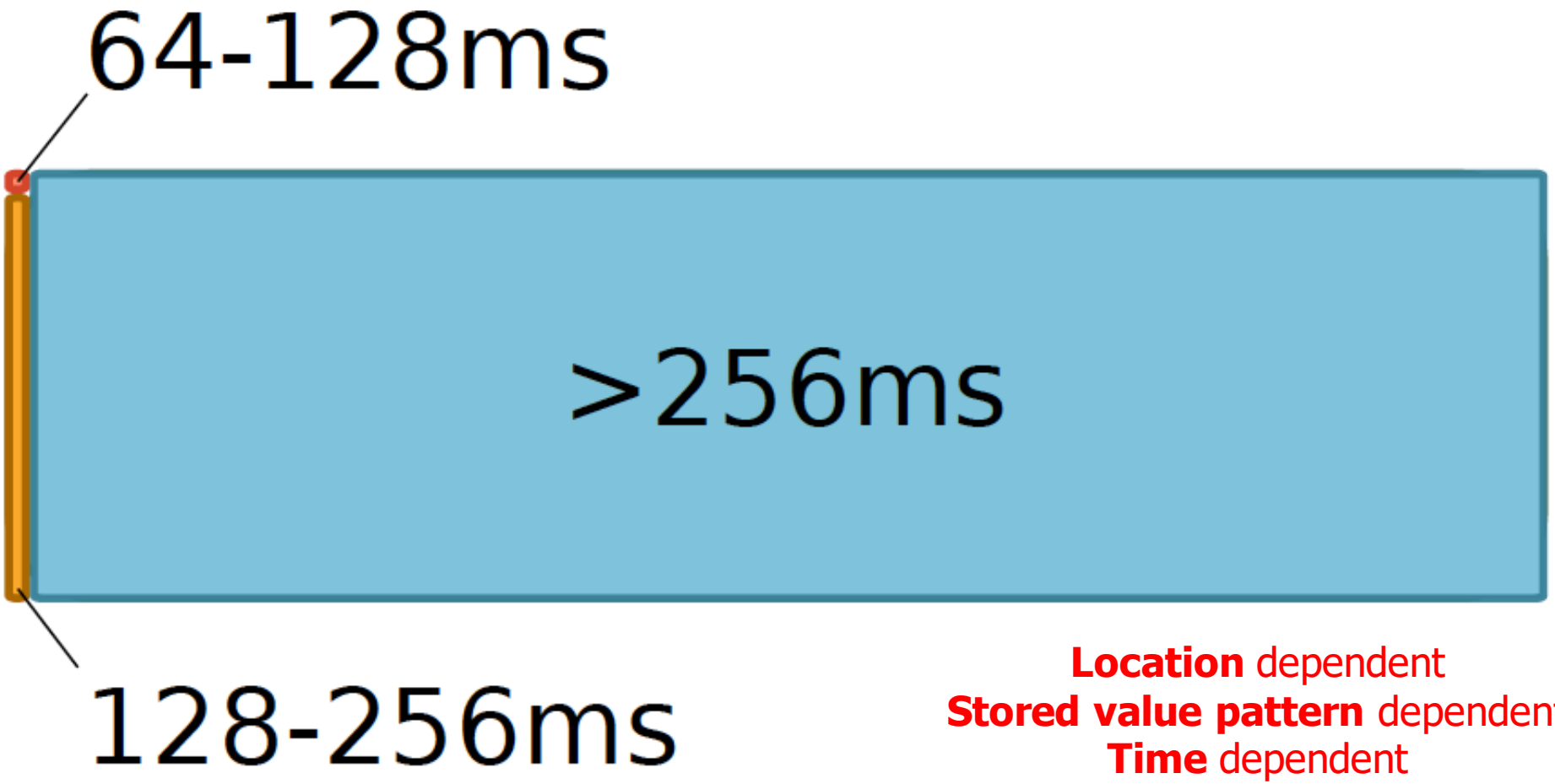
SoftMC: A Flexible and Practical Open-Source Infrastructure for Enabling Experimental DRAM Studies

Hasan Hassan[1,2,3] Nandita Vijaykumar[3] Samira Khan[4,3] Saugata Ghose[3] Kevin Chang[3]
Gennady Pekhimenko[5,3] Donghyuk Lee[6,3] Oguz Ergin[2] Onur Mutlu[1,3]

[1]*ETH Zürich* [2]*TOBB University of Economics & Technology* [3]*Carnegie Mellon University*
[4]*University of Virginia* [5]*Microsoft Research* [6]*NVIDIA Research*

Data Retention in Memory [Liu et al., ISCA 2013]

- Retention Time Profile of DRAM looks like this:



Location dependent
Stored value pattern dependent
Time dependent

A Curious Discovery [Kim et al., ISCA 2014]

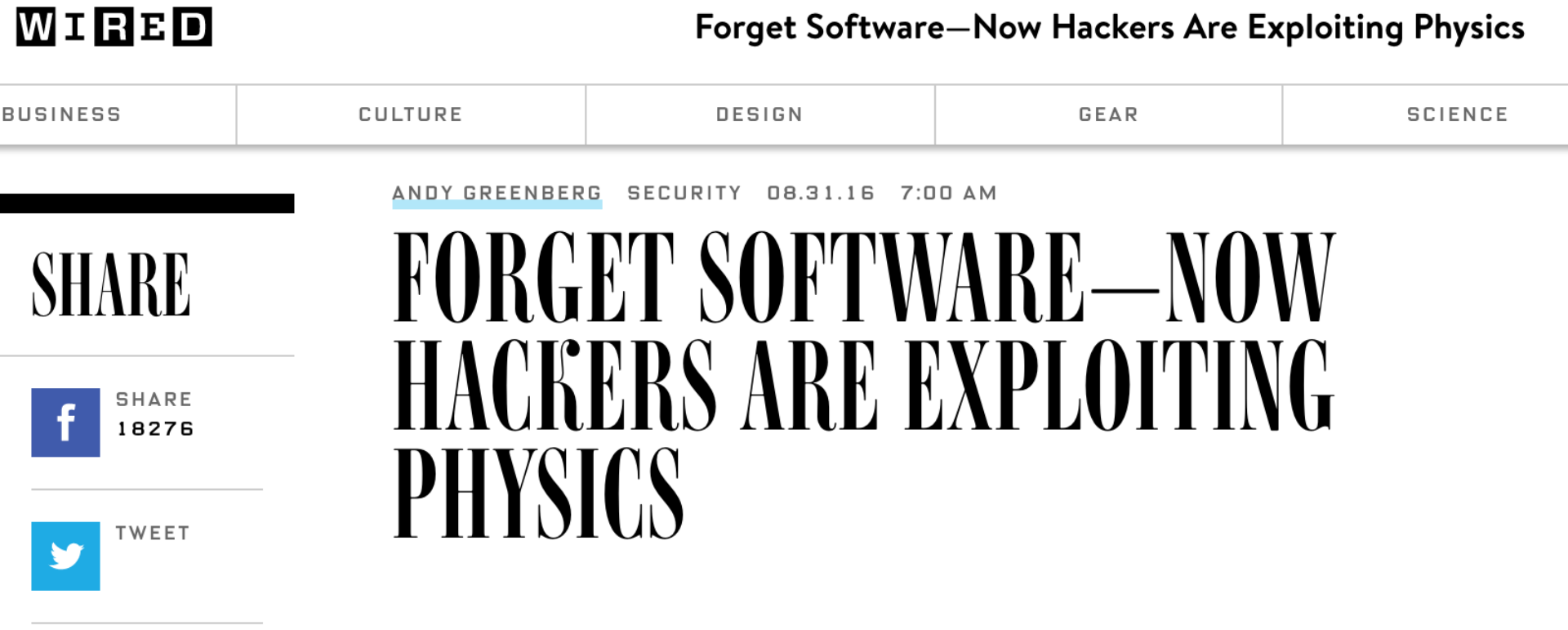
One can

predictably induce errors

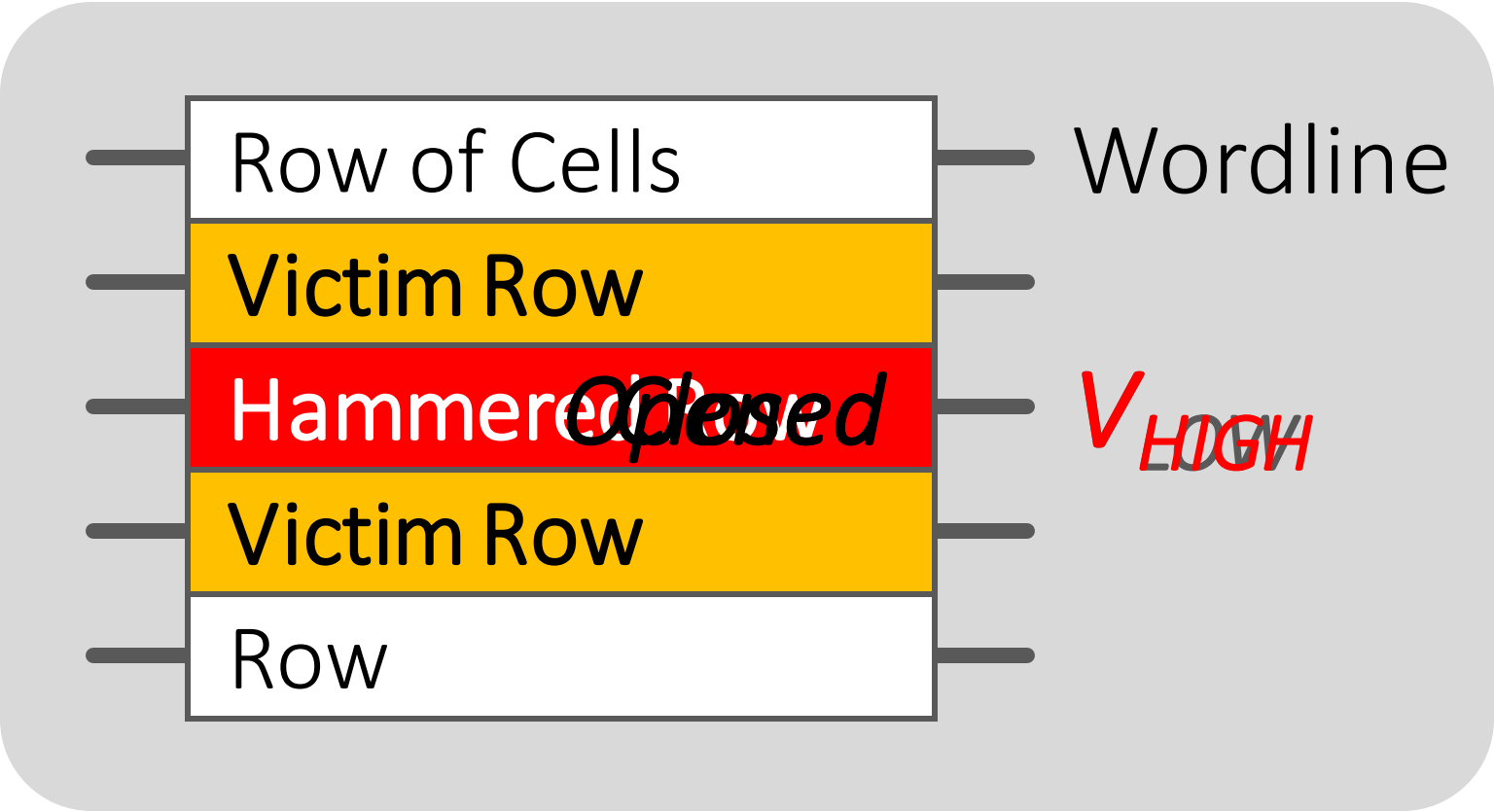
in most DRAM memory chips

DRAM RowHammer

A simple hardware failure mechanism can create a widespread system security vulnerability



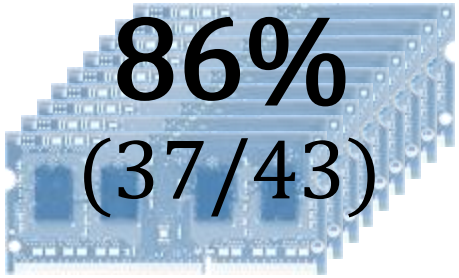
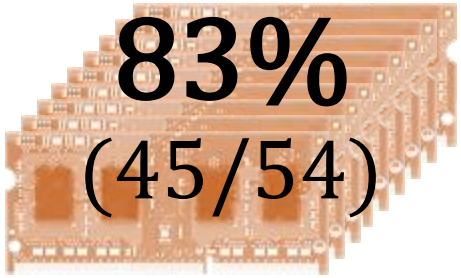
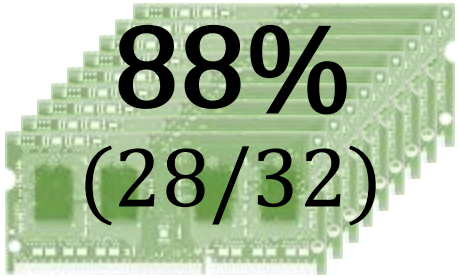
Modern DRAM is Prone to Disturbance Errors



Repeatedly reading a row enough times (before memory gets refreshed) induces disturbance errors in **adjacent rows** in most real DRAM chips you can buy today

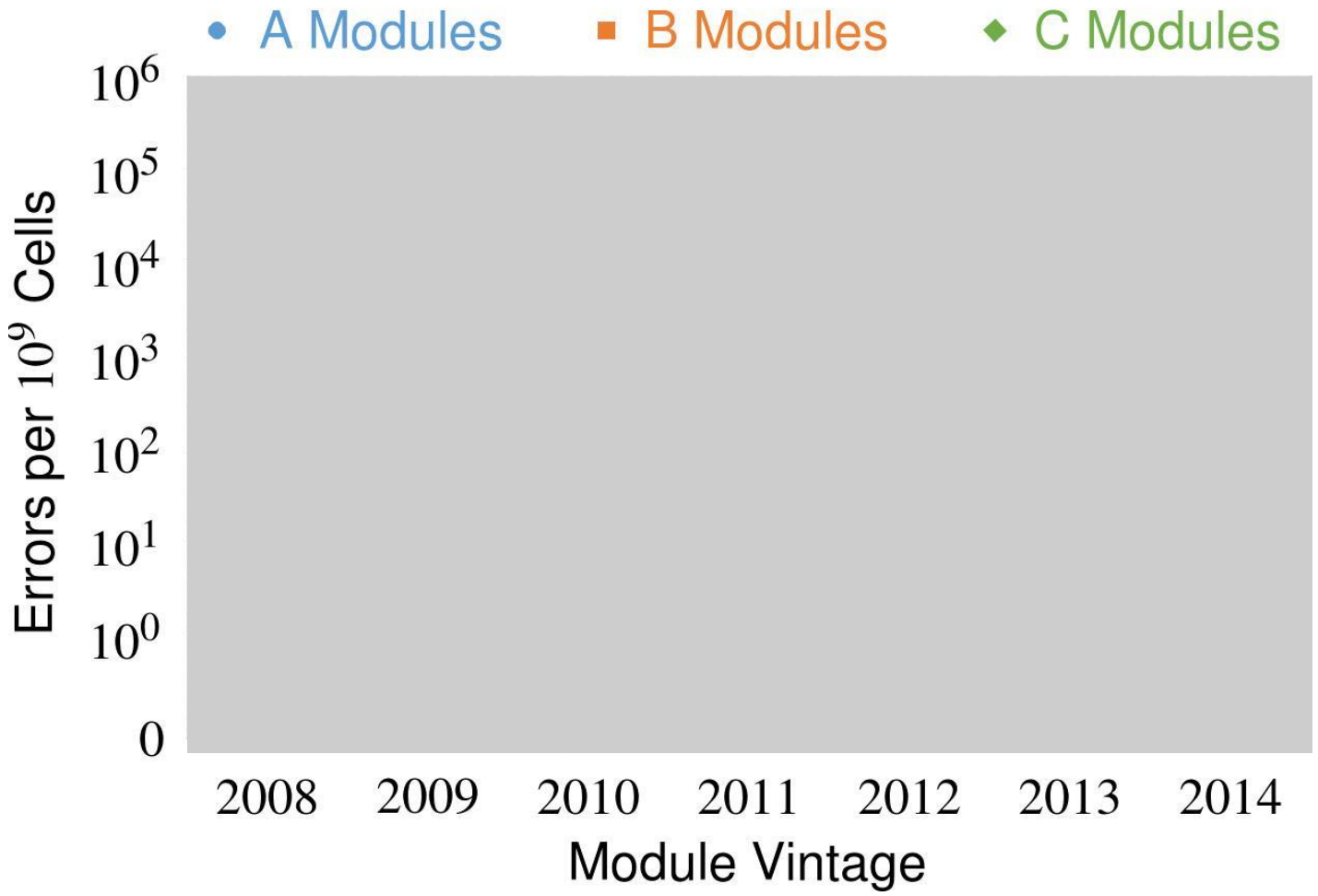
Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors, (Kim et al., ISCA 2014)

Most DRAM Modules Are Vulnerable

A company	B company	C company
 86% (37/43)	 83% (45/54)	 88% (28/32)
Up to 1.0×10^{7} errors	Up to 2.7×10^{6} errors	Up to 3.3×10^{5} errors

Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors, (Kim et al., ISCA 2014)

Recent DRAM Is More Vulnerable



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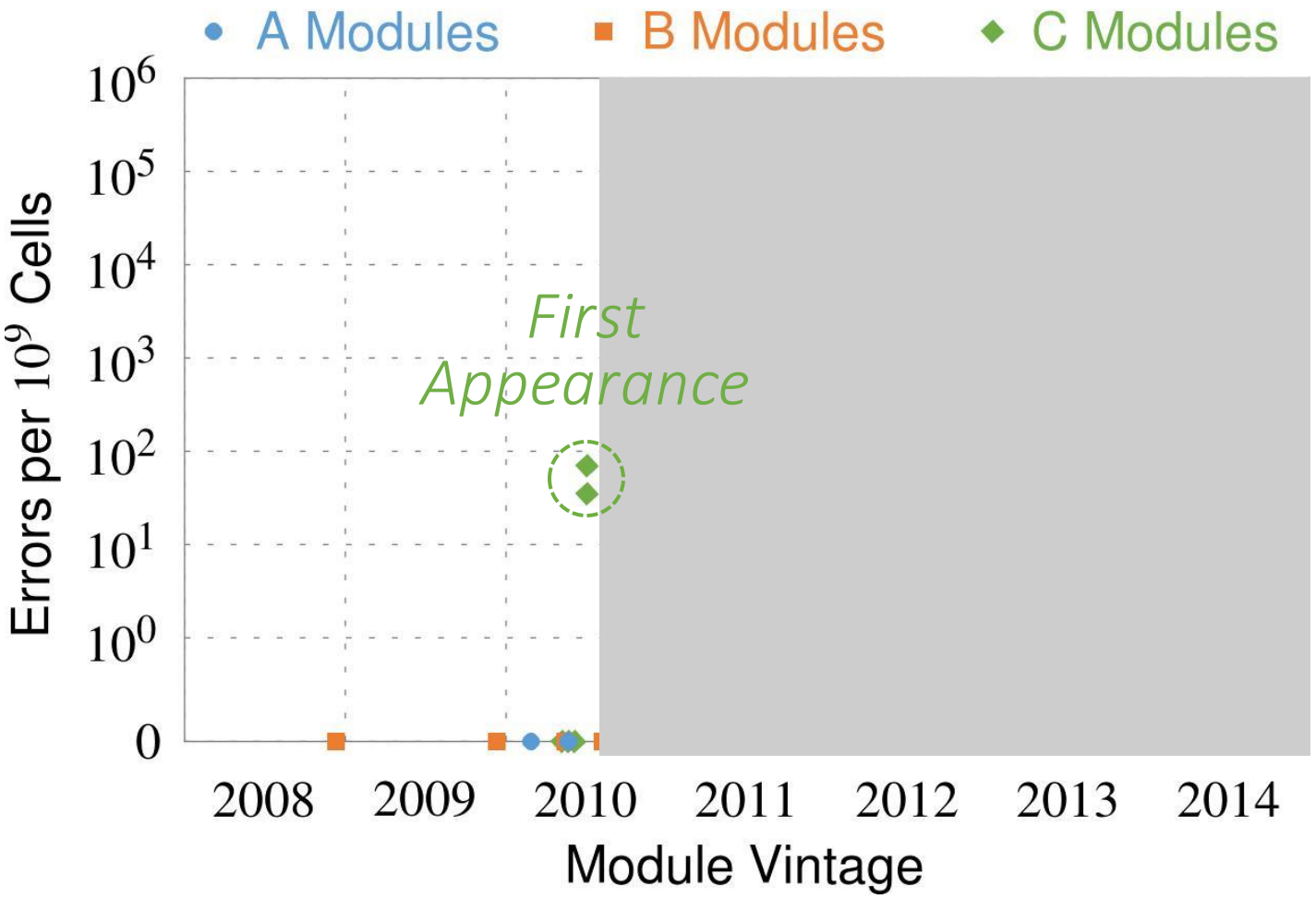

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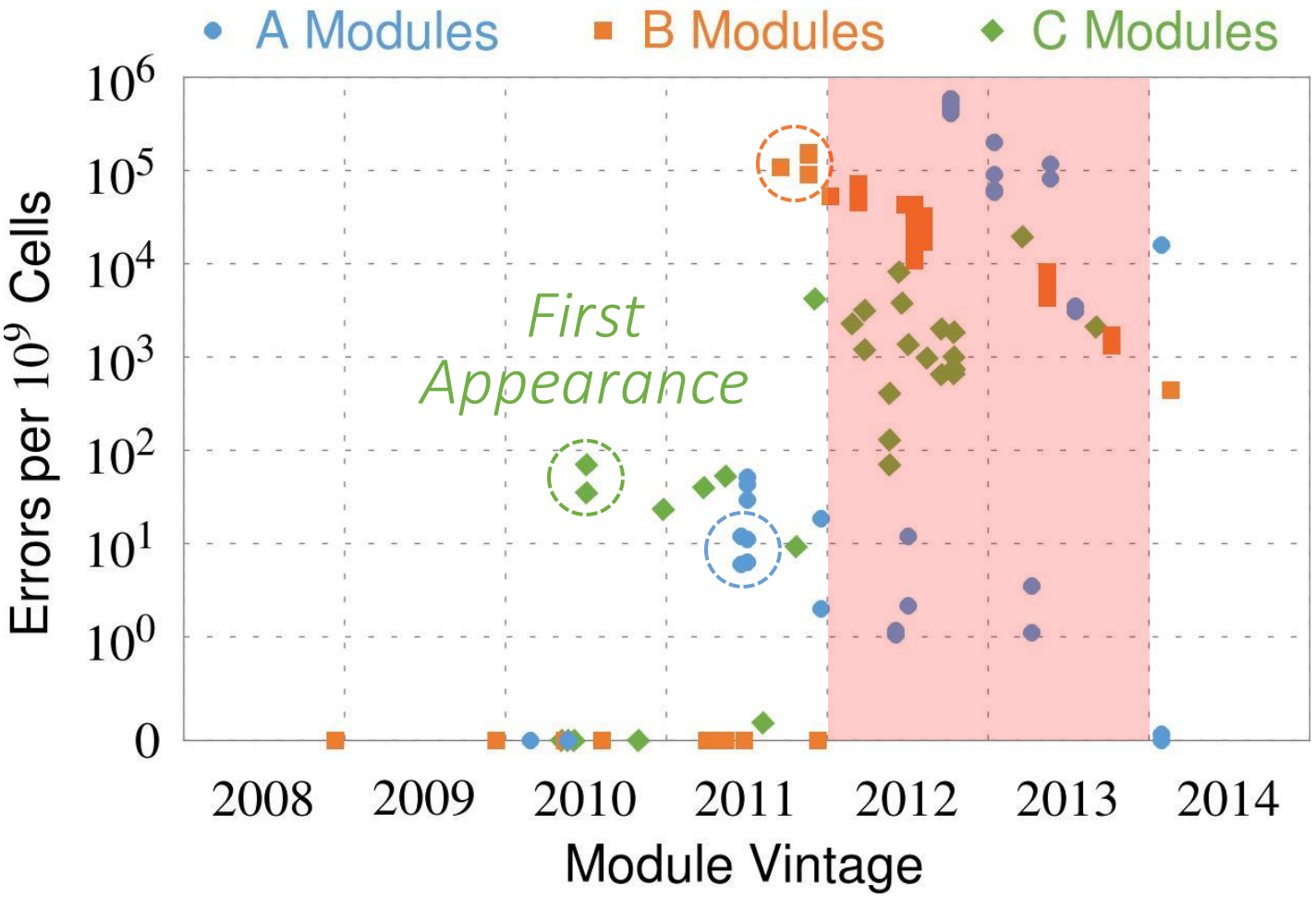


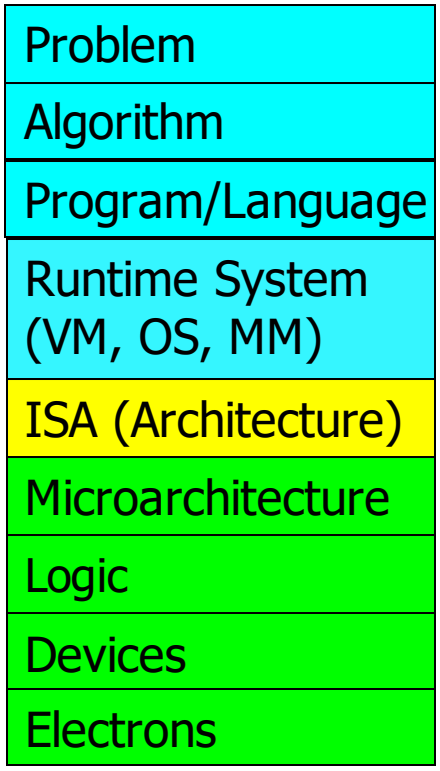
All modules from 2012–2013 are vulnerable

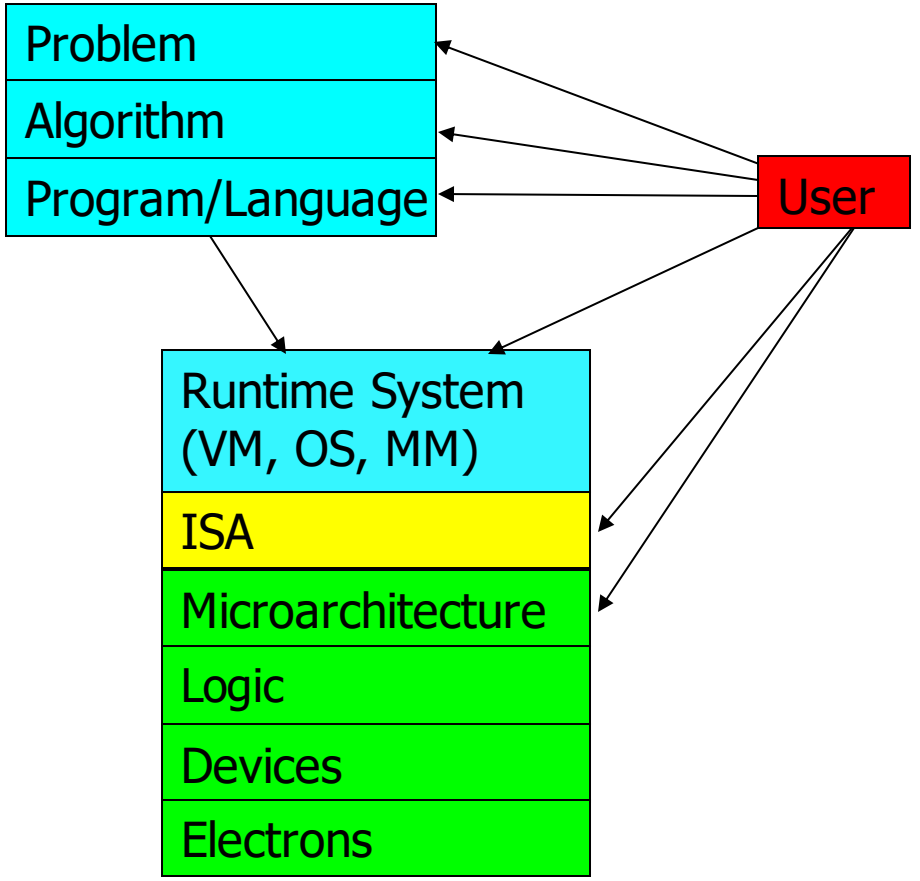
Why Is This Happening?

- DRAM cells are too close to each other!
  - They are not electrically isolated from each other
- Access to one cell affects the value in nearby cells
  - due to electrical interference between
    - the cells
    - wires used for accessing the cells
  - Also called cell-to-cell coupling/interference
- Example: When we activate (apply high voltage) to a row, an adjacent row gets slightly activated as well
  - Vulnerable cells in that slightly-activated row lose a little bit of charge
  - If row hammer happens enough times, charge in such cells gets drained

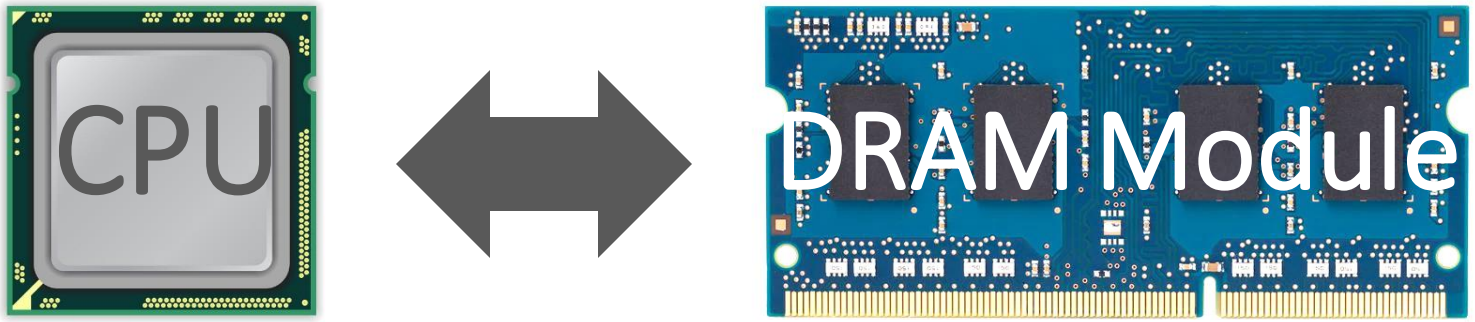
Higher-Level Implications

- This simple circuit level failure mechanism has enormous implications on upper layers of the transformation hierarchy

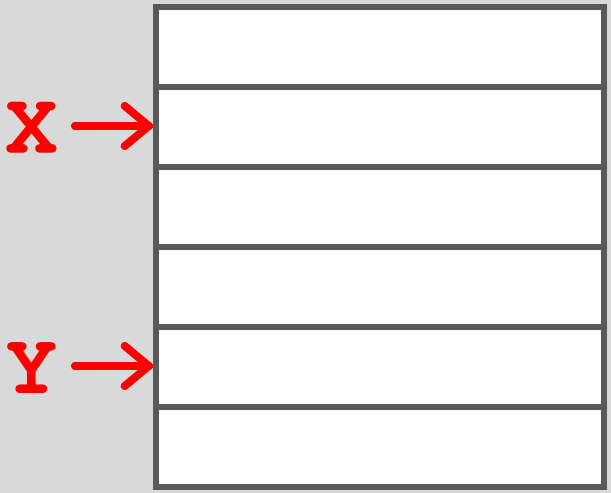




A Simple Program Can Induce Many Errors




```
loop:
  mov (X), %eax
  mov (Y), %ebx
  clflush (X)
  clflush (Y)
  mfence
  jmp loop
```



Download from: https://github.com/CMU-SAFARI/rowhammer

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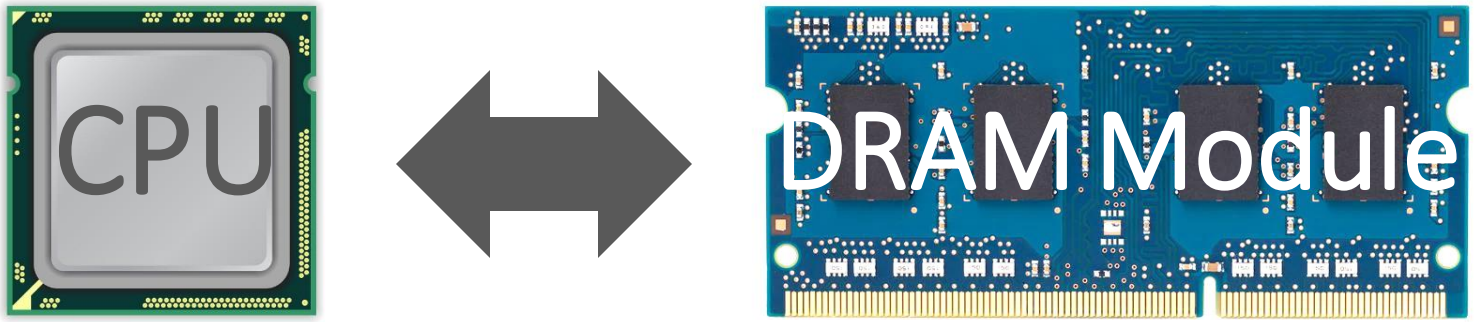
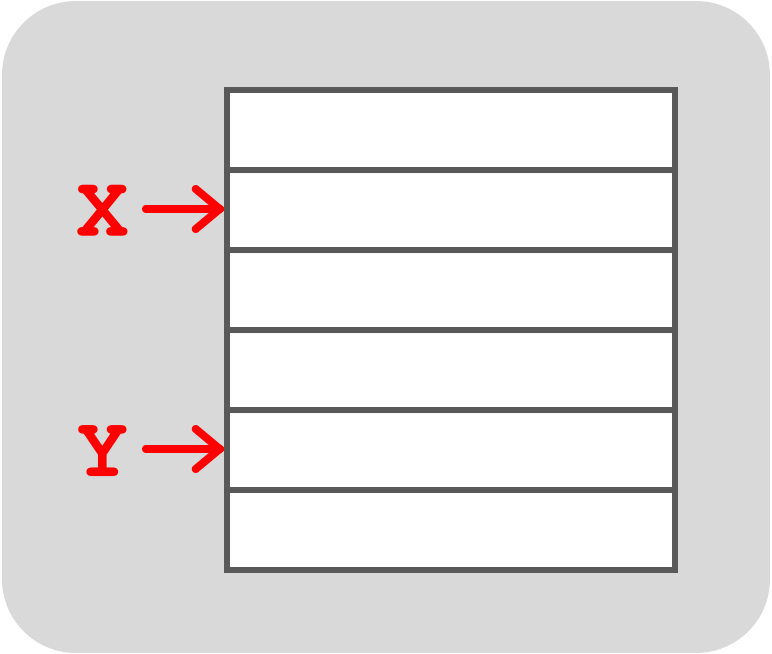


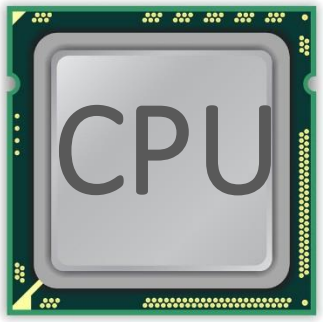
1. Avoid ***cache hits***
   – Flush **X** from cache

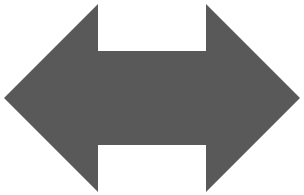
2. Avoid ***row hits*** to **X**
   – Read **Y** in another row

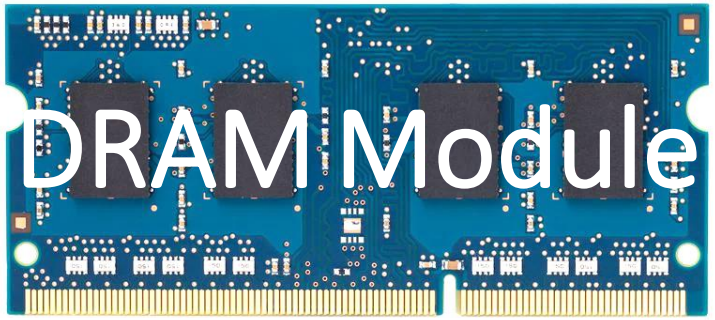


Download from: https://github.com/CMU-SAFARI/rowhammer

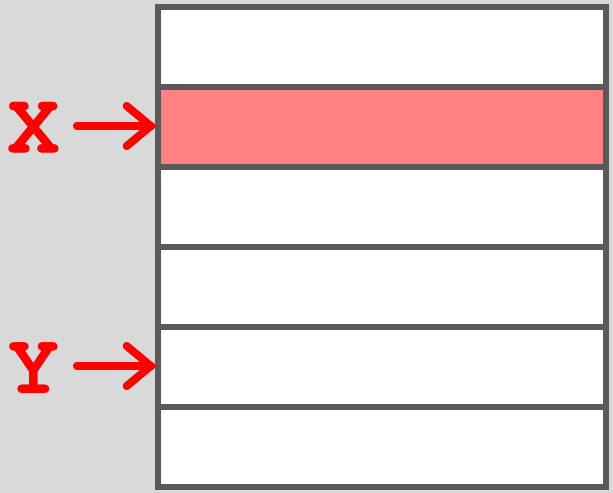
A Simple Program Can Induce Many Errors








```
loop:
  mov (X), %eax
  mov (Y), %ebx
  clflush (X)
  clflush (Y)
  mfence
  jmp loop
```



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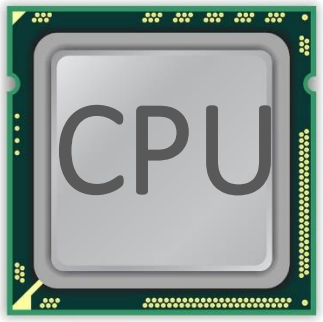
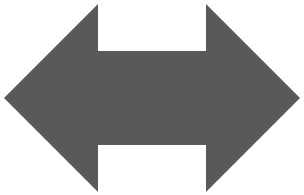
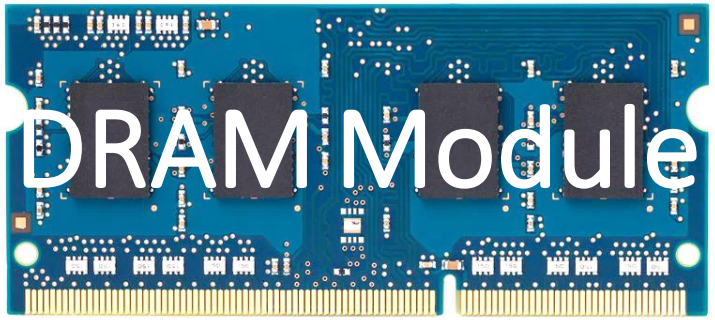
A Simple Program Can Induce Many Errors





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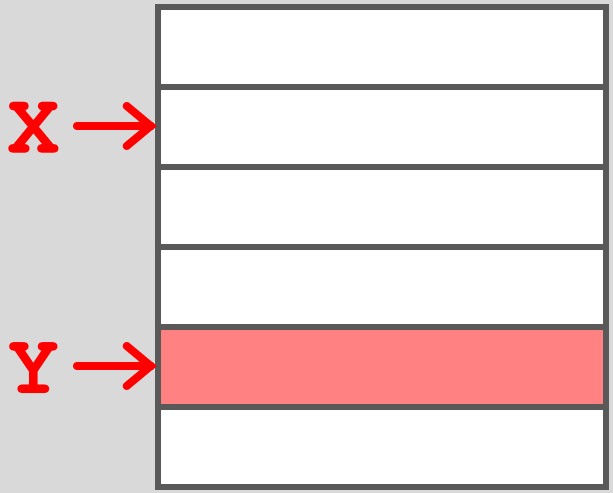

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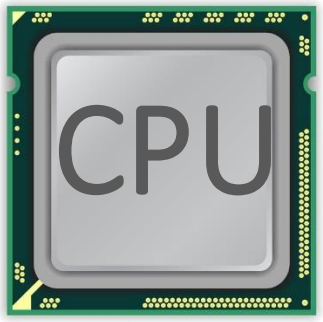
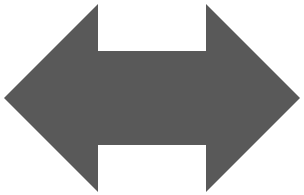
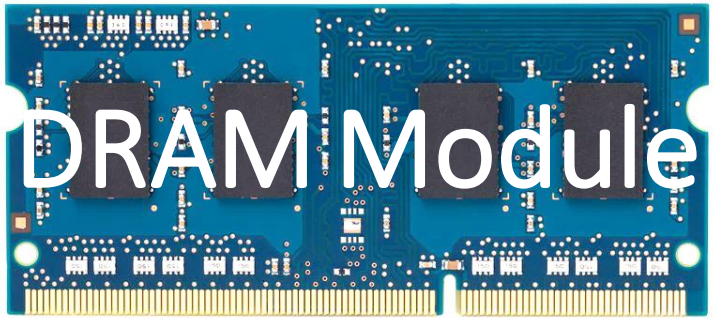
A Simple Program Can Induce Many Errors





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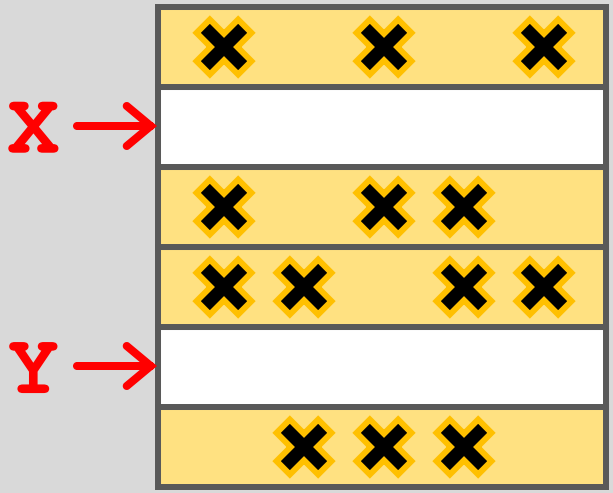


Download from: https://github.com/CMU-SAFARI/rowhammer

Observed Errors in Real Systems

CPU Architecture	Errors	Access-Rate
Intel Haswell (2013)	22.9K	12.3M/sec
Intel Ivy Bridge (2012)	20.7K	11.7M/sec
Intel Sandy Bridge (2011)	16.1K	11.6M/sec
AMD Piledriver (2012)	59	6.1M/sec

A real reliability & security issue

Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

One Can Take Over an Otherwise-Secure System

Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors

Abstract. Memory isolation is a key property of a reliable and secure computing system — an access to one memory address should not have unintended side effects on data stored in other addresses. However, as DRAM process technology

Project Zero

Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)

News and updates from the Project Zero team at Google

Exploiting the DRAM rowhammer bug to gain kernel privileges (Seaborn, 2015)

Monday, March 9, 2015

Exploiting the DRAM rowhammer bug to gain kernel privileges

RowHammer Security Attack Example

- "Rowhammer" is a problem with some recent DRAM devices in which repeatedly accessing a row of memory can cause bit flips in adjacent rows (Kim et al., ISCA 2014).
  - Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)

- We tested a selection of laptops and found that a subset of them exhibited the problem.
- We built two working privilege escalation exploits that use this effect.
  - Exploiting the DRAM rowhammer bug to gain kernel privileges (Seaborn+, 2015)

- One exploit uses rowhammer-induced bit flips to gain kernel privileges on x86-64 Linux when run as an unprivileged userland process.
- When run on a machine vulnerable to the rowhammer problem, the process was able to induce bit flips in page table entries (PTEs).
- It was able to use this to gain write access to its own page table, and hence gain read-write access to all of physical memory.

Security Implications

Security Implications

It's like breaking into an apartment by repeatedly slamming a neighbor's door until the vibrations open the door you were after

Selected Readings on RowHammer (I)

- Our first detailed study: Rowhammer analysis and solutions (June 2014)
  - Yoongu Kim, Ross Daly, Jeremie Kim, Chris Fallin, Ji Hye Lee, Donghyuk Lee, Chris Wilkerson, Konrad Lai, and Onur Mutlu,
    "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors"
    *Proceedings of the 41st International Symposium on Computer Architecture (**ISCA**)*, Minneapolis, MN, June 2014. [Slides (pptx) (pdf)] [Lightning Session Slides (pptx) (pdf)] [Source Code and Data]

- Our Source Code to Induce Errors in Modern DRAM Chips (June 2014)
  - https://github.com/CMU-SAFARI/rowhammer

- Google Project Zero's Attack to Take Over a System (March 2015)
  - Exploiting the DRAM rowhammer bug to gain kernel privileges (Seaborn+, 2015)
  - https://github.com/google/rowhammer-test
  - **Double-sided Rowhammer**

Selected Readings on RowHammer (II)

- Remote RowHammer Attacks via JavaScript (July 2015)
  - http://arxiv.org/abs/1507.06955
  - https://github.com/IAIK/rowhammerjs
  - Gruss et al., DIMVA 2016.
  - **CLFLUSH-free Rowhammer**
  - "A fully automated attack that requires nothing but a website with JavaScript to **trigger faults on remote hardware**."
  - "We can gain unrestricted access to systems of website visitors."

- ANVIL: Software-Based Protection Against Next-Generation Rowhammer Attacks (March 2016)
  - http://dl.acm.org/citation.cfm?doid=2872362.2872390
  - Aweke et al., ASPLOS 2016
  - **CLFLUSH-free Rowhammer**
  - Software based monitoring for rowhammer detection

Selected Readings on RowHammer (III)

- Dedup Est Machina: Memory Deduplication as an Advanced Exploitation Vector (May 2016)
  - https://www.ieee-security.org/TC/SP2016/papers/0824a987.pdf
  - Bosman et al., IEEE S&P 2016.
  - Exploits Rowhammer and Memory Deduplication to overtake a browser
  - "We report on the **first reliable remote exploit for the Rowhammer vulnerability** running entirely in Microsoft Edge."
  - "[an attacker] … can reliably "own" a system with all defenses up, even if the software is entirely free of bugs."

- CAn't Touch This: Software-only Mitigation against Rowhammer Attacks targeting Kernel Memory (August 2017)
  - https://www.usenix.org/system/files/conference/usenixsecurity17/sec17-brasser.pdf
  - Brasser et al., USENIX Security 2017.
  - Partitions physical memory into security domains, user vs. kernel; limits rowhammer-induced bit flips to the user domain.

Selected Readings on RowHammer (IV)

- A New Approach for Rowhammer Attacks (May 2016)
  - https://ieeexplore.ieee.org/document/7495576
  - Qiao et al., HOST 2016
  - **CLFLUSH-free RowHammer**
  - "Libc functions memset and memcpy are found capable of rowhammer."
  - Triggers RowHammer with malicious inputs but benign code

- One Bit Flips, One Cloud Flops: Cross-VM Row Hammer Attacks and Privilege Escalation (August 2016)
  - https://www.usenix.org/system/files/conference/usenixsecurity16/sec16_paper_xiao.pdf
  - Xiao et al., USENIX Security 2016.
  - **"Technique that allows a malicious guest VM to have read and write accesses to arbitrary physical pages on a shared machine."**
  - Graph-based algorithm to reverse engineer mapping of physical addresses in DRAM

Selected Readings on RowHammer (V)

- Curious Case of RowHammer: Flipping Secret Exponent Bits using Timing Analysis (August 2016)
  - https://link.springer.com/content/pdf/10.1007%2F978-3-662-53140-2_29.pdf
  - Bhattacharya et al., CHES 2016
  - Combines timing analysis to perform **rowhammer on cryptographic keys** stored in memory

- DRAMA: Exploiting DRAM Addressing for Cross-CPU Attacks (August 2016)
  - https://www.usenix.org/system/files/conference/usenixsecurity16/sec16_paper_pessl.pdf
  - Pessl et al., USENIX Security 2016
  - **Shows RowHammer failures on DDR4 devices despite TRR solution**
  - Reverse engineers address mapping functions to improve existing RowHammer attacks

Selected Readings on RowHammer (VI)

- Flip Feng Shui: Hammering a Needle in the Software Stack (August 2016)
  - https://www.usenix.org/system/files/conference/usenixsecurity16/sec16_paper_razavi.pdf
  - Razavi et al., USENIX Security 2016.
  - Combines memory deduplication and RowHammer
  - "**A malicious VM can gain unauthorized access to a co-hosted VM running OpenSSH**."
  - Breaks OpenSSH public key authentication

- Drammer: Deterministic Rowhammer Attacks on Mobile Platforms (October 2016)
  - http://dl.acm.org/citation.cfm?id=2976749.2978406
  - Van Der Veen et al., ACM CCS 2016
  - **Can take over an ARM-based Android system deterministically**
  - Exploits predictable physical memory allocator behavior
    - Can deterministically place security-sensitive data (e.g., page table) in an attacker-chosen, vulnerable location in memory

Selected Readings on RowHammer (VII)

- When Good Protections go Bad: Exploiting anti-DoS Measures to Accelerate Rowhammer Attacks (May 2017)
  - https://web.eecs.umich.edu/~misiker/resources/HOST-2017-Misiker.pdf
  - Aga et al., HOST 2017
  - "A virtual-memory based cache-flush free attack that is sufficiently fast to **rowhammer with double rate refresh.**"
  - Enabled by Cache Allocation Technology

- SGX-Bomb: Locking Down the Processor via Rowhammer Attack (October 2017)
  - https://dl.acm.org/citation.cfm?id=3152709
  - Jang et al., SysTEX 2017
  - "Launches the Rowhammer attack against enclave memory to trigger the processor lockdown."
  - **Running unknown enclave programs on the cloud can shut down servers shared with other clients.**

Selected Readings on RowHammer (VIII)

- Another Flip in the Wall of Rowhammer Defenses (May 2018)
  - https://arxiv.org/pdf/1710.00551.pdf
  - Gruss et al., IEEE S&P 2018
  - **A new type of Rowhammer attack which only hammers one single address**, which can be done without knowledge of physical addresses and DRAM mappings
  - Defeats static analysis and performance counter analysis defenses by running inside an SGX enclave

- GuardION: Practical Mitigation of DMA-Based Rowhammer Attacks on ARM (June 2018)
  - https://link.springer.com/chapter/10.1007/978-3-319-93411-2_5
  - Van Der Veen et al., DIMVA 2018
  - Presents RAMPAGE, a DMA-based RowHammer attack against the latest Android OS

Selected Readings on RowHammer (IX)

- Grand Pwning Unit: Accelerating Microarchitectural Attacks with the GPU (May 2018)
  - https://www.vusec.net/wp-content/uploads/2018/05/glitch.pdf
  - Frigo et al., IEEE S&P 2018.
  - The first end-to-end remote Rowhammer exploit on mobile platforms that use our GPU-based primitives in orchestration to **compromise browsers on mobile devices in under two minutes**.

- Throwhammer: Rowhammer Attacks over the Network and Defenses (July 2018)
  - https://www.cs.vu.nl/~herbertb/download/papers/throwhammer_atc18.pdf
  - Tatar et al., USENIX ATC 2018.
  - "[We] show that **an attacker can trigger and exploit Rowhammer bit flips directly from a remote machine by only sending network packets**."

Selected Readings on RowHammer (X)

- Nethammer: Inducing Rowhammer Faults through Network Requests (July 2018)
  - https://arxiv.org/pdf/1805.04956.pdf
  - Lipp et al., arxiv.org 2018.
  - "Nethammer is the first truly **remote Rowhammer attack**, without a single attacker-controlled line of code on the targeted system."

- ZebRAM: Comprehensive and Compatible Software Protection Against Rowhammer Attacks (October 2018)
  - https://www.usenix.org/system/files/osdi18-konoth.pdf
  - Konoth et al., OSDI 2018
  - A new pure-software protection mechanism against RowHammer.

Selected Readings on RowHammer (XI.A)

- PassMark Software, memtest86, since 2014
  - https://www.memtest86.com/troubleshooting.htm#hammer

Why am I only getting errors during Test 13 Hammer Test?

The Hammer Test is designed to detect RAM modules that are susceptible to disturbance errors caused by charge leakage. This phenomenon is characterized in the research paper **Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors** by Yoongu Kim et al. According to the research, a significant number of RAM modules manufactured 2010 or newer are affected by this defect. In simple terms, susceptible RAM modules can be subjected to disturbance errors when repeatedly accessing addresses in the same memory bank but different rows in a short period of time. Errors occur when the repeated access causes charge loss in a memory cell, before the cell contents can be refreshed at the next DRAM refresh interval.

Starting from MemTest86 v6.2, the user may see a warning indicating that the RAM may be vulnerable to high frequency row hammer bit flips. This warning appears when errors are detected during the first pass (maximum hammer rate) but no errors are detected during the second pass (lower hammer rate). See **MemTest86 Test Algorithms** for a description of the two passes that are performed during the Hammer Test (Test 13). When performing the second pass, address pairs are hammered only at the rate deemed as the maximum allowable by memory vendors (200K accesses per 64ms). Once this rate is exceeded, the integrity of memory contents may no longer be guaranteed. If errors are detected in both passes, errors are reported as normal.

The errors detected during Test 13, albeit exposed only in extreme memory access cases, are most certainly real errors. During typical home PC usage (eg. web browsing, word processing, etc.), it is less likely that the memory usage pattern will fall into the extreme case that make it vulnerable to disturbance errors. It may be of greater concern if you were running highly sensitive equipment such as medical equipment, aircraft control systems, or bank database servers. It is impossible to predict with any accuracy if these errors will occur in real life applications. One would need to do a major scientific study of 1000 of computers and their usage patterns, then do a forensic analysis of each application to study how it makes use of the RAM while it executes. To date, we have only seen 1-bit errors as a result of running the Hammer Test.

Selected Readings on RowHammer (XI.B)

- PassMark Software, memtest86, since 2014
  - https://www.memtest86.com/troubleshooting.htm#hammer

Detection and mitigation of row hammer errors

The ability of MemTest86 to detect and report on row hammer errors depends on several factors and what mitigations are in place. To generate errors adjacent memory rows must be repeatedly accessed. But hardware features such as multiple channels, interleaving, **scrambling**, Channel Hashing, NUMA & XOR schemes make it nearly impossible (for an arbitrary CPU & RAM stick) to know which memory addresses correspond to which rows in the RAM. Various mitigations might also be in place. Different BIOS firmware might set the refresh interval to different values (tREFI). The shorter the interval the more resistant the RAM will be to errors. But shorter intervals result in higher power consumption and increased processing overhead. Some CPUs also support pseudo target row refresh (pTRR) that can be used in combination with pTRR-compliant RAM. This field allows the RAM stick to indicate the MAC (Maximum Active Count) level which is the RAM can support. A typical value might be 200,000 row activations. Some CPUs also support the Joint Electron Design Engineering Council (JEDEC) Targeted Row Refresh (TRR) algorithm. The TRR is an improved version of the previously implemented pTRR algorithm and does not inflict any performance drop or additional power usage. As a result the row hammer test implemented in MemTest86 maybe not be the worst case possible and vulnerabilities in the underlying RAM might be undetectable due to the mitigations in place in the BIOS and CPU.

Security Implications (ISCA 2014)

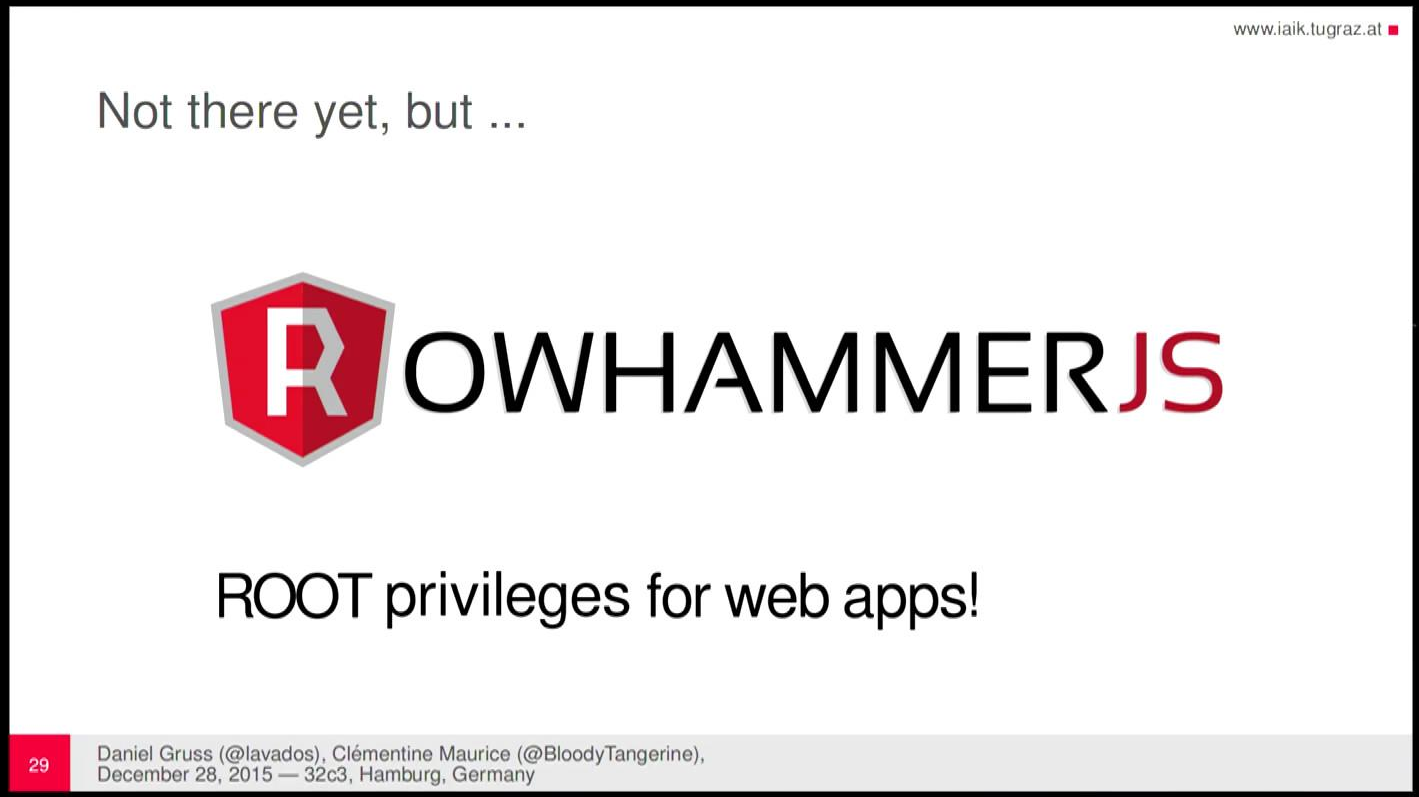
- *Breach of memory protection*
  - OS page (4KB) fits inside DRAM row (8KB)
  - Adjacent DRAM row → Different OS page

- *Vulnerability: disturbance attack*
  - By accessing its own page, a program could corrupt pages belonging to another program

- *We constructed a proof-of-concept*
  - Using only user-level instructions

More Security Implications (I)

"We can gain unrestricted access to systems of website visitors."



Rowhammer.js: A Remote Software-Induced Fault Attack in JavaScript (DIMVA'16)

Source: https://lab.dsst.io/32c3-slides/7197.html

More Security Implications (II)

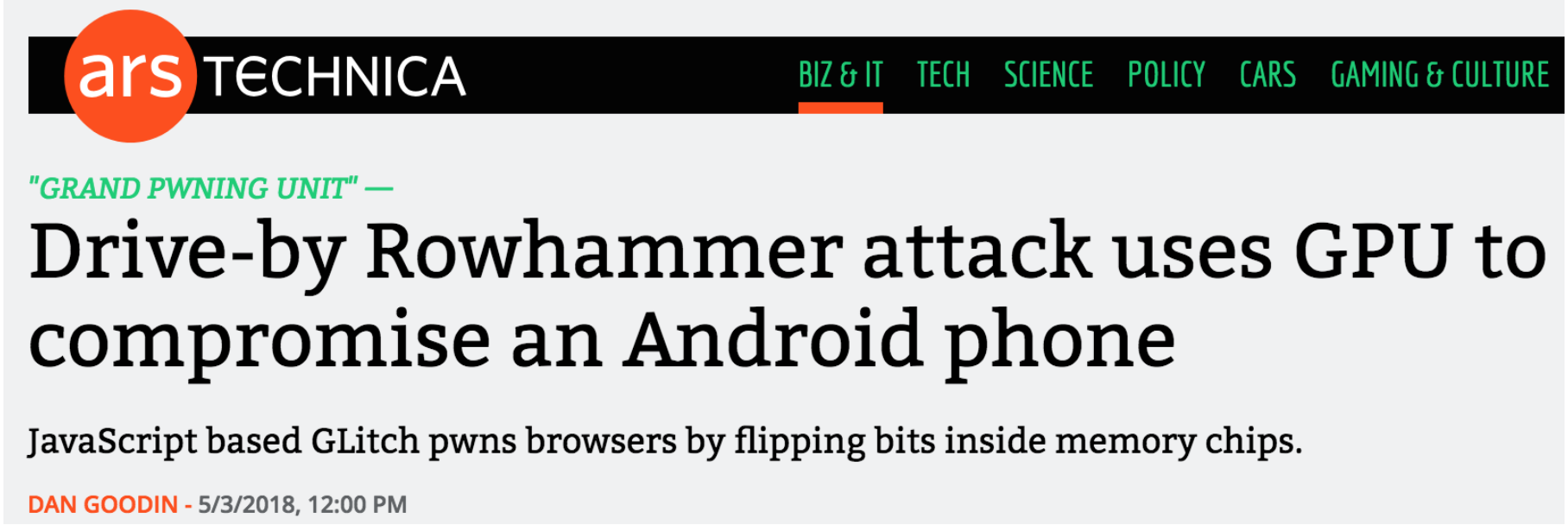
"Can gain control of a smart phone deterministically"

Drammer: Deterministic Rowhammer Attacks on Mobile Platforms, CCS'16

Source: https://fossbytes.com/drammer-rowhammer-attack-android-root-devices/

More Security Implications (III)

- Using an integrated GPU in a mobile system to remotely escalate privilege via the WebGL interface



Grand Pwning Unit: Accelerating Microarchitectural Attacks with the GPU

Pietro Frigo
Vrije Universiteit
Amsterdam
p.frigo@vu.nl

Cristiano Giuffrida
Vrije Universiteit
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Herbert Bos
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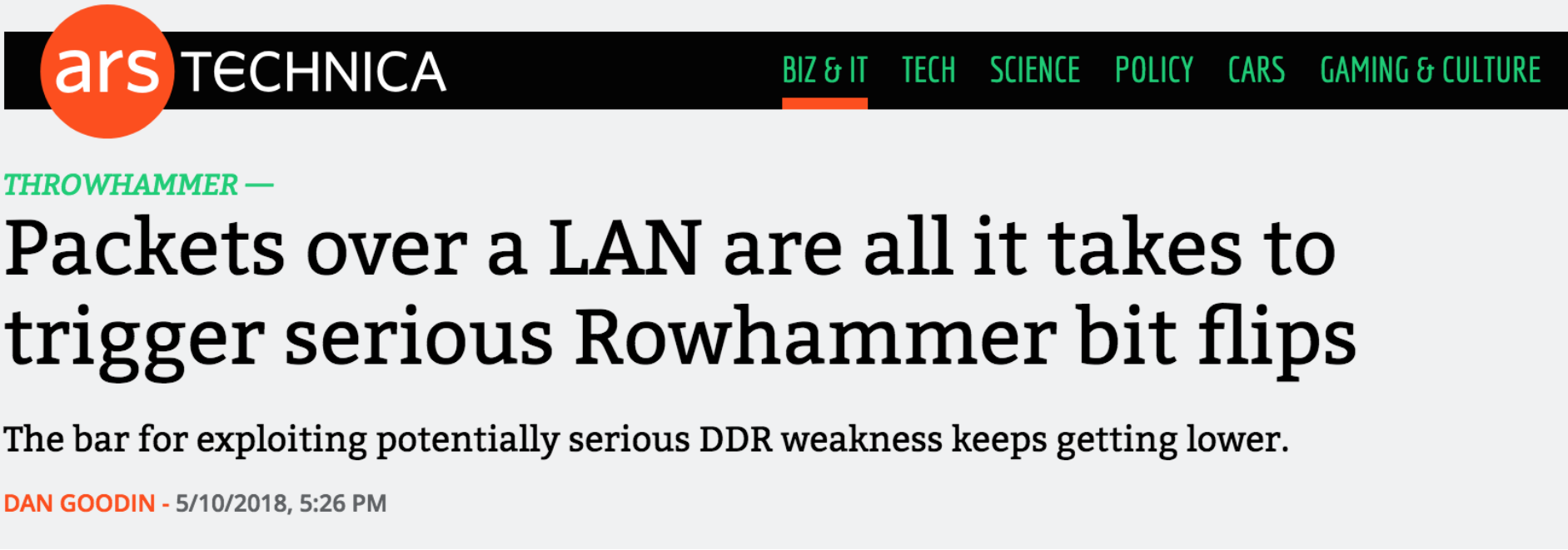
Amsterdam
herbertb@cs.vu.nl

Kaveh Razavi
Vrije Universiteit
Amsterdam
kaveh@cs.vu.nl

More Security Implications (IV)

- Rowhammer over RDMA (I)



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THROWHAMMER —

Packets over a LAN are all it takes to trigger serious Rowhammer bit flips

The bar for exploiting potentially serious DDR weakness keeps getting lower.

DAN GOODIN - 5/10/2018, 5:26 PM

Throwhammer: Rowhammer Attacks over the Network and Defenses

Andrei Tatar
VU Amsterdam

Radhesh Krishnan
VU Amsterdam

Elias Athanasopoulos
University of Cyprus

Cristiano Giuffrida
VU Amsterdam

Herbert Bos
VU Amsterdam

Kaveh Razavi
VU Amsterdam

More Security Implications (V)

- Rowhammer over RDMA (II)

The Hacker News™
Security in a serious way

Nethammer—Exploiting DRAM Rowhammer Bug Through Network Requests

Nethammer:
Inducing Rowhammer Faults through Network Requests

Moritz Lipp
Graz University of Technology

Misiker Tadesse Aga
University of Michigan

Michael Schwarz
Graz University of Technology

Daniel Gruss
Graz University of Technology

Clémentine Maurice
Univ Rennes, CNRS, IRISA

Lukas Raab
Graz University of Technology

Lukas Lamster
Graz University of Technology

More Security Implications (VI)

- Rowhammer on MLC NAND Flash (based on [Cai+, HPCA 2017])

The Register®
Biting the hand that feeds IT

Security

Rowhammer RAM attack adapted to hit flash storage

Project Zero's two-year-old dog learns a new trick

By Richard Chirgwin 17 Aug 2017 at 04:27 17 SHARE ▼

From random block corruption to privilege escalation: A filesystem attack vector for rowhammer-like attacks

Anil Kurmus Nikolas Ioannou Matthias Neugschwandtner Nikolaos Papandreou
Thomas Parnell
IBM Research – Zurich

More Security Implications?

Understanding RowHammer

Root Causes of Disturbance Errors

- *Cause 1: Electromagnetic coupling*
  - Toggling the wordline voltage briefly increases the voltage of adjacent wordlines
  - Slightly opens adjacent rows → Charge leakage
- *Cause 2: Conductive bridges*
- *Cause 3: Hot-carrier injection*

Confirmed by at least one manufacturer

Experimental DRAM Testing Infrastructure

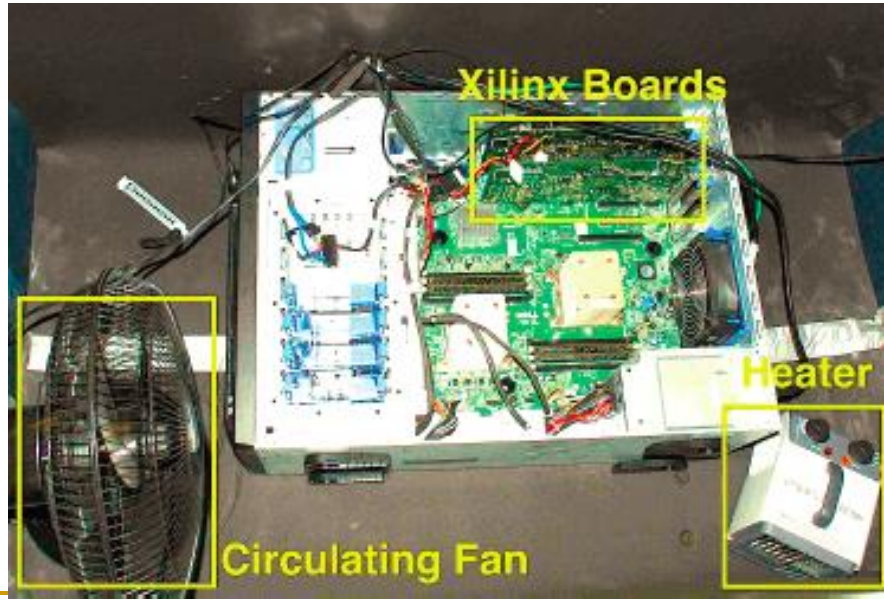
An Experimental Study of Data Retention Behavior in Modern DRAM Devices: Implications for Retention Time Profiling Mechanisms (Liu et al., ISCA 2013)

The Efficacy of Error Mitigation Techniques for DRAM Retention Failures: A Comparative Experimental Study (Khan et al., SIGMETRICS 2014)

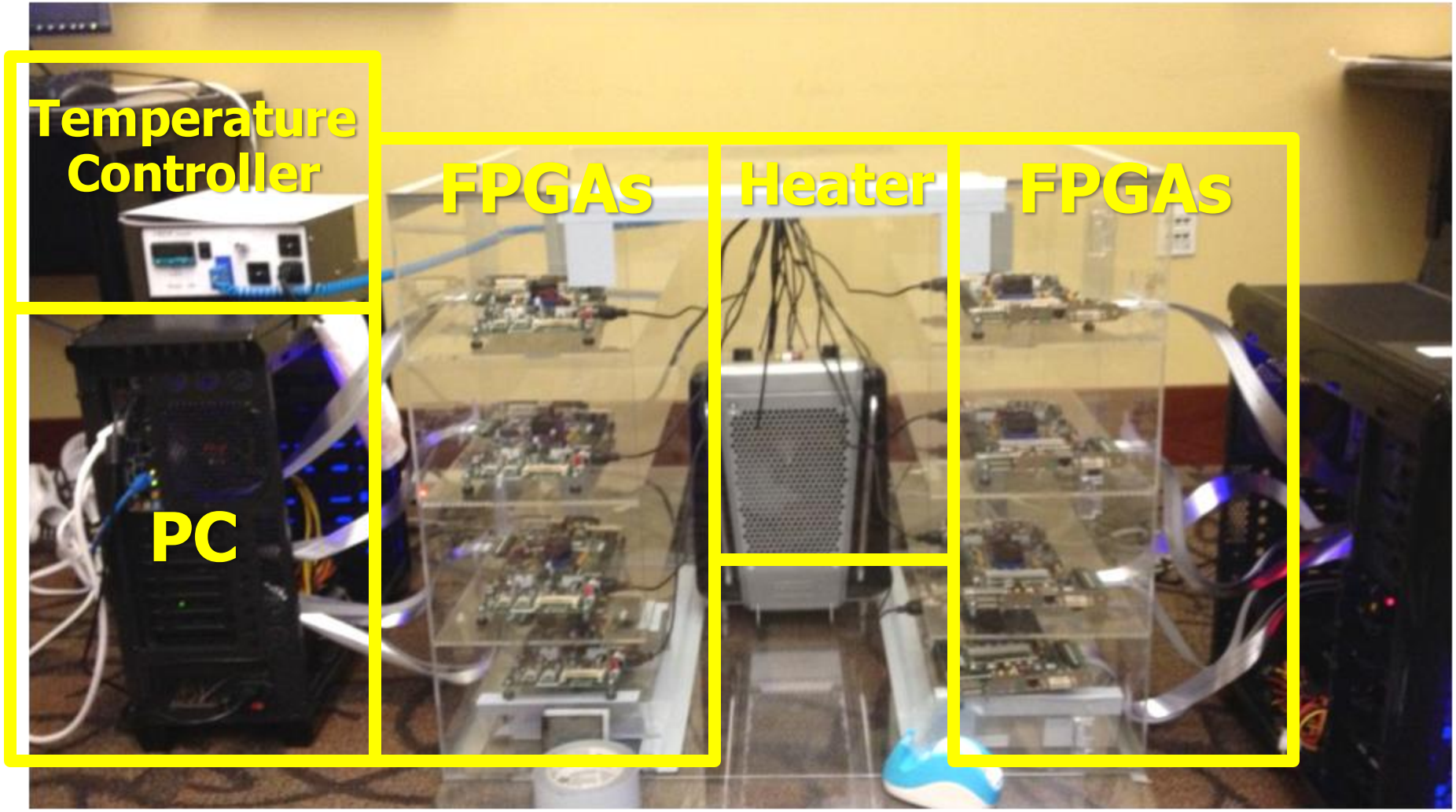
Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)

Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case (Lee et al., HPCA 2015)

AVATAR: A Variable-Retention-Time (VRT) Aware Refresh for DRAM Systems (Qureshi et al., DSN 2015)



Where RowHammer Was Discovered



Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

Tested DRAM Modules

(129 total)

Manufacturer	Module	Date*	Timing†		Organization		Chip			Victims-per-Module			RI_{th} (ms)
		(yy-ww)	Freq (MT/s)	t_{RC} (ns)	Size (GB)	Chips	Size (Gb)‡	Pins	DieVersion§	Average	Minimum	Maximum	Min
A Total of 43 Modules	A_1	10-08	1066	50.625	0.5	4	1	×16	$\mathcal{B}$	0	0	0	–
	A_2	10-20	1066	50.625	1	8	1	×8	$\mathcal{F}$	0	0	0	–
	A_{3-5}	10-20	1066	50.625	0.5	4	1	×16	$\mathcal{B}$	0	0	0	–
	A_{6-7}	11-24	1066	49.125	1	4	2	×16	$\mathcal{D}$	7.8×10^1	5.2×10^1	1.0×10^2	21.3
	A_{8-12}	11-26	1066	49.125	1	4	2	×16	$\mathcal{D}$	2.4×10^2	5.4×10^1	4.4×10^2	16.4
	A_{13-14}	11-50	1066	49.125	1	4	2	×16	$\mathcal{D}$	8.8×10^1	1.7×10^1	1.6×10^2	26.2
	A_{15-16}	12-22	1600	50.625	1	4	2	×16	$\mathcal{D}$	9.5	9	1.0×10^1	34.4
	A_{17-18}	12-26	1600	49.125	2	8	2	×8	$\mathcal{M}$	1.2×10^2	3.7×10^1	2.0×10^2	21.3
	A_{19-30}	12-40	1600	48.125	2	8	2	×8	$\mathcal{K}$	8.6×10^6	7.0×10^6	$\mathbf{1.0 \times 10^7}$	**8.2**
	A_{31-34}	13-02	1600	48.125	2	8	2	×8	–	1.8×10^6	1.0×10^6	3.5×10^6	11.5
	A_{35-36}	13-14	1600	48.125	2	8	2	×8	–	4.0×10^1	1.9×10^1	6.1×10^1	21.3
	A_{37-38}	13-20	1600	48.125	2	8	2	×8	$\mathcal{K}$	1.7×10^6	1.4×10^6	2.0×10^6	9.8
	A_{39-40}	13-28	1600	48.125	2	8	2	×8	$\mathcal{K}$	5.7×10^4	5.4×10^4	6.0×10^4	16.4
	A_{41}	14-04	1600	49.125	2	8	2	×8	–	2.7×10^5	2.7×10^5	2.7×10^5	18.0
	A_{42-43}	14-04	1600	48.125	2	8	2	×8	$\mathcal{K}$	0.5	0	1	62.3
B Total of 54 Modules	B_1	08-49	1066	50.625	1	8	1	×8	$\mathcal{D}$	0	0	0	–
	B_2	09-49	1066	50.625	1	8	1	×8	$\mathcal{E}$	0	0	0	–
	B_3	10-19	1066	50.625	1	8	1	×8	$\mathcal{F}$	0	0	0	–
	B_4	10-31	1333	49.125	2	8	2	×8	$\mathcal{C}$	0	0	0	–
	B_5	11-13	1333	49.125	2	8	2	×8	$\mathcal{C}$	0	0	0	–
	B_6	11-16	1066	50.625	1	8	1	×8	$\mathcal{F}$	0	0	0	–
	B_7	11-19	1066	50.625	1	8	1	×8	$\mathcal{F}$	0	0	0	–
	B_8	11-25	1333	49.125	2	8	2	×8	$\mathcal{C}$	0	0	0	–
	B_9	11-37	1333	49.125	2	8	2	×8	$\mathcal{D}$	1.9×10^6	1.9×10^6	1.9×10^6	11.5
	B_{10-12}	11-46	1333	49.125	2	8	2	×8	$\mathcal{D}$	2.2×10^6	1.5×10^6	$\mathbf{2.7 \times 10^6}$	11.5
	B_{13}	11-49	1333	49.125	2	8	2	×8	$\mathcal{C}$	0	0	0	–
	B_{14}	12-01	1866	47.125	2	8	2	×8	$\mathcal{D}$	9.1×10^5	9.1×10^5	9.1×10^5	**9.8**
	B_{15-31}	12-10	1866	47.125	2	8	2	×8	$\mathcal{D}$	9.8×10^5	7.8×10^5	1.2×10^6	11.5
	B_{32}	12-25	1600	48.125	2	8	2	×8	$\mathcal{E}$	7.4×10^5	7.4×10^5	7.4×10^5	11.5
	B_{33-42}	12-28	1600	48.125	2	8	2	×8	$\mathcal{E}$	5.2×10^5	1.9×10^5	7.3×10^5	11.5
	B_{43-47}	12-31	1600	48.125	2	8	2	×8	$\mathcal{E}$	4.0×10^5	2.9×10^5	5.5×10^5	13.1
	B_{48-51}	13-19	1600	48.125	2	8	2	×8	$\mathcal{E}$	1.1×10^5	7.4×10^4	1.4×10^5	14.7
	B_{52-53}	13-40	1333	49.125	2	8	2	×8	$\mathcal{D}$	2.6×10^4	2.3×10^4	2.9×10^4	21.3
	B_{54}	14-07	1333	49.125	2	8	2	×8	$\mathcal{D}$	7.5×10^3	7.5×10^3	7.5×10^3	26.2
C Total of 32 Modules	C_1	10-18	1333	49.125	2	8	2	×8	$\mathcal{A}$	0	0	0	–
	C_2	10-20	1066	50.625	2	8	2	×8	$\mathcal{A}$	0	0	0	–
	C_3	10-22	1066	50.625	2	8	2	×8	$\mathcal{A}$	0	0	0	–
	C_{4-5}	10-26	1333	49.125	2	8	2	×8	$\mathcal{B}$	8.9×10^2	6.0×10^2	1.2×10^3	29.5
	C_6	10-43	1333	49.125	1	8	1	×8	$\mathcal{T}$	0	0	0	–
	C_7	10-51	1333	49.125	2	8	2	×8	$\mathcal{B}$	4.0×10^2	4.0×10^2	4.0×10^2	29.5
	C_8	11-12	1333	46.25	2	8	2	×8	$\mathcal{B}$	6.9×10^2	6.9×10^2	6.9×10^2	21.3
	C_9	11-19	1333	46.25	2	8	2	×8	$\mathcal{B}$	9.2×10^2	9.2×10^2	9.2×10^2	27.9
	C_{10}	11-31	1333	49.125	2	8	2	×8	$\mathcal{B}$	3	3	3	39.3
	C_{11}	11-42	1333	49.125	2	8	2	×8	$\mathcal{B}$	1.6×10^2	1.6×10^2	1.6×10^2	39.3
	C_{12}	11-48	1600	48.125	2	8	2	×8	$\mathcal{C}$	7.1×10^4	7.1×10^4	7.1×10^4	19.7
	C_{13}	12-08	1333	49.125	2	8	2	×8	$\mathcal{C}$	3.9×10^4	3.9×10^4	3.9×10^4	21.3
	C_{14-15}	12-12	1333	49.125	2	8	2	×8	$\mathcal{C}$	3.7×10^4	2.1×10^4	5.4×10^4	21.3
	C_{16-18}	12-20	1600	48.125	2	8	2	×8	$\mathcal{C}$	3.5×10^3	1.2×10^3	7.0×10^3	27.9
	C_{19}	12-23	1600	48.125	2	8	2	×8	$\mathcal{E}$	1.4×10^5	1.4×10^5	1.4×10^5	18.0
	C_{20}	12-24	1600	48.125	2	8	2	×8	$\mathcal{C}$	6.5×10^4	6.5×10^4	6.5×10^4	21.3
	C_{21}	12-26	1600	48.125	2	8	2	×8	$\mathcal{C}$	2.3×10^4	2.3×10^4	2.3×10^4	24.6
	C_{22}	12-32	1600	48.125	2	8	2	×8	$\mathcal{C}$	1.7×10^4	1.7×10^4	1.7×10^4	22.9
	C_{23-24}	12-37	1600	48.125	2	8	2	×8	$\mathcal{C}$	2.3×10^4	1.1×10^4	3.4×10^4	18.0
	C_{25-30}	12-41	1600	48.125	2	8	2	×8	$\mathcal{C}$	2.0×10^4	1.1×10^4	3.2×10^4	19.7
	C_{31}	13-11	1600	48.125	2	8	2	×8	$\mathcal{C}$	3.3×10^5	3.3×10^5	$\mathbf{3.3 \times 10^5}$	**14.7**
	C_{32}	13-35	1600	48.125	2	8	2	×8	$\mathcal{C}$	3.7×10^4	3.7×10^4	3.7×10^4	21.3

∗ We report the manufacture date marked on the chip packages, which is more accurate than other dates that can be gleaned from a module.
† We report timing constraints stored in the module's on-board ROM [33], which is read by the system BIOS to calibrate the memory controller.
‡ The maximum DRAM chip size supported by our testing platform is 2Gb.
§ We report DRAM die versions marked on the chip packages, which typically progress in the following manner: $\mathcal{M} \rightarrow \mathcal{A} \rightarrow \mathcal{B} \rightarrow \mathcal{C} \rightarrow \cdots$.

Table 3. Sample population of 129 DDR3 DRAM modules, categorized by manufacturer and sorted by manufacture date

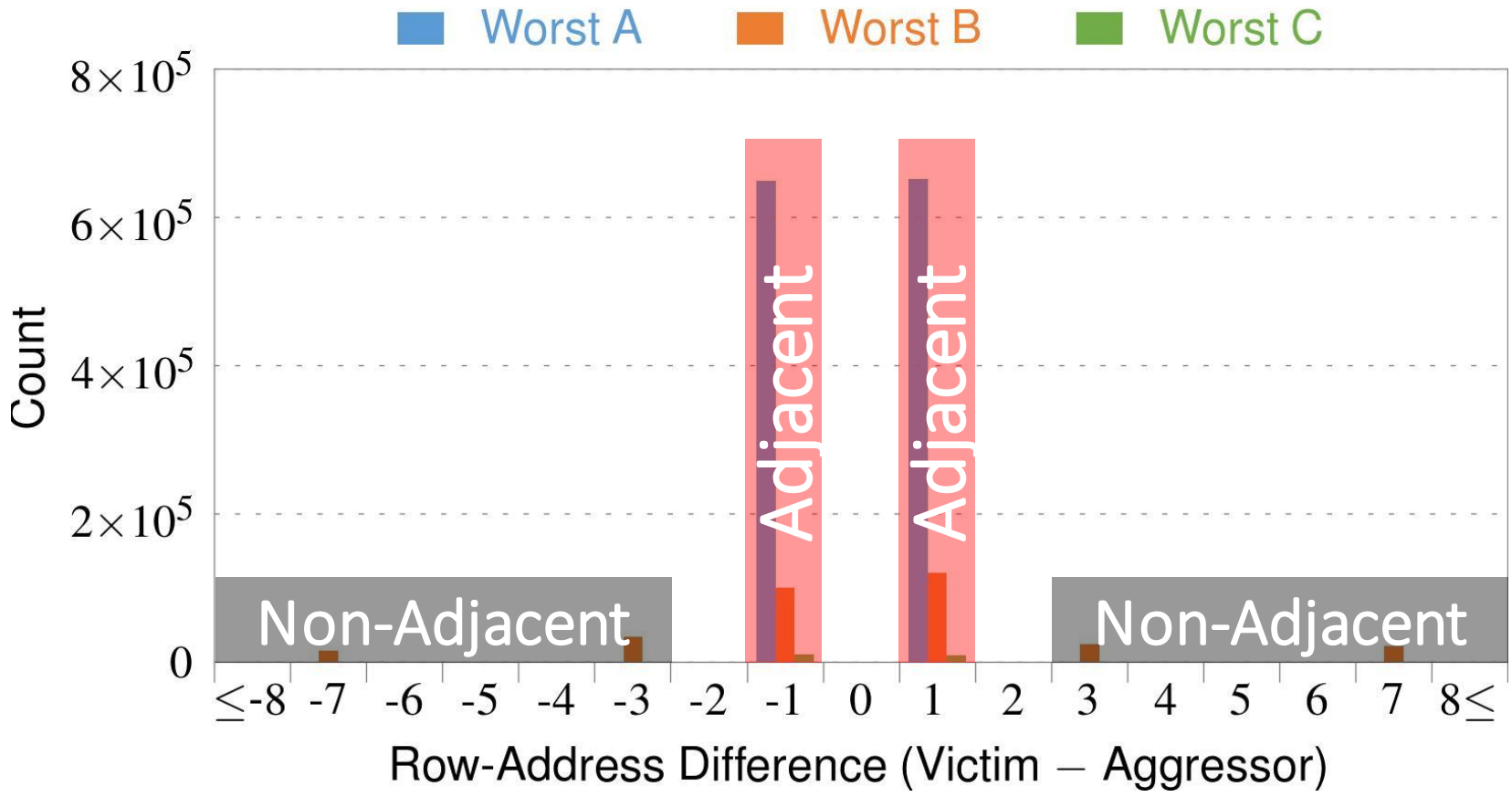
SAFARI

RowHammer Characterization Results

1. Most Modules Are at Risk
2. Errors vs. Vintage
3. Error = Charge Loss
4. Adjacency: Aggressor & Victim
5. Sensitivity Studies
6. Other Results in Paper
7. Solution Space

Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors, (Kim et al., ISCA 2014)

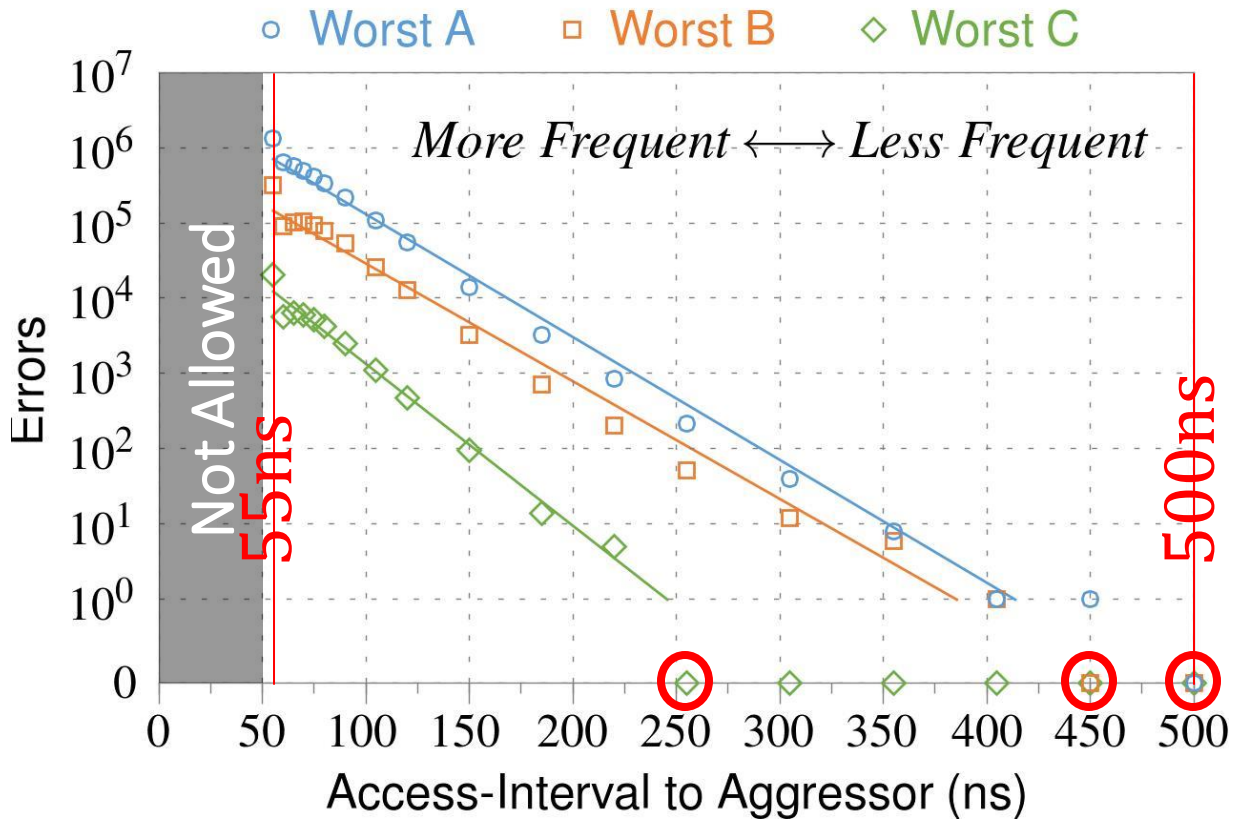
4. Adjacency: Aggressor & Victim



Note: For three modules with the most errors (only first bank)

Most aggressors & victims are adjacent

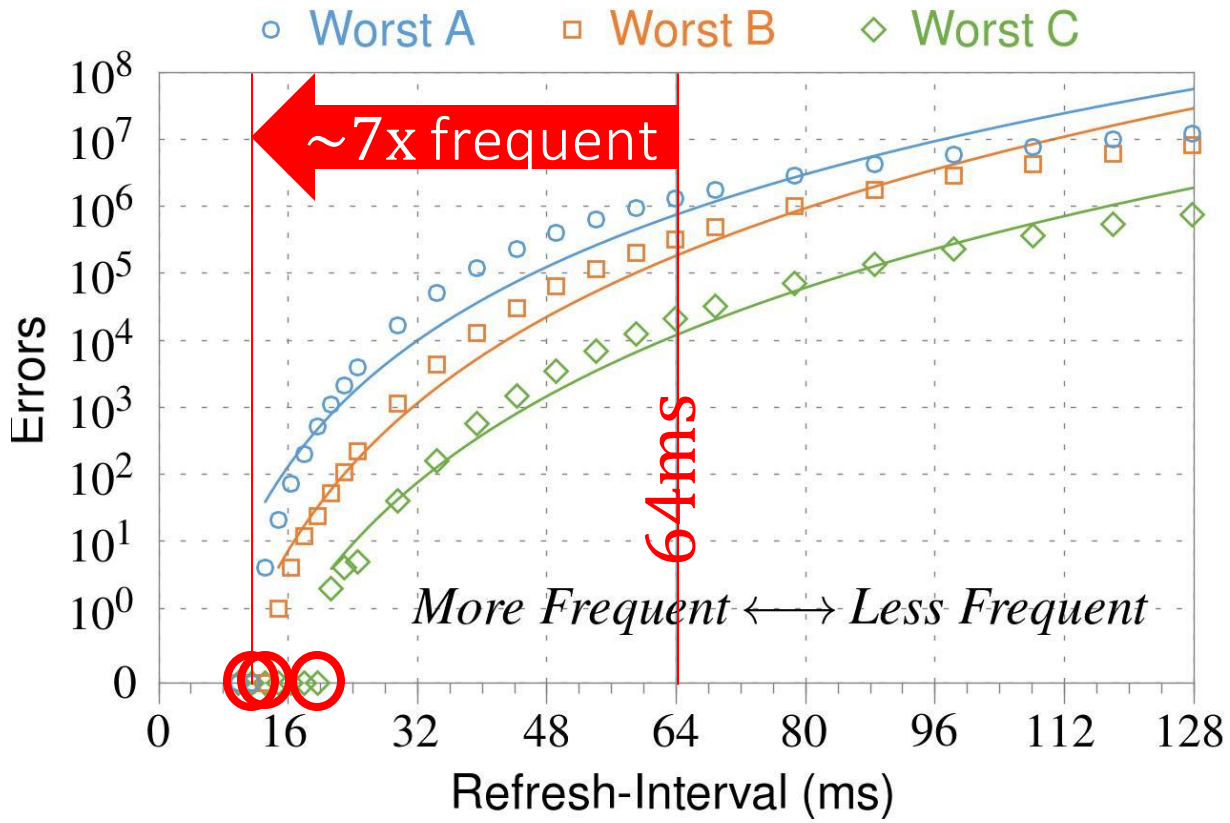
❶ Access Interval (Aggressor)



Note: For three modules with the most errors (only first bank)

Less frequent accesses → Fewer errors

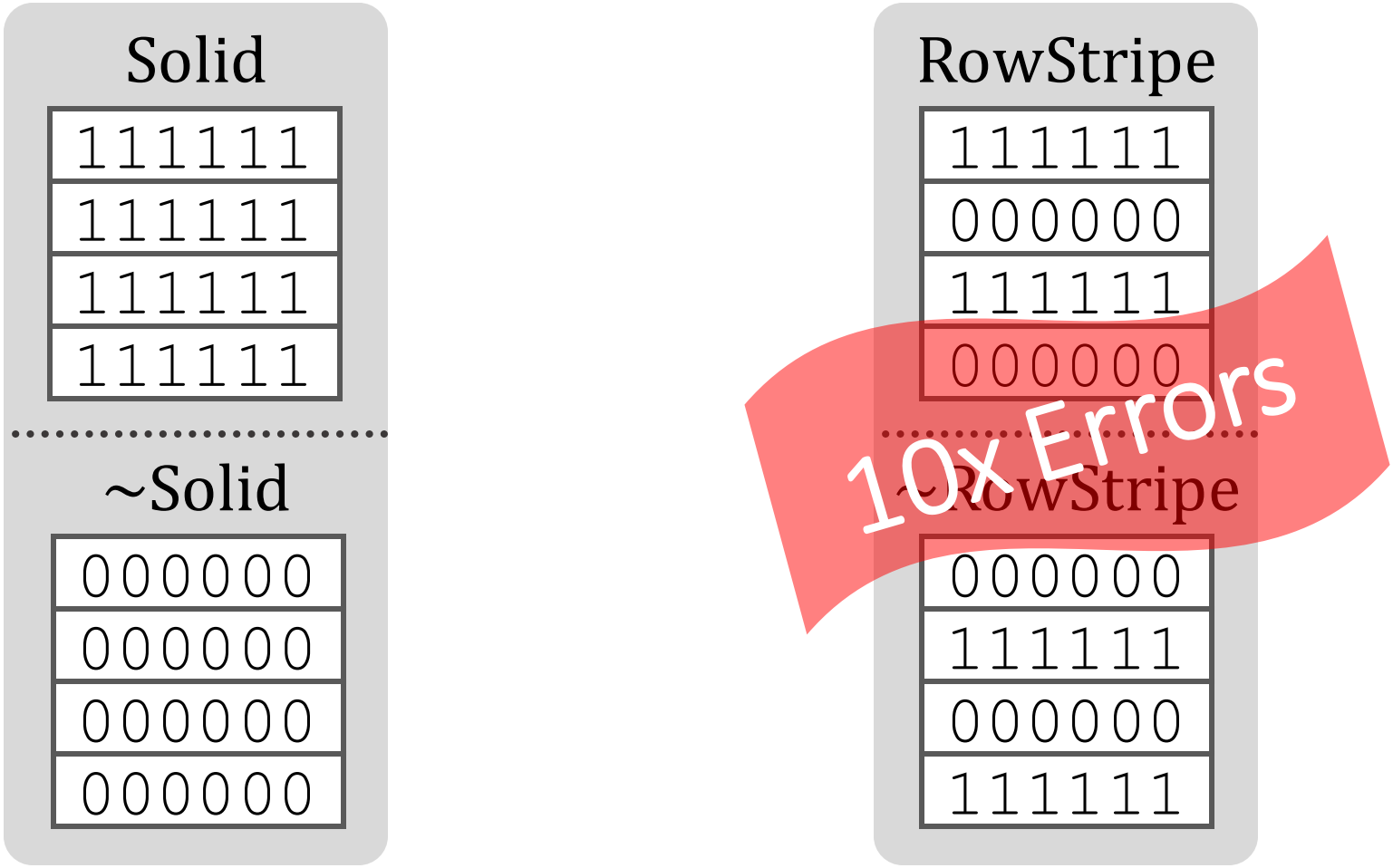
❷ Refresh Interval



Note: Using three modules with the most errors (only first bank)

More frequent refreshes → Fewer errors

❸ Data Pattern



Errors affected by data stored in other cells

6. Other Results (in Paper)

- *Victim Cells ≠ Weak Cells (i.e., leaky cells)*
  - Almost no overlap between them

- *Errors not strongly affected by temperature*
  - Default temperature: $50°C$
  - At $30°C$ and $70°C$, number of errors changes $<15\%$

- *Errors are repeatable*
  - Across ten iterations of testing, $>70\%$ of victim cells had errors in every iteration

6. Other Results (in Paper) cont'd

- *As many as 4 errors per cache-line*
  - Simple ECC (e.g., SECDED) cannot prevent all errors

- *Number of cells & rows affected by aggressor*
  - Victims cells per aggressor: ≤ 110
  - Victims rows per aggressor: ≤ 9

- *Cells affected by two aggressors on either side*
  - Very small fraction of victim cells (< 100) have an error when either one of the aggressors is toggled

First RowHammer Analysis

- Yoongu Kim, Ross Daly, Jeremie Kim, Chris Fallin, Ji Hye Lee, Donghyuk Lee, Chris Wilkerson, Konrad Lai, and Onur Mutlu,
  "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors"
  *Proceedings of the 41st International Symposium on Computer Architecture (**ISCA**)*, Minneapolis, MN, June 2014.
  [Slides (pptx) (pdf)] [Lightning Session Slides (pptx) (pdf)] [Source Code and Data]

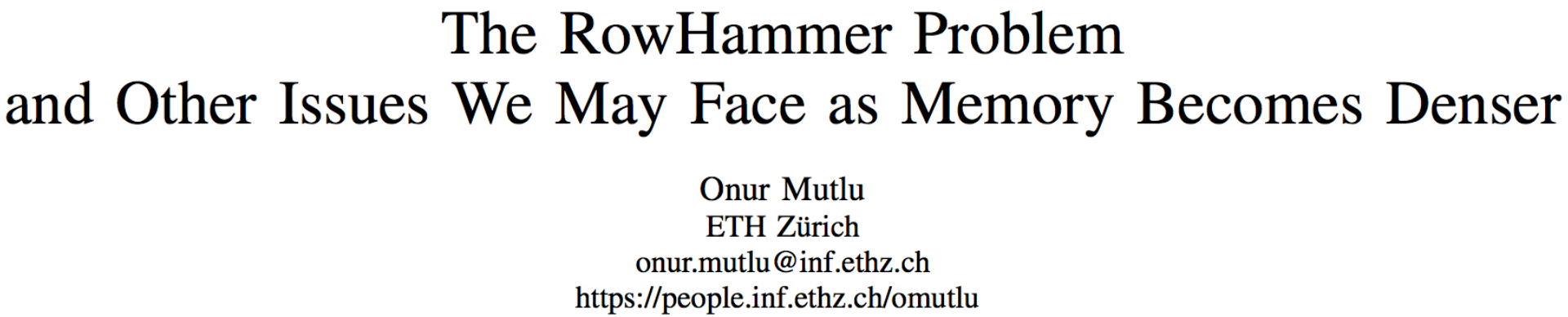
Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors

Yoongu Kim[1] Ross Daly* Jeremie Kim[1] Chris Fallin* Ji Hye Lee[1]
Donghyuk Lee[1] Chris Wilkerson[2] Konrad Lai Onur Mutlu[1]

[1]Carnegie Mellon University [2]Intel Labs

Retrospective on RowHammer & Future

- Onur Mutlu,
  "The RowHammer Problem and Other Issues We May Face as Memory Becomes Denser"
  *Invited Paper in Proceedings of the Design, Automation, and Test in Europe Conference (**DATE**)*, Lausanne, Switzerland, March 2017.
  [Slides (pptx) (pdf)]


The RowHammer Problem
and Other Issues We May Face as Memory Becomes Denser

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https://people.inf.ethz.ch/omutlu

RowHammer Solutions

Two Types of RowHammer Solutions

- Immediate
  - To protect the vulnerable DRAM chips in the field
  - Limited possibilities

- Longer-term
  - To protect future DRAM chips
  - Wider range of protection mechanisms

- Our ISCA 2014 paper proposes both types of solutions
  - Seven solutions in total
  - PARA proposed as best solution → already employed in the field

Some Potential Solutions (ISCA 2014)

- Make better DRAM chips — Cost
- Refresh frequently — Power, Performance
- Sophisticated ECC — Cost, Power
- Access counters — Cost, Power, Complexity

Naive Solutions

1. *Throttle accesses to same row*
   - Limit access-interval: $\geq 500\text{ns}$
   - Limit number of accesses: $\leq 128\text{K}$ $(=64\text{ms}/500\text{ns})$

2. *Refresh more frequently*
   - Shorten refresh-interval by $\sim 7\text{x}$

Both naive solutions introduce significant overhead in performance and power

Apple's Patch for RowHammer

- https://support.apple.com/en-gb/HT204934

Available for: OS X Mountain Lion v10.8.5, OS X Mavericks v10.9.5

Impact: A malicious application may induce memory corruption to escalate privileges

Description: A disturbance error, also known as Rowhammer, exists with some DDR3 RAM that could have led to memory corruption. This issue was mitigated by increasing memory refresh rates.

CVE-ID

CVE-2015-3693 : Mark Seaborn and Thomas Dullien of Google, working from original research by Yoongu Kim et al (2014)

HP, Lenovo, and other vendors released similar patches

Our Best Solution to RowHammer

- PARA: *Probabilistic Adjacent Row Activation*
- Key Idea
  - After closing a row, we activate (i.e., refresh) one of its neighbors with a low probability: $p = 0.005$
- Reliability Guarantee
  - When $p=0.005$, errors in one year: 9.4×10^{-14}
  - By adjusting the value of p, we can vary the strength of protection against errors

Advantages of PARA

- *PARA refreshes rows infrequently*
  - Low power
  - Low performance-overhead
    - Average slowdown: 0.20% (for 29 benchmarks)
    - Maximum slowdown: 0.75%
- *PARA is stateless*
  - Low cost
  - Low complexity

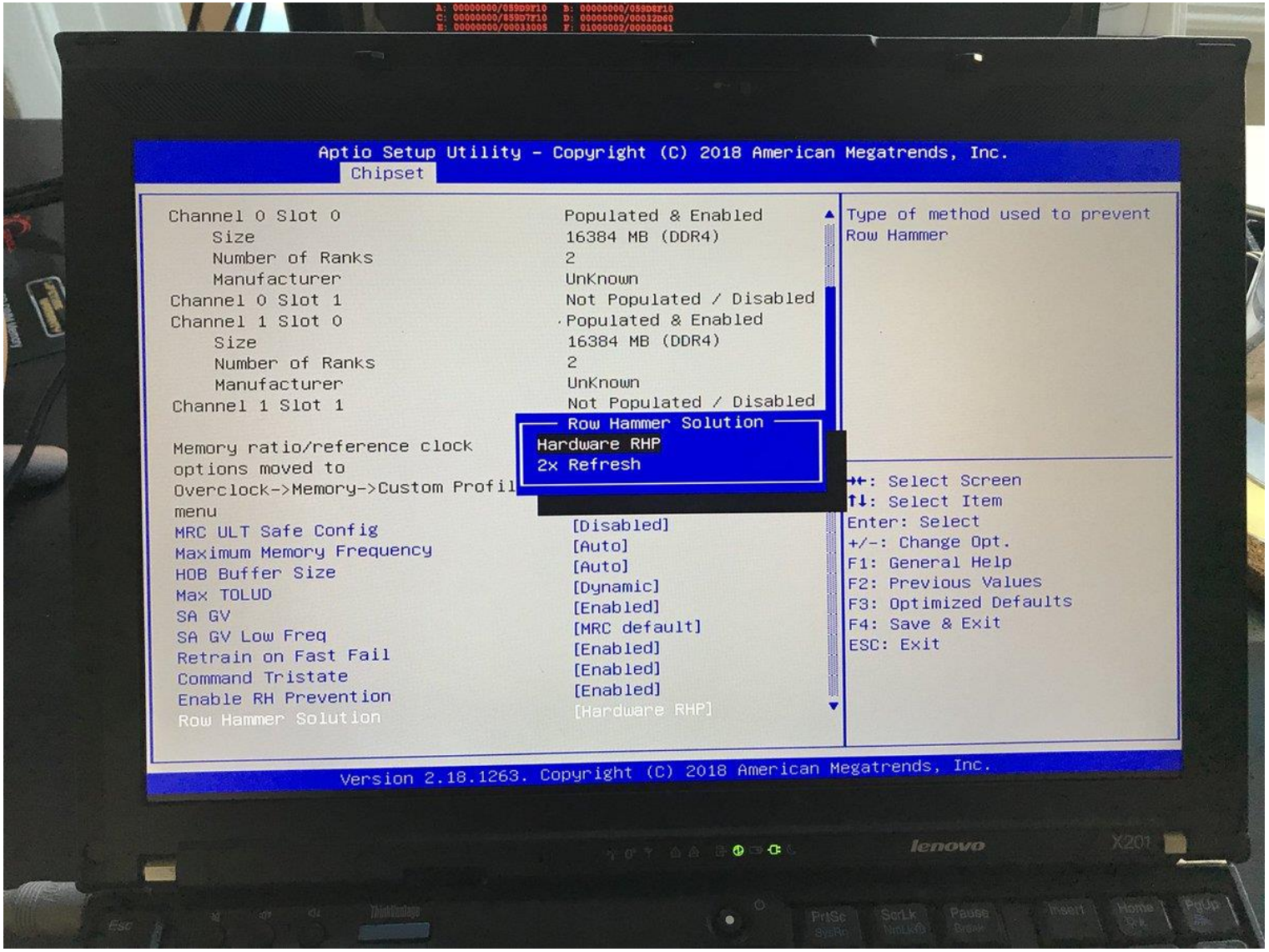
- *PARA is an effective and low-overhead solution to prevent disturbance errors*

Requirements for PARA

- If implemented in DRAM chip (done today)
  - Enough slack in timing and refresh parameters
  - Plenty of slack today:
    - Lee et al., "Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common Case," HPCA 2015.
    - Chang et al., "Understanding Latency Variation in Modern DRAM Chips," SIGMETRICS 2016.
    - Lee et al., "Design-Induced Latency Variation in Modern DRAM Chips," SIGMETRICS 2017.
    - Chang et al., "Understanding Reduced-Voltage Operation in Modern DRAM Devices," SIGMETRICS 2017.
    - Ghose et al., "What Your DRAM Power Models Are Not Telling You: Lessons from a Detailed Experimental Study," SIGMETRICS 2018.

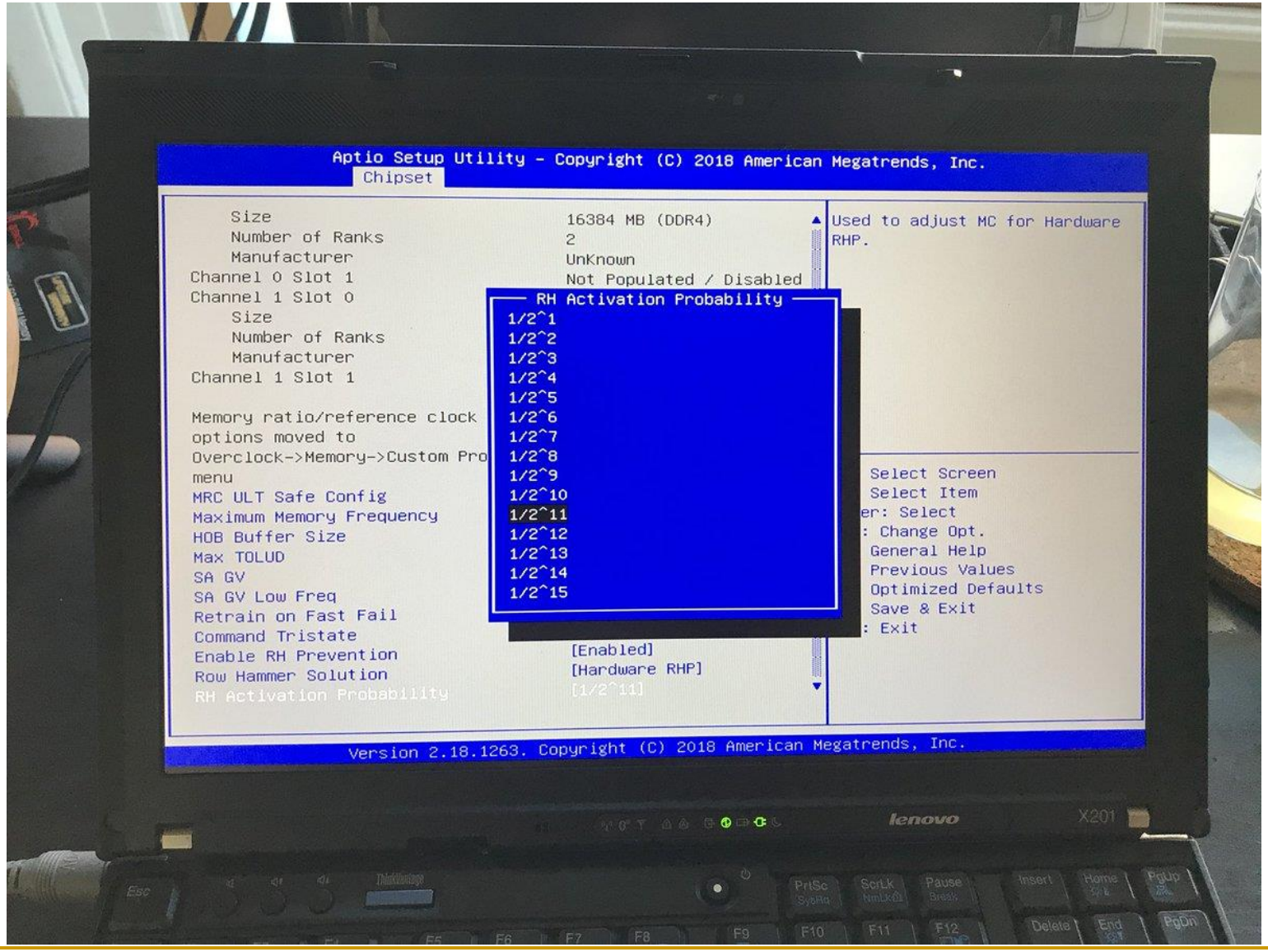
- If implemented in memory controller
  - Better coordination between memory controller and DRAM
  - Memory controller should know which rows are physically adjacent

Probabilistic Activation in Real Life (I)



https://twitter.com/isislovecruft/status/1021939922754723841

Probabilistic Activation in Real Life (II)



https://twitter.com/isislovecruft/status/1021939922754723841

Seven RowHammer Solutions Proposed

- Yoongu Kim, Ross Daly, Jeremie Kim, Chris Fallin, Ji Hye Lee, Donghyuk Lee, Chris Wilkerson, Konrad Lai, and Onur Mutlu,
  "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors"
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Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors

Yoongu Kim[1] Ross Daly* Jeremie Kim[1] Chris Fallin* Ji Hye Lee[1]
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Future Memory Reliability/Security Challenges

Future of RowHammer & Memory Reliability

- Onur Mutlu,
  "The RowHammer Problem and Other Issues We May Face as Memory Becomes Denser"
  *Invited Paper in Proceedings of the Design, Automation, and Test in Europe Conference (**DATE**)*, Lausanne, Switzerland, March 2017.
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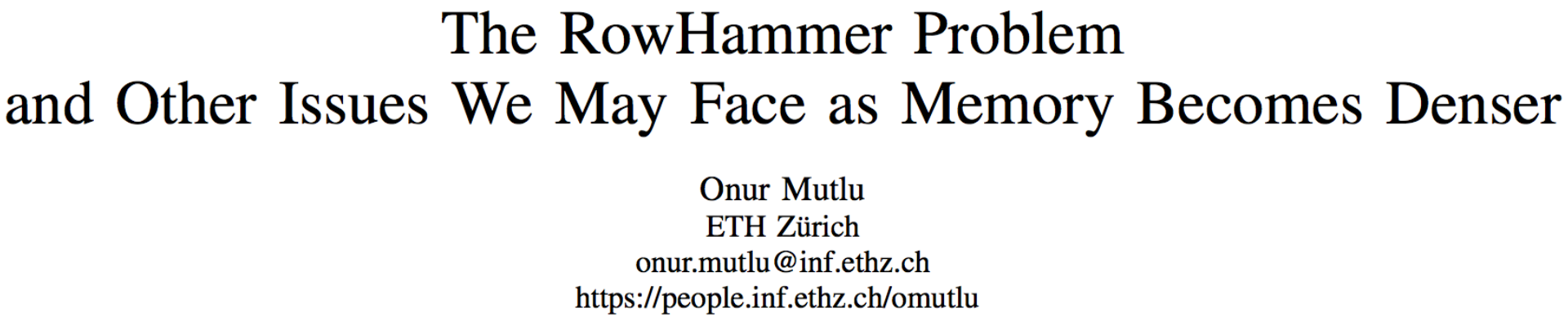

The RowHammer Problem
and Other Issues We May Face as Memory Becomes Denser

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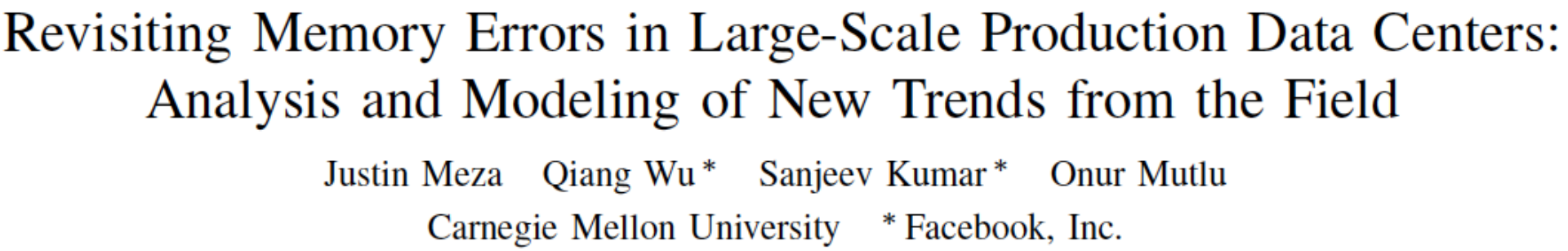
Future of Main Memory

- DRAM is becoming less reliable → more vulnerable

Large-Scale Failure Analysis of DRAM Chips

- Analysis and modeling of memory errors found in all of Facebook's server fleet

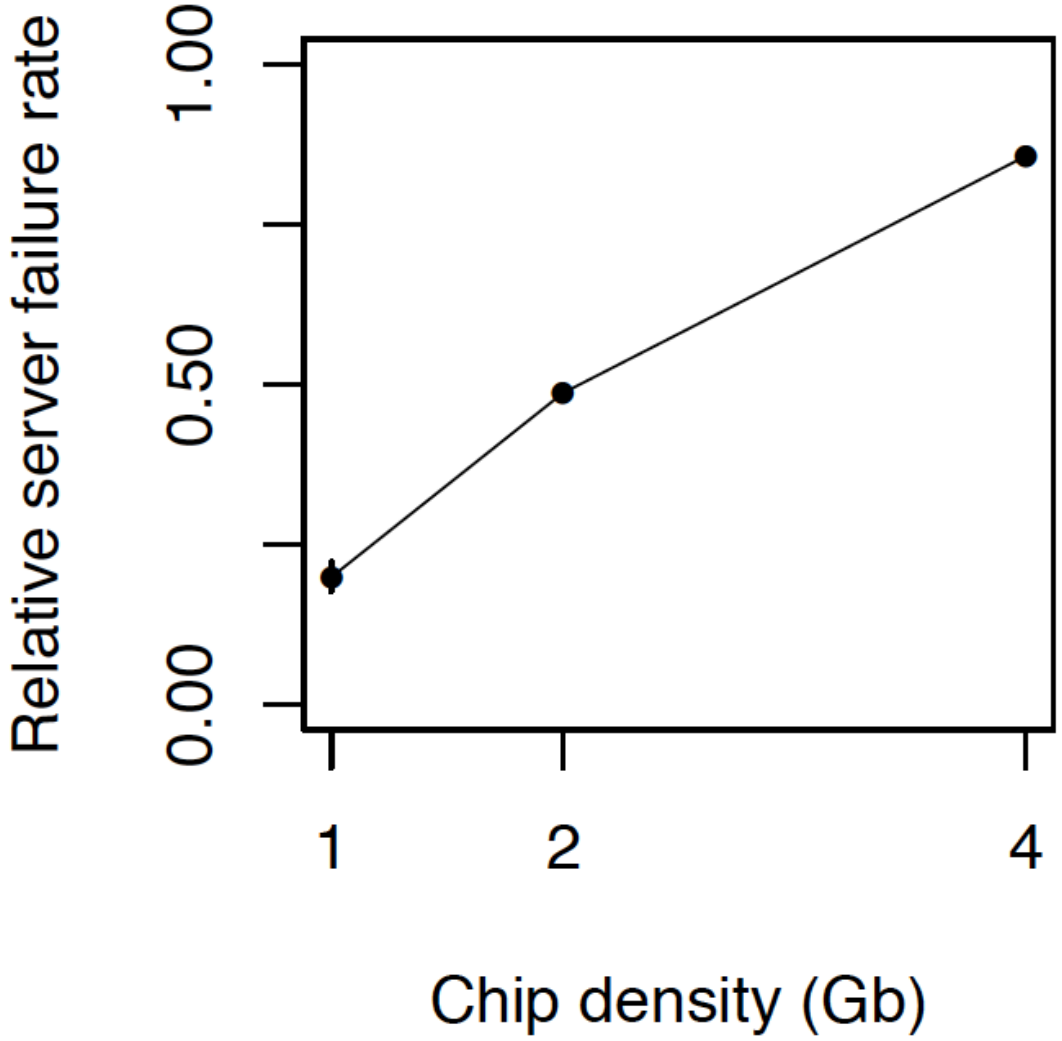
- Justin Meza, Qiang Wu, Sanjeev Kumar, and Onur Mutlu, **"Revisiting Memory Errors in Large-Scale Production Data Centers: Analysis and Modeling of New Trends from the Field"** *Proceedings of the 45th Annual IEEE/IFIP International Conference on Dependable Systems and Networks (**DSN**)*, Rio de Janeiro, Brazil, June 2015.
  [Slides (pptx) (pdf)] [DRAM Error Model]


Revisiting Memory Errors in Large-Scale Production Data Centers: Analysis and Modeling of New Trends from the Field

Justin Meza Qiang Wu * Sanjeev Kumar * Onur Mutlu

Carnegie Mellon University * Facebook, Inc.

DRAM Reliability Reducing



Intuition: quadratic increase in capacity

Meza+, "Revisiting Memory Errors in Large-Scale Production Data Centers," DSN'15.

Future of Main Memory Security

- DRAM is becoming less reliable → more vulnerable
- Due to difficulties in DRAM scaling, other problems may also appear (or they may be going unnoticed)
- Some errors may already be slipping into the field
  - Read disturb errors (Rowhammer)
  - Retention errors
  - Read errors, write errors
  - …
- These errors can also pose security vulnerabilities

How Do We Keep Memory Secure?

- DRAM
- Flash memory
- Emerging Technologies
  - Phase Change Memory
  - STT-MRAM
  - RRAM, memristors
  - …

Solution Direction: Principled Designs

Design fundamentally secure computing architectures

Predict and prevent such safety issues

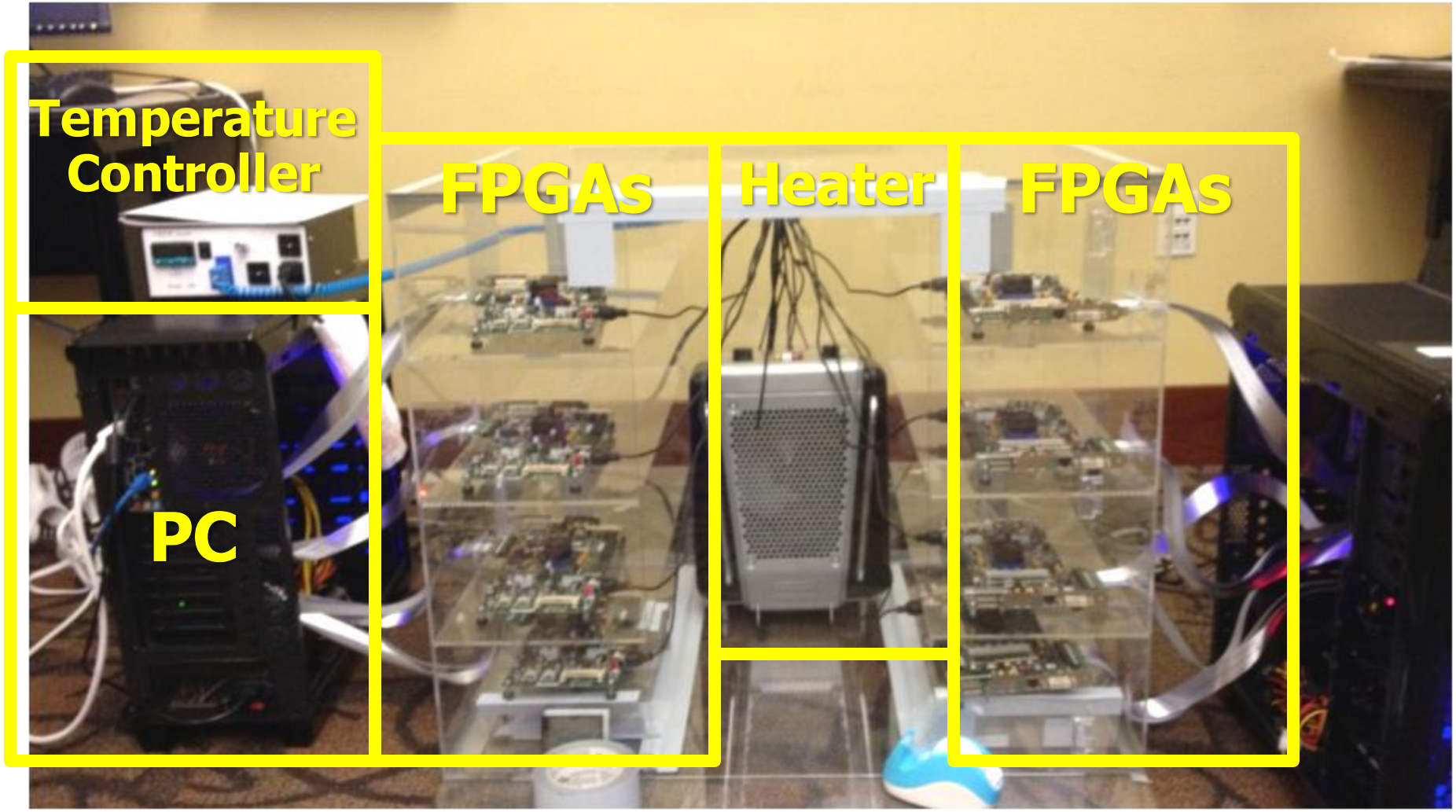
Architecting Future Memory for Security

- **Understand**: Methods for vulnerability modeling & discovery
  - Modeling and prediction based on real (device) data and analysis
  - Understanding vulnerabilities
  - Developing reliable metrics

- **Architect**: Principled architectures with security as key concern
  - Good partitioning of duties across the stack
  - Cannot give up performance and efficiency
  - Patch-ability in the field

- **Design & Test**: Principled design, automation, (online) testing
  - Design for security
  - High coverage and good interaction with system reliability methods

Understand and Model with Experiments (DRAM)



Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

Key Contributions and Impact

Recall: Collapse of the "Galloping Gertie"

Source: AP
http://www.wsdot.wa.gov/tnbhistory/connections/connections3.htm

Another Example (1994)

Yet Another Example (2007)

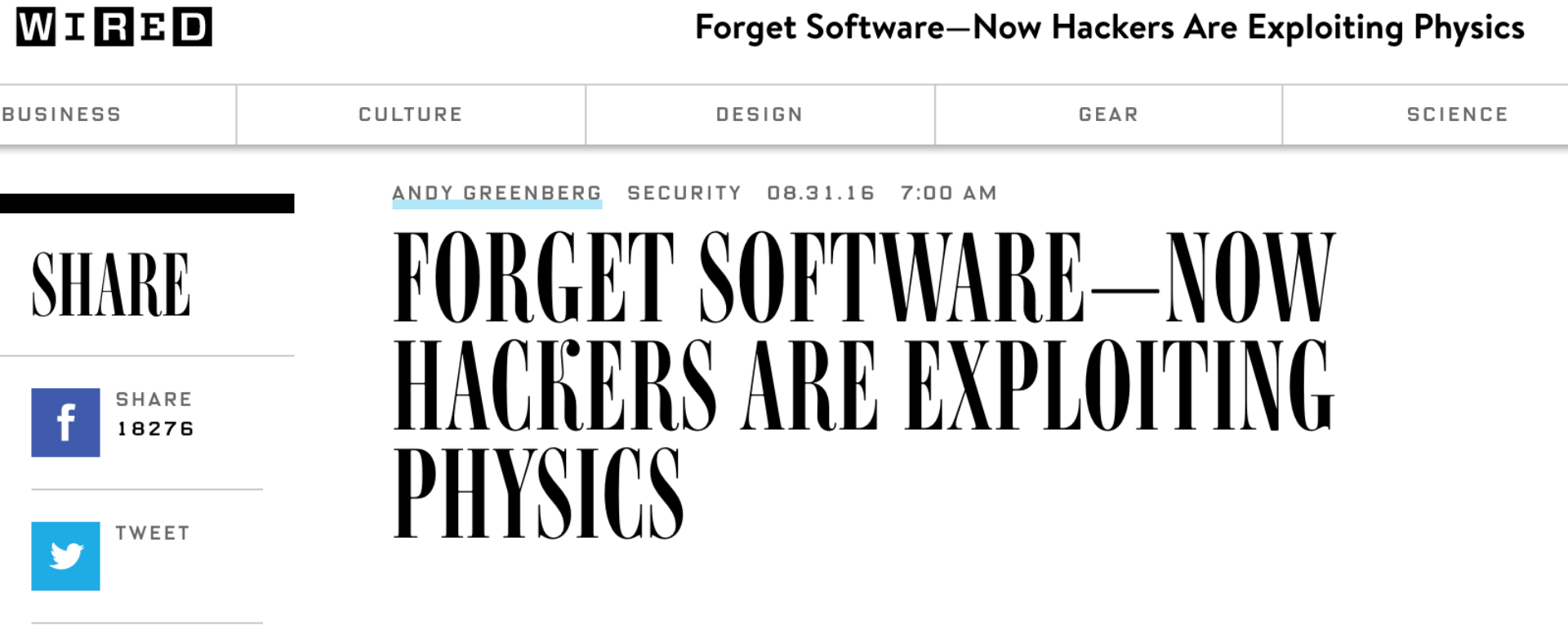
Source: Morry Gash/AP,
https://www.npr.org/2017/08/01/540669701/10-years-after-bridge-collapse-america-is-still-crumbling?t=1535427165809

A More Recent Example (2018)

Source: AFP / Valery HACHE, https://www.capitalfm.co.ke/news/2018/08/genoa-bridge-collapse-what-we-know/

Key Discovery (ISCA 2014)

- One can predictably induce bit flips in commodity DRAM chips
  - >80% of the tested DRAM chips are vulnerable
- First example of how a simple hardware failure mechanism can create a widespread system security vulnerability



Key Contributions & Impact (ISCA 2014)

- New mindset that has enabled a renewed interest in HW security attack research:
  - Real (memory) chips are vulnerable, in a simple and widespread manner → this causes real security problems
  - Hardware (memory) security is now part of the mainstream discourse

- Many new RowHammer attacks build on our work
  - Tens of papers in top security venues
  - **More to come** as RowHammer is getting worse (DDR4 & beyond)

- Many new RowHammer solutions inspired by our work
  - Apple security release; Memtest86 updated
  - Many solution proposals in top venues (latest in OSDI 2018)
  - Principled system-DRAM co-design (first proposed by our paper)
  - **More to come**

Perhaps Most Importantly…

- RowHammer enabled a shift of mindset in mainstream security researchers
  - General-purpose hardware is fallible, in a widespread manner
  - Its problems are exploitable
- This mindset has enabled many systems security researchers to examine hardware in more depth
  - And understand HW's inner workings and vulnerabilities
- It is no coincidence that two of the groups that discovered Meltdown and Spectre heavily worked on RowHammer attacks before
  - **More to come…**

Conclusion

Summary: RowHammer

- DRAM reliability is reducing
- Reliability issues open up security vulnerabilities
  - Very hard to defend against
- **Rowhammer is a prime example**
  - First example of how a simple hardware failure mechanism can create a widespread system security vulnerability
  - Its implications on system security research are tremendous & exciting
- Bad news: RowHammer is getting worse.
- **Good news: We have a lot more to do.**
  - We are now fully aware hardware is easily fallible.
  - We are developing both attacks and solutions.
  - We are developing principled models, methodologies, solutions.

RowHammer

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November 8, 2018

Top Picks in Hardware and Embedded Security

SAFARI

ETH zürich

Carnegie Mellon

Backup Slides

Keeping Future Memory Secure

Architecting for Security

- **Understand**: Methods for vulnerability modeling & discovery
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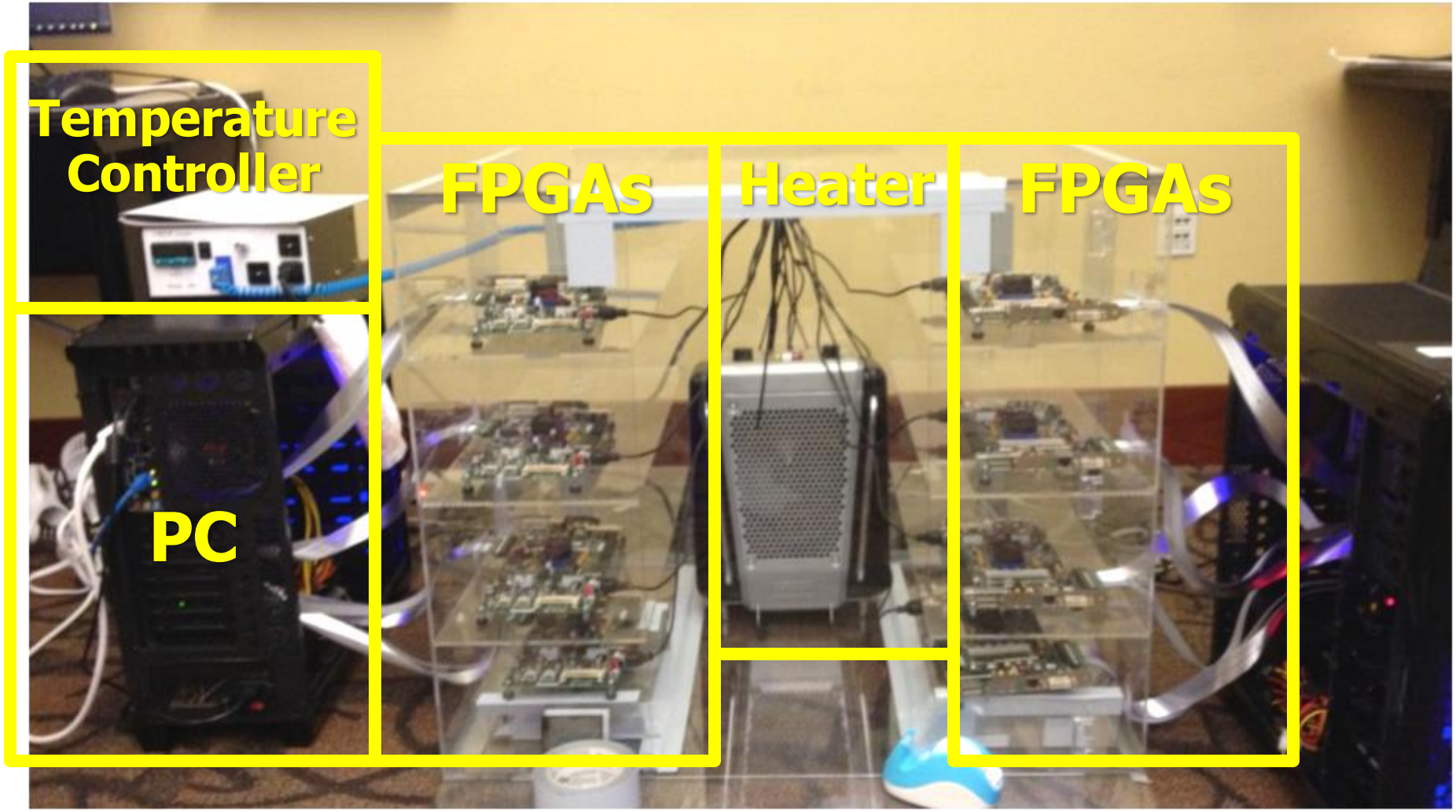
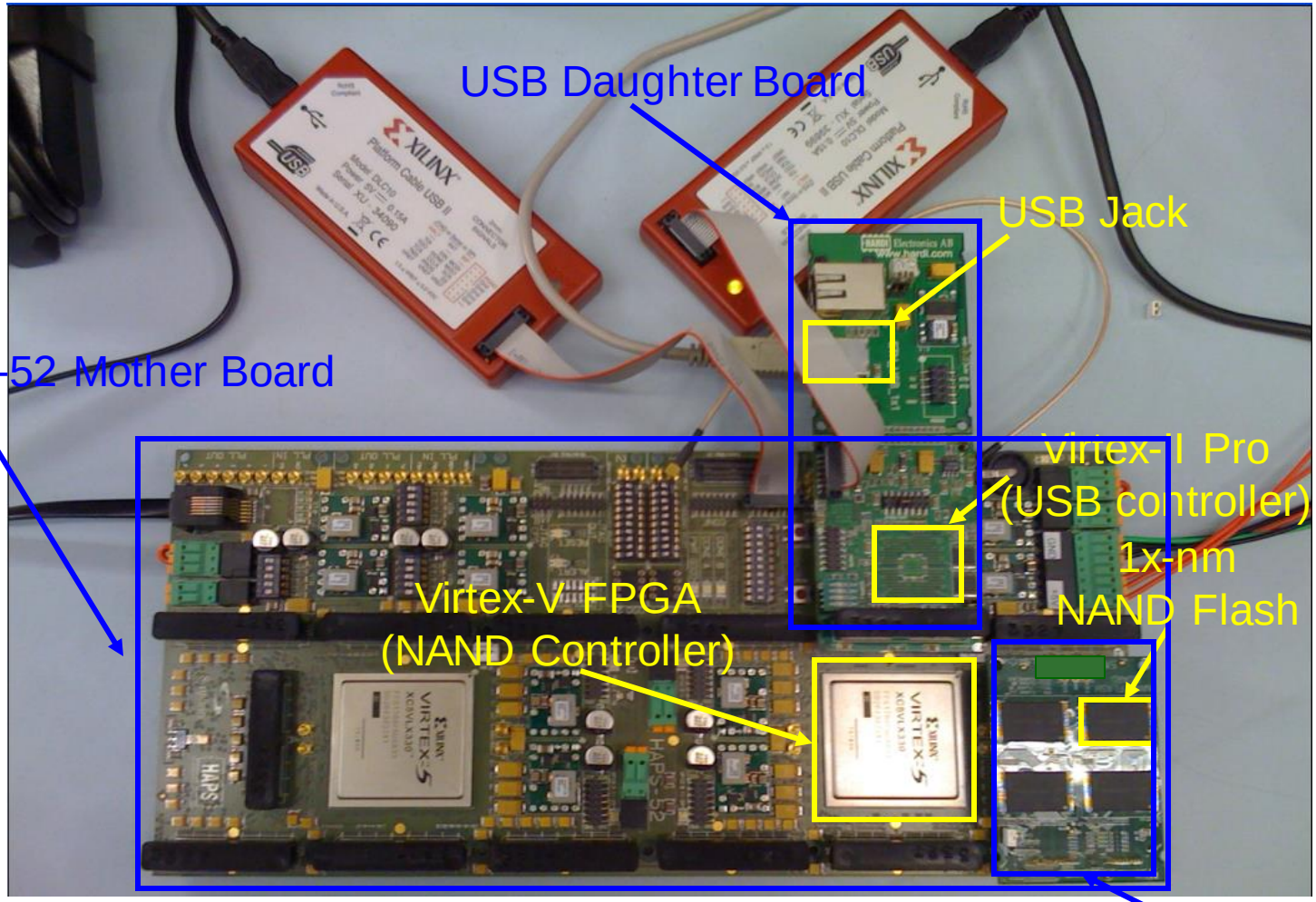
- **Design & Test**: Principled design, automation, (online) testing
  - Design for security
  - High coverage and good interaction with system reliability methods

Understand and Model with Experiments (DRAM)



Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

Understand and Model with Experiments (Flash)



[DATE 2012, ICCD 2012, DATE 2013, ITJ 2013, ICCD 2013, SIGMETRICS 2014, HPCA 2015, DSN 2015, MSST 2015, JSAC 2016, HPCA 2017, DFRWS 2017, PIEEE 2017, HPCA 2018, SIGMETRICS 2018]

Cai+, "Error Characterization, Mitigation, and Recovery in Flash Memory Based Solid State Drives," Proc. IEEE 2017.

Understanding Flash Memory Reliability

Proceedings of the IEEE, Sept. 2017

Error Characterization, Mitigation, and Recovery in Flash-Memory-Based Solid-State Drives

This paper reviews the most recent advances in solid-state drive (SSD) error characterization, mitigation, and data recovery techniques to improve both SSD's reliability and lifetime.

By Yu Cai, Saugata Ghose, Erich F. Haratsch, Yixin Luo, and Onur Mutlu

https://arxiv.org/pdf/1706.08642

Understanding Flash Memory Reliability

- Justin Meza, Qiang Wu, Sanjeev Kumar, and Onur Mutlu,
  "A Large-Scale Study of Flash Memory Errors in the Field"
  *Proceedings of the ACM International Conference on Measurement and Modeling of Computer Systems (**SIGMETRICS**)*, Portland, OR, June 2015.
  [Slides (pptx) (pdf)] [Coverage at ZDNet] [Coverage on The Register]
  [Coverage on TechSpot] [Coverage on The Tech Report]

A Large-Scale Study of Flash Memory Failures in the Field

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NAND Flash Vulnerabilities [HPCA'17]

HPCA, Feb. 2017

Vulnerabilities in MLC NAND Flash Memory Programming: Experimental Analysis, Exploits, and Mitigation Techniques

Yu Cai[†] Saugata Ghose[†] Yixin Luo[‡†] Ken Mai[†] Onur Mutlu[§†] Erich F. Haratsch[‡]
[†]*Carnegie Mellon University* [‡]*Seagate Technology* [§]*ETH Zürich*

Modern NAND flash memory chips provide high density by storing two bits of data in each flash cell, called a multi-level cell *(MLC). An MLC partitions the threshold voltage range of a flash cell into four* voltage states. *When a flash cell is programmed, a high voltage is applied to the cell. Due to parasitic capacitance coupling between flash cells that are physically close to each other, flash cell programming can lead to* cell-to-cell program interference, *which introduces errors into* neighboring *flash cells. In order to reduce the impact of cell-to-cell interference on the reliability of MLC NAND flash memory, flash manufacturers adopt a* two-step programming method, *which programs the MLC in two separate steps. First, the flash memory partially programs the least significant bit of the MLC to some intermediate threshold voltage. Second, it programs the most significant bit to bring the MLC up to its full voltage state.*

In this paper, we demonstrate that two-step programming exposes new reliability and security vulnerabilities. We expe-

belongs to a different flash memory *page* (the unit of data programmed and read at the same time), which we refer to, respectively, as the least significant bit (LSB) page and the most significant bit (MSB) page [5].

A flash cell is programmed by applying a large voltage on the control gate of the transistor, which triggers charge transfer into the floating gate, thereby increasing the threshold voltage. To precisely control the threshold voltage of the cell, the flash memory uses *incremental step pulse programming* (ISPP) [12, 21, 25, 41]. ISPP applies multiple short pulses of the programming voltage to the control gate, in order to increase the cell threshold voltage by some small voltage amount (V_{step}) after each step. Initial MLC designs programmed the threshold voltage in *one shot*, issuing all of the pulses back-to-back to program *both* bits of data at the same time. However, as flash memory scales down, the distance between neighboring flash cells decreases, which

https://people.inf.ethz.ch/omutlu/pub/flash-memory-programming-vulnerabilities_hpca17.pdf

Original RowHammer Talk (ISCA 2014)

Flipping Bits in Memory Without Accessing Them

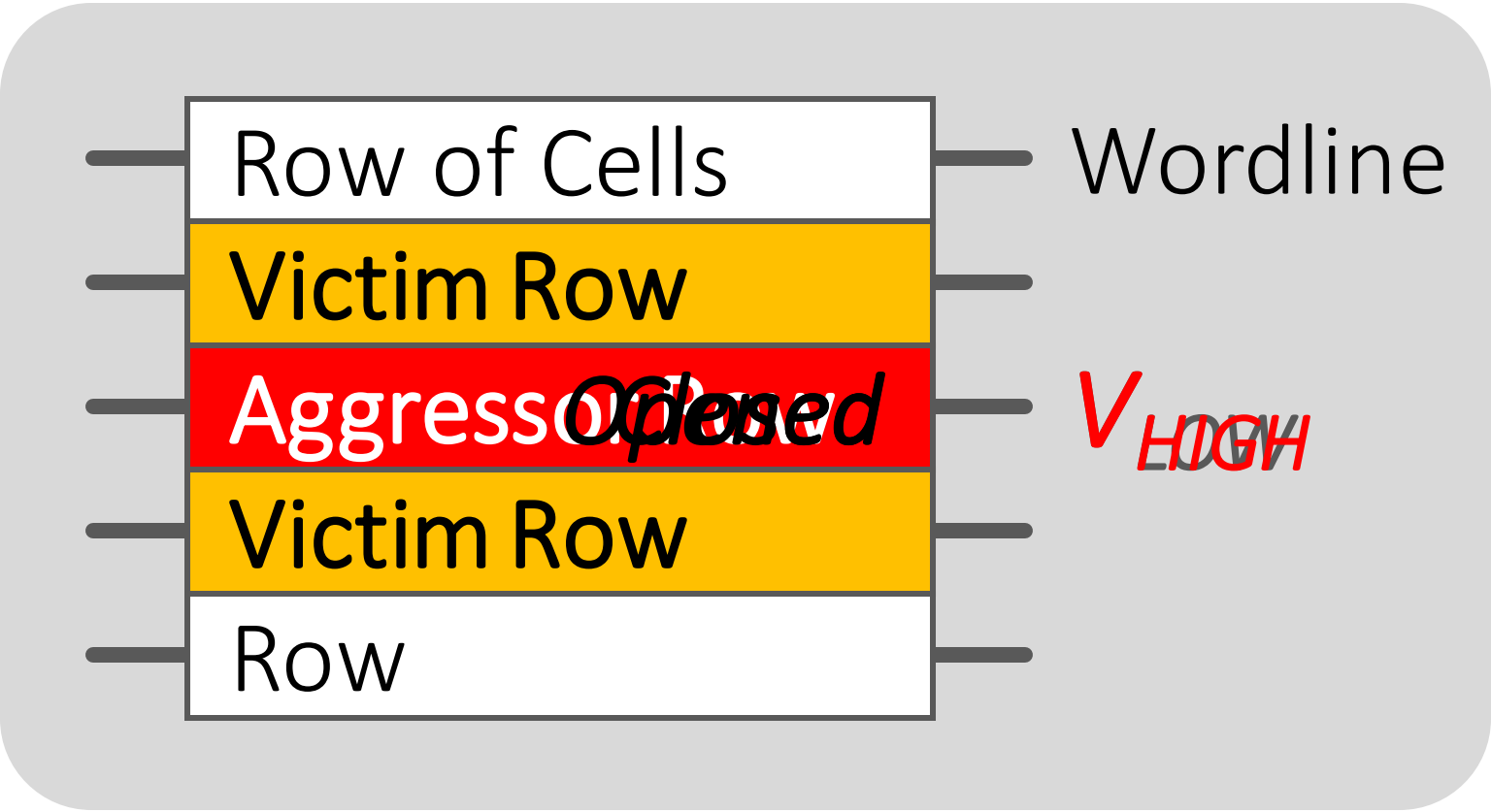
DRAM Disturbance Errors

Yoongu Kim

Ross Daly, Jeremie Kim, Chris Fallin, Ji Hye Lee,
Donghyuk Lee, Chris Wilkerson, Konrad Lai, Onur Mutlu

Carnegie Mellon SAFARI intel

DRAM Chip



*Repeatedly opening and closing a row induces **disturbance errors** in adjacent rows*

Quick Summary of Paper

- *We expose the **existence** and **prevalence** of disturbance errors in DRAM chips of today*
  - 110 of 129 modules are vulnerable
  - Affects modules of 2010 vintage or later

- *We characterize the **cause** and **symptoms***
  - Toggling a row accelerates charge leakage in adjacent rows: *row-to-row coupling*

- *We prevent errors using a **system-level** approach*
  - Each time a row is closed, we refresh the charge stored in its adjacent rows with a low probability

1. Historical Context

2. Demonstration (Real System)

3. Characterization (FPGA-Based)

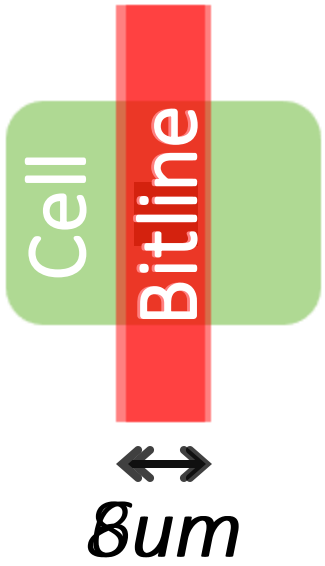
4. Solutions

A Trip Down Memory Lane

1968 IBM's patent on DRAM

1971 Intel commercializes DRAM (Intel 1103)

- Suffered bitline-to-cell coupling



2013

2014

"... this big fat metal line with full level signals running right over the storage node (of cell)."

*– **Joel Karp** (1103 Designer)*
Interview: Comp. History Museum

A Trip Down Memory Lane

1968 IBM's patent on DRAM

1971 Intel commercializes DRAM (Intel 1103)

- Suffered bitline-to-cell coupling

2010 Earliest DRAM with row-to-row coupling

2013 We observe row-to-row coupling

2014 Intel's patents mention *"Row Hammer"*

Lessons from History

- *Coupling in DRAM is not new*
  - Leads to *disturbance errors* if not addressed
  - Remains a major hurdle in DRAM scaling
- *Traditional efforts to contain errors*
  - Design-Time: Improve circuit-level isolation
  - Production-Time: Test for disturbance errors
- *Despite such efforts, disturbance errors have been slipping into the field since 2010*

1. Historical Context

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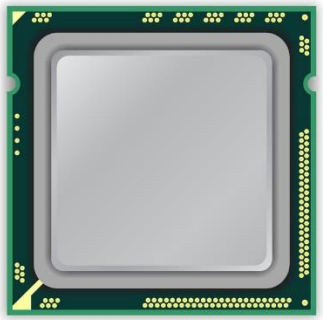
4. Solutions

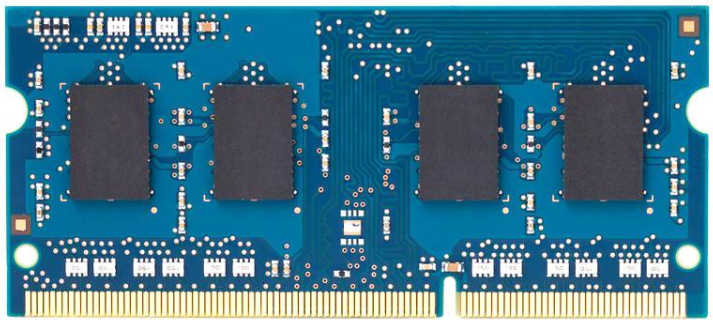
How to Induce Errors

x86 CPU

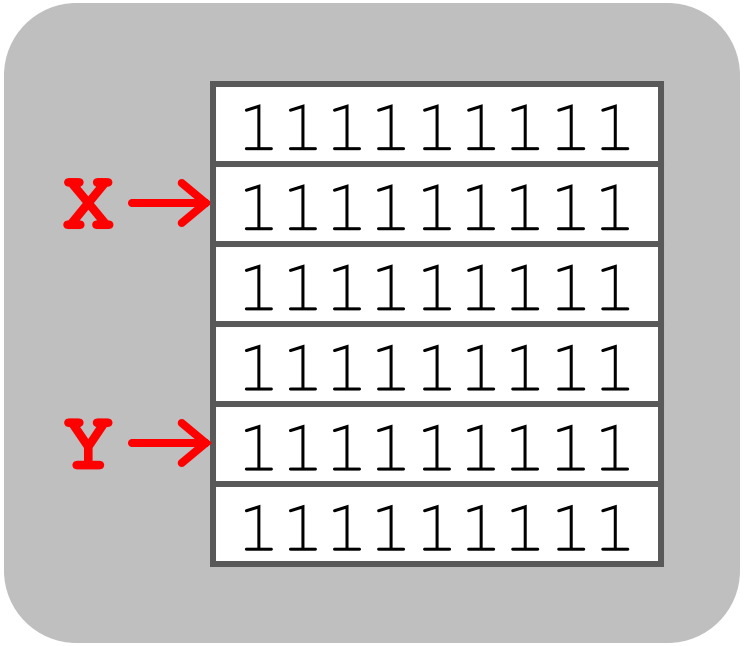


DDR3

DRAM Module

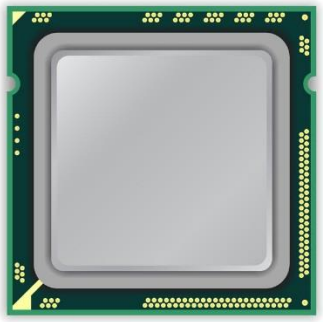


1. Avoid ***cache hits***
   - Flush **X** from cache
2. Avoid ***row hits*** to **X**
   - Read **Y** in another row



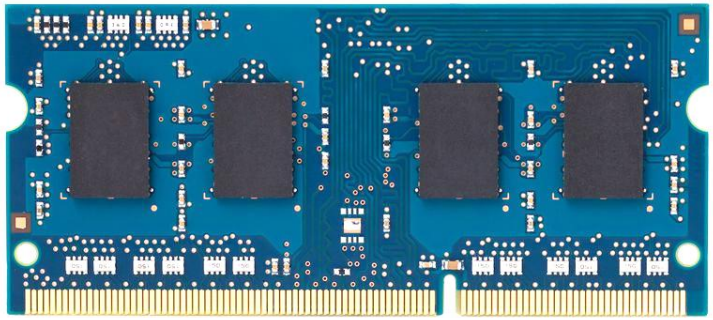
How to Induce Errors

x86 CPU

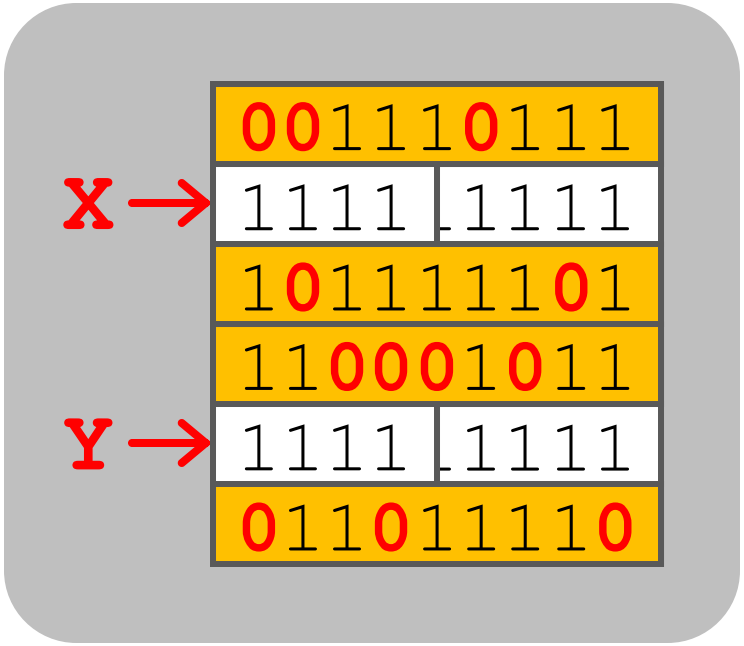


DDR3

DRAM Module



```
loop:
   mov (X), %eax
   mov (Y), %ebx
   clflush (X)
   clflush (Y)
   mfence
   jmp loop
```



Number of Disturbance Errors

CPU Architecture	Errors	Access-Rate
Intel Haswell (2013)	22.9K	12.3M/sec
Intel Ivy Bridge (2012)	20.7K	11.7M/sec
Intel Sandy Bridge (2011)	16.1K	11.6M/sec
AMD Piledriver (2012)	59	6.1M/sec

- *In a more controlled environment, we can induce as many as ten million disturbance errors*
- *Disturbance errors are a serious reliability issue*

Security Implications

- *Breach of memory protection*
  - OS page (4KB) fits inside DRAM row (8KB)
  - Adjacent DRAM row → Different OS page
- *Vulnerability: disturbance attack*
  - By accessing its own page, a program could corrupt pages belonging to another program
- *We constructed a proof-of-concept*
  - Using only user-level instructions

Mechanics of Disturbance Errors

- *Cause 1: Electromagnetic coupling*
  - Toggling the wordline voltage briefly increases the voltage of adjacent wordlines
  - Slightly opens adjacent rows → Charge leakage
- *Cause 2: Conductive bridges*
- *Cause 3: Hot-carrier injection*

Confirmed by at least one manufacturer

1. Historical Context

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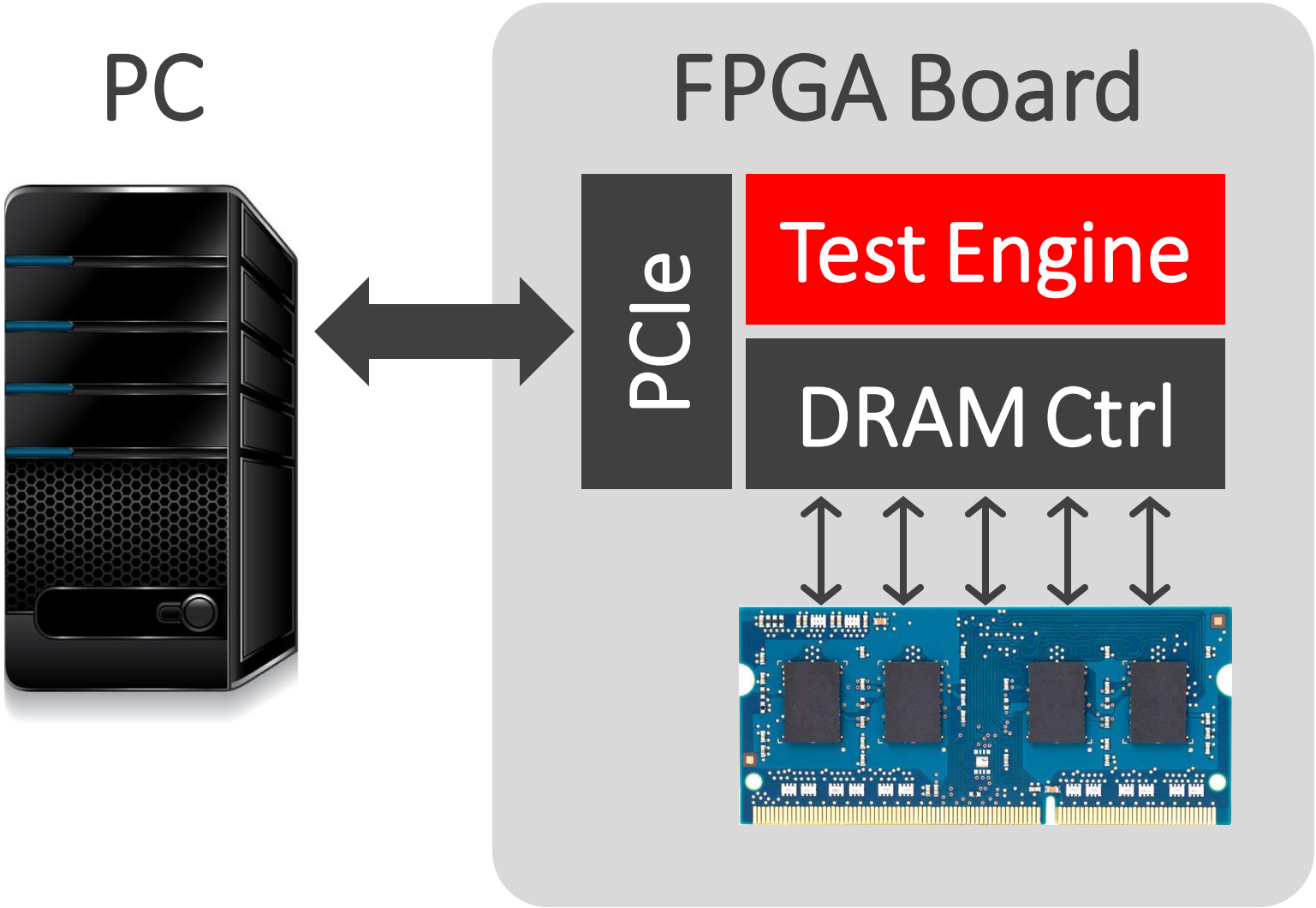
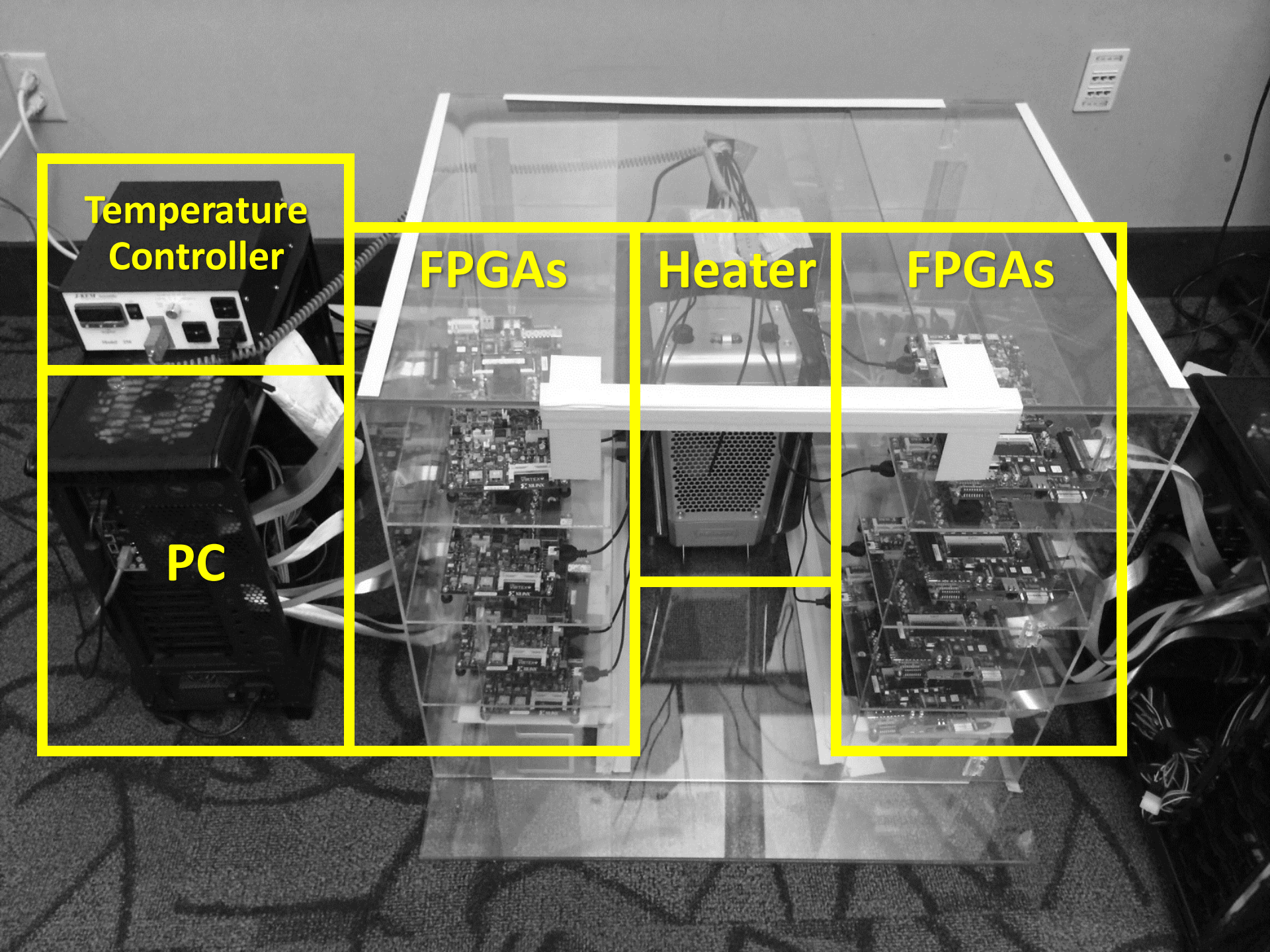
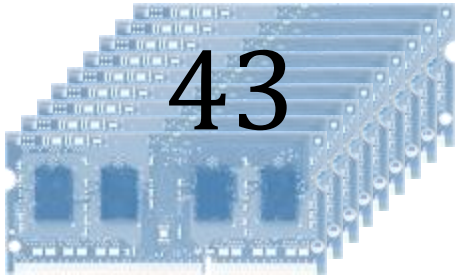
Infrastructure



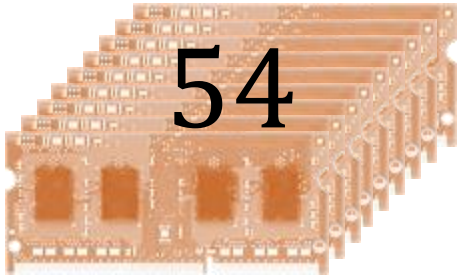

Temperature Controller
PC
FPGAs
Heater
FPGAs

Tested DDR3 DRAM Modules

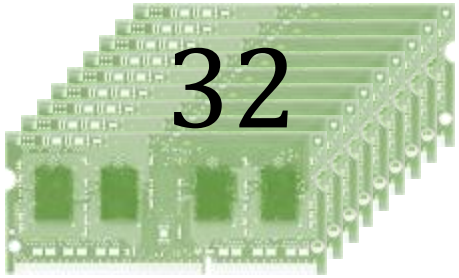
Company A



Company B



Company C

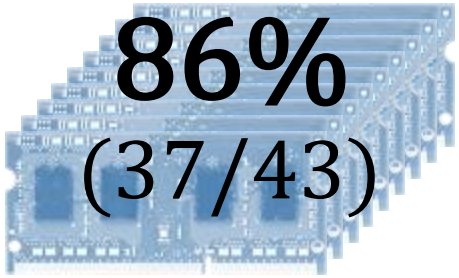
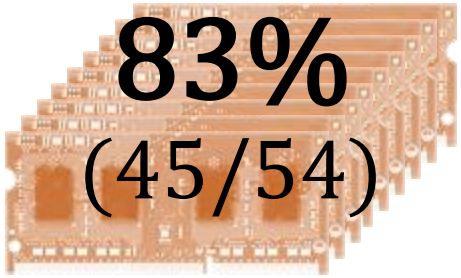
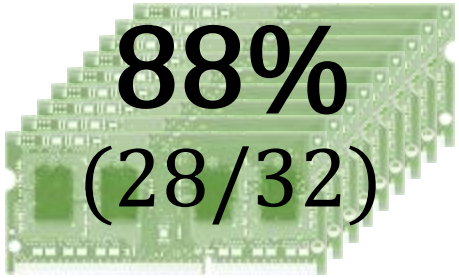


- Total: 129
- Vintage: 2008 – 2014
- Capacity: 512MB – 2GB

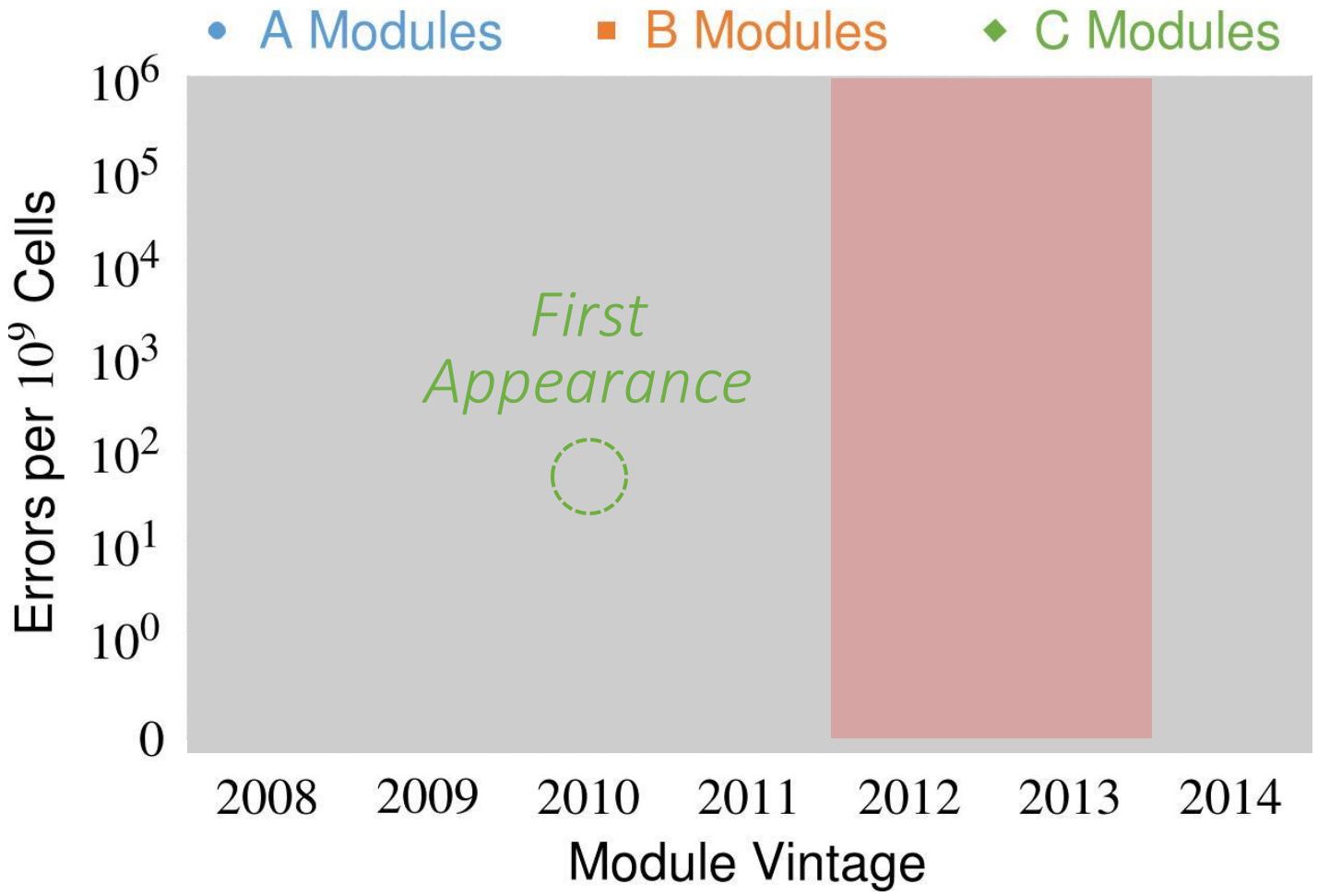
Characterization Results

1. Most Modules Are at Risk
2. Errors vs. Vintage
3. Error = Charge Loss
4. Adjacency: Aggressor & Victim
5. Sensitivity Studies
6. Other Results in Paper

1. Most Modules Are at Risk

A company	B company	C company
 86% (37/43)	 83% (45/54)	 88% (28/32)
Up to 1.0×10^{7} errors	Up to 2.7×10^{6} errors	Up to 3.3×10^{5} errors

2. Errors *vs.* Vintage



All modules from 2012–2013 are vulnerable

3. Error = Charge Loss

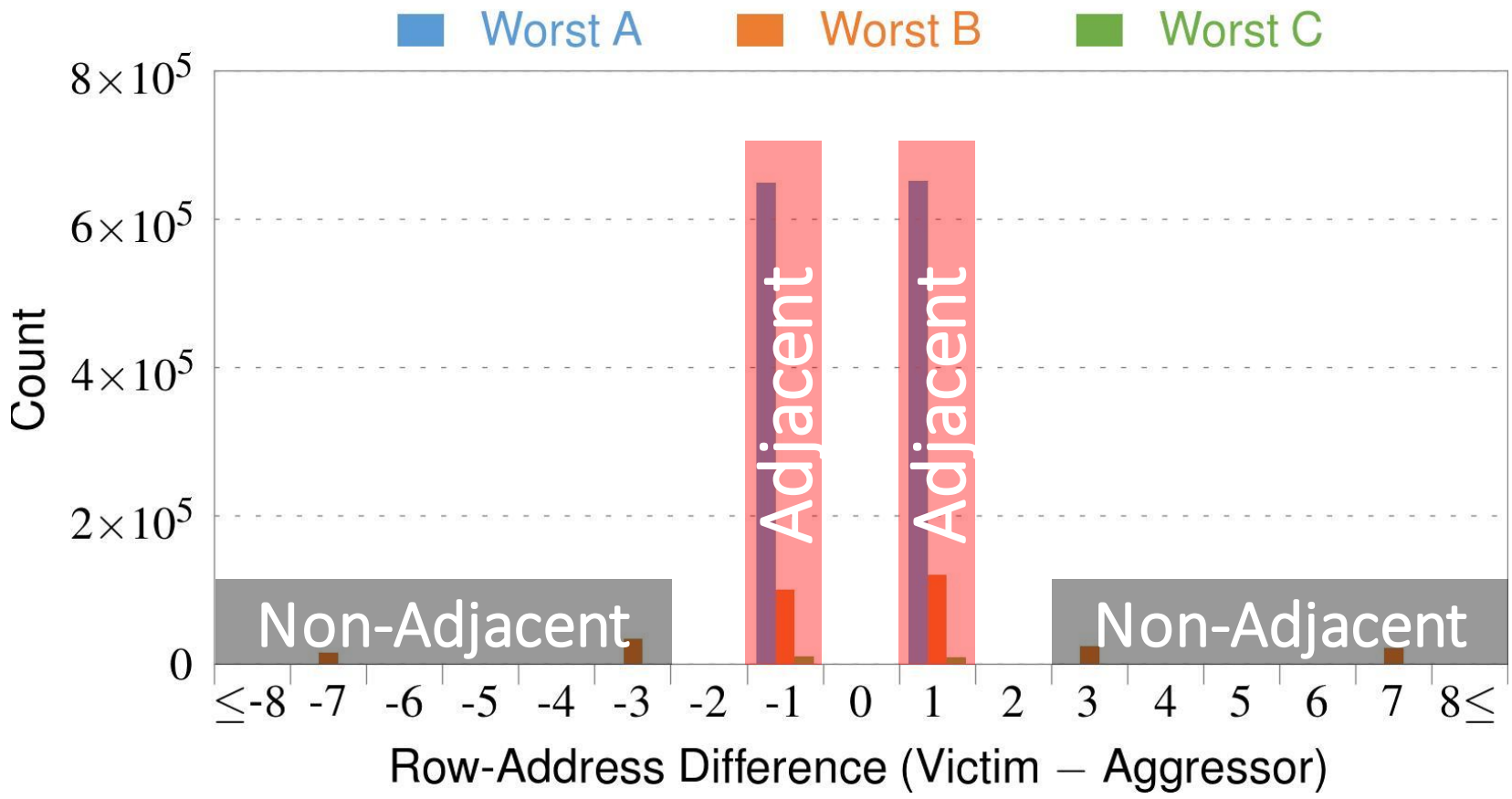
- Two types of errors
  - '1' → '0'
  - '0' → '1'
- A given cell suffers only one type

- Two types of cells
  - True: Charged ('1')
  - Anti: Charged ('0')
- Manufacturer's design choice

- True-cells have only '1' → '0' errors
- Anti-cells have only '0' → '1' errors

Errors are manifestations of charge loss

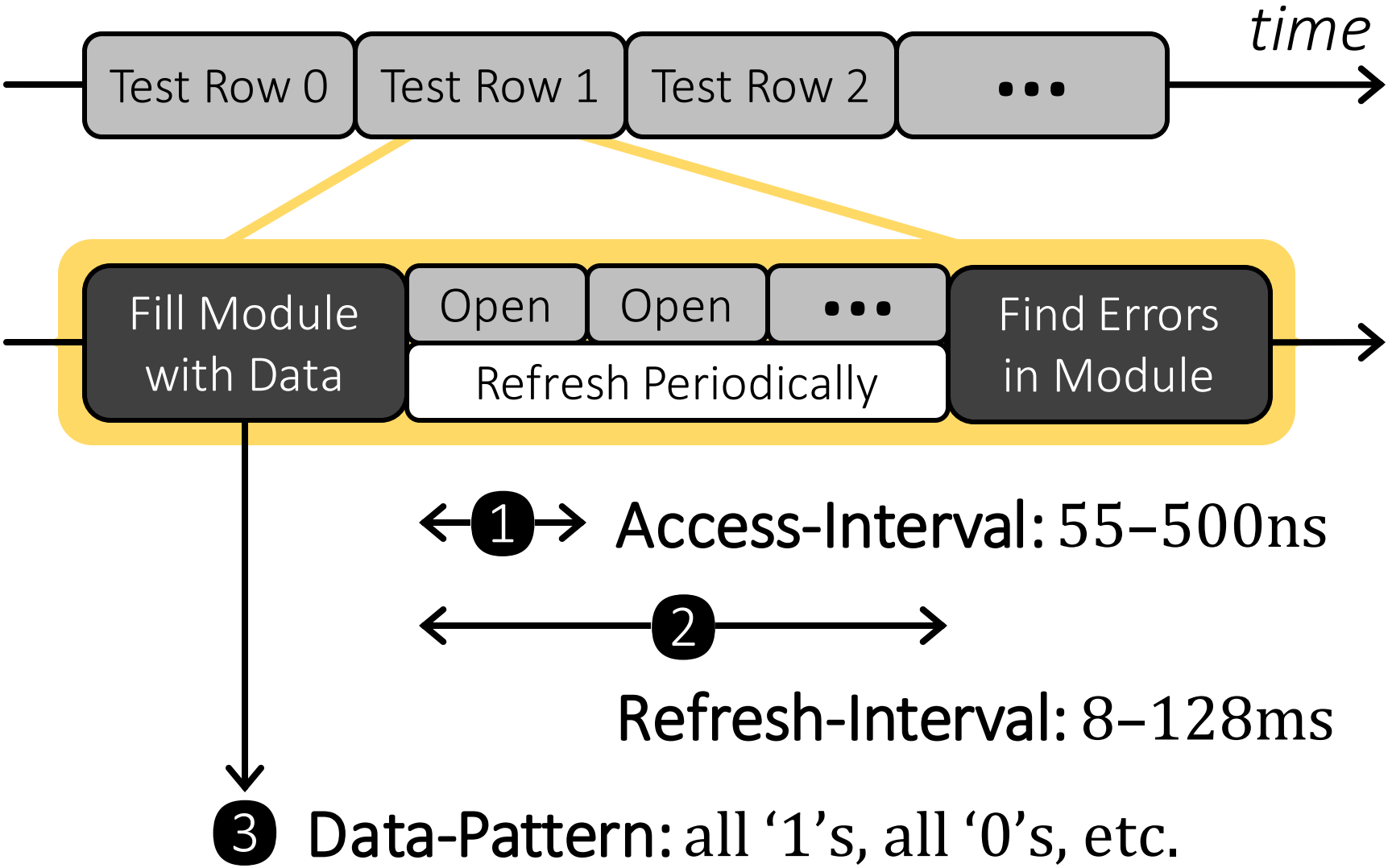
4. Adjacency: Aggressor & Victim



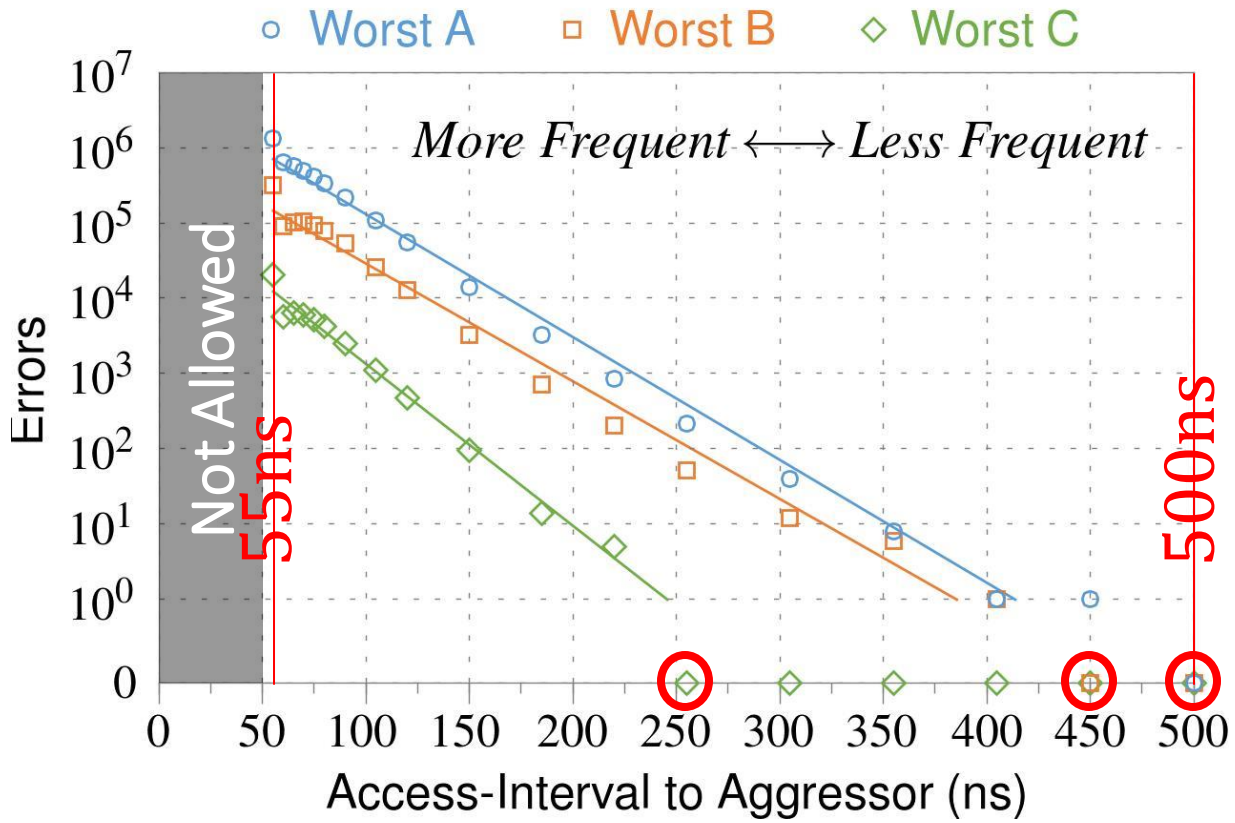
Note: For three modules with the most errors (only first bank)

Most aggressors & victims are adjacent

5. Sensitivity Studies



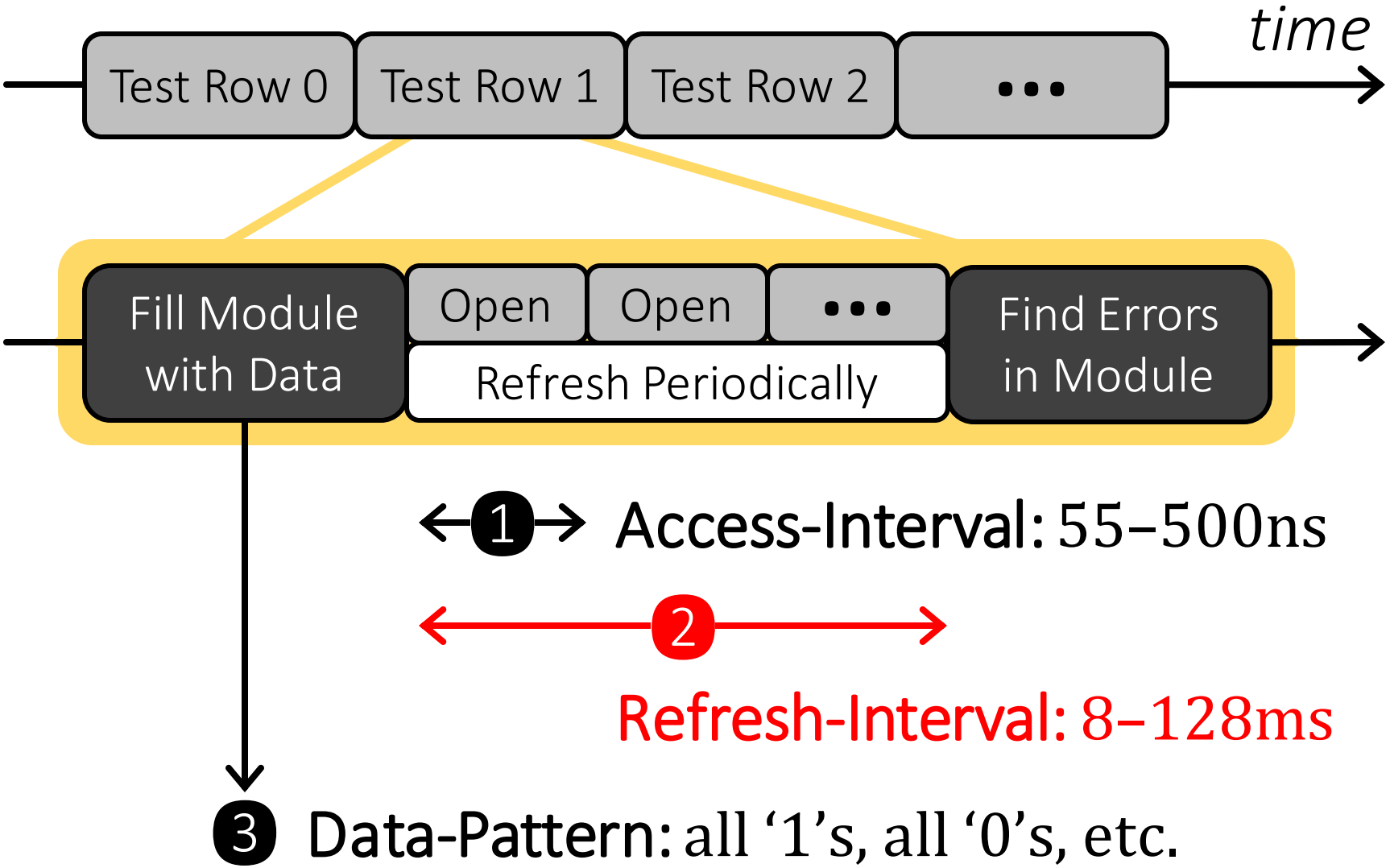
❶ Access-Interval (Aggressor)



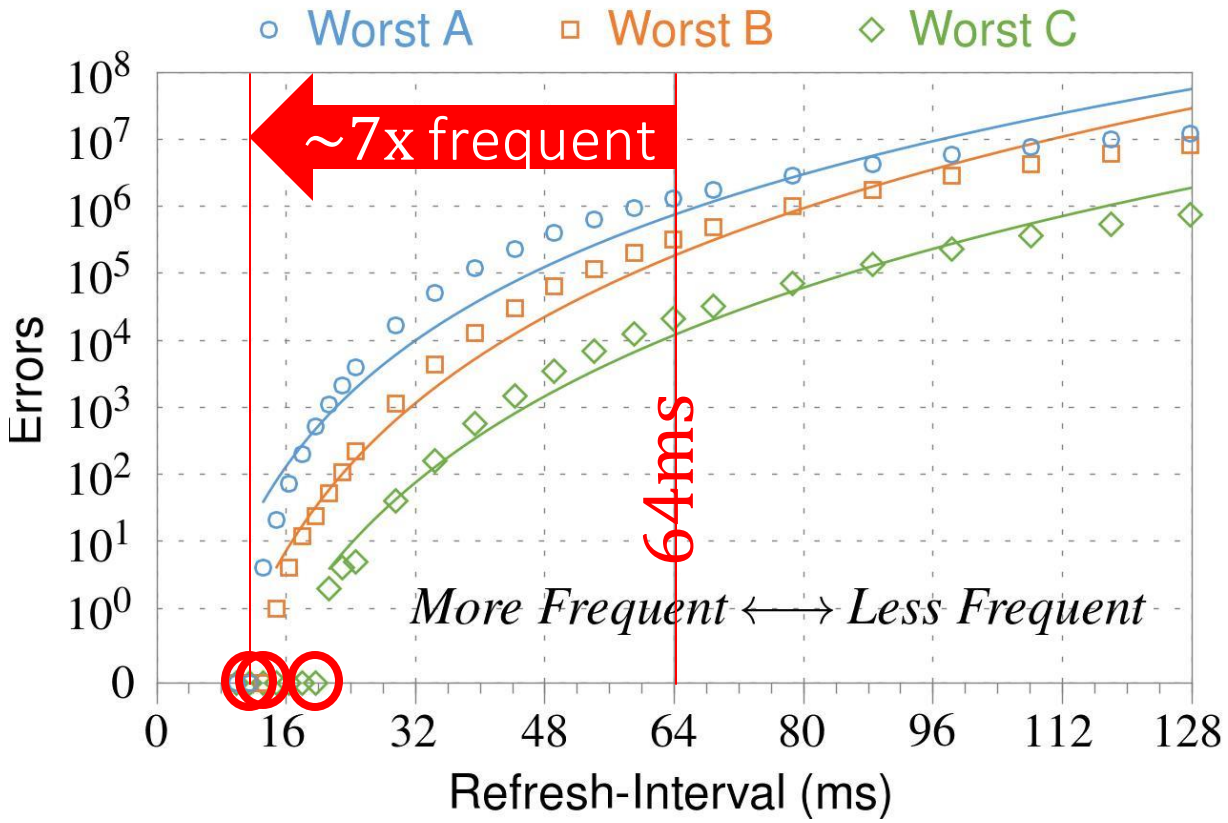
Note: For three modules with the most errors (only first bank)

Less frequent accesses → Fewer errors

5. Sensitivity Studies



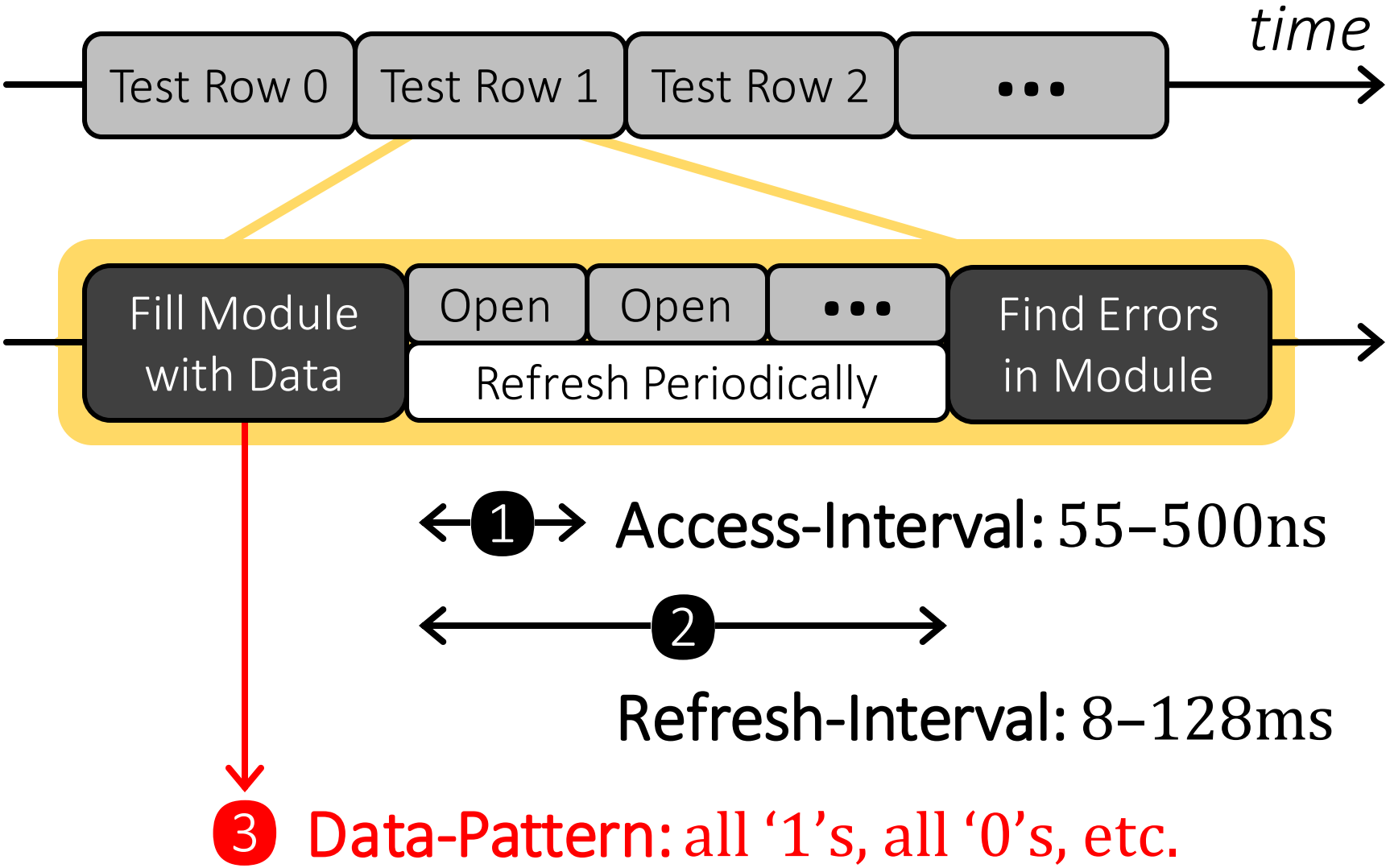
❷ Refresh-Interval



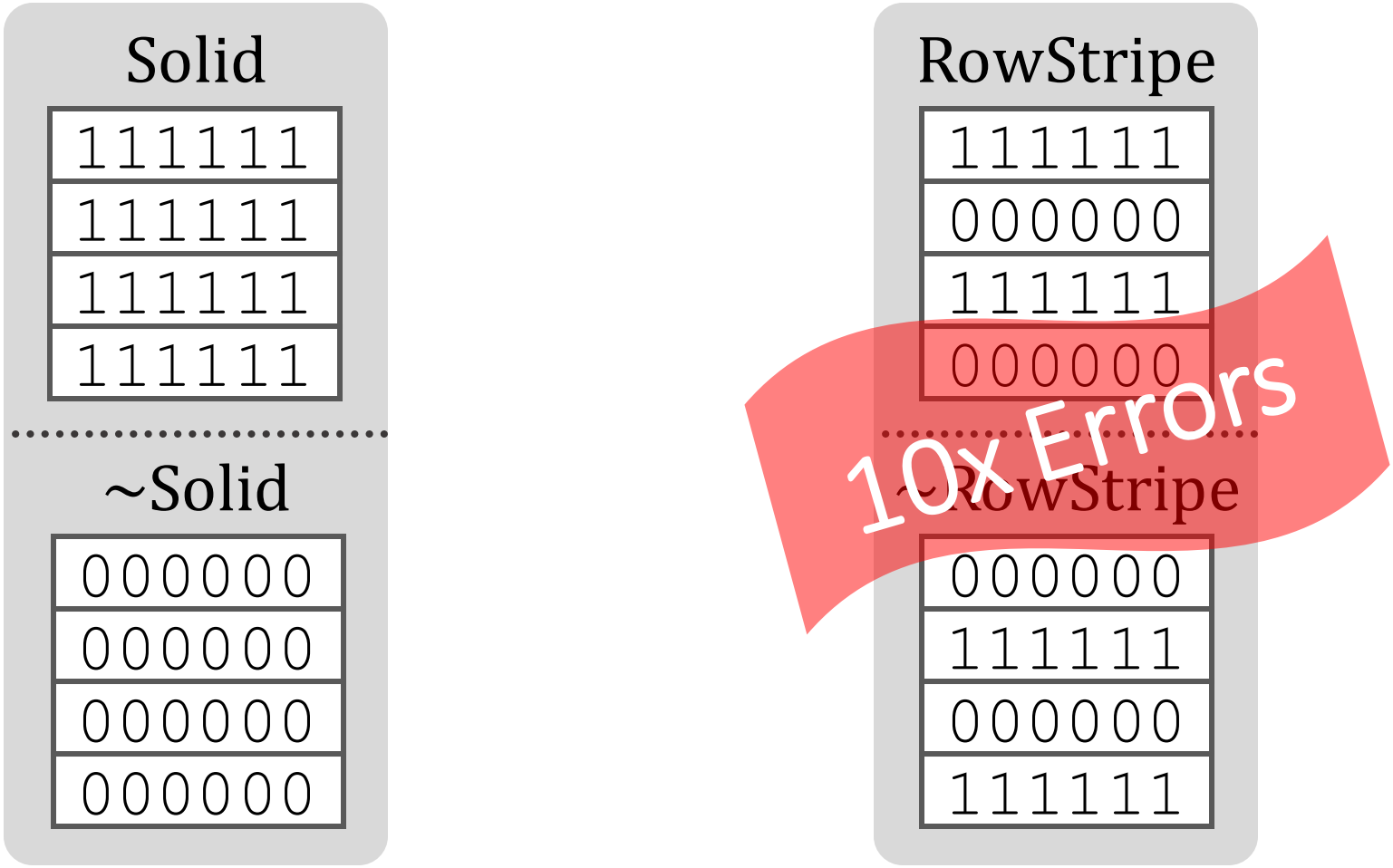
Note: Using three modules with the most errors (only first bank)

More frequent refreshes → Fewer errors

5. Sensitivity Studies



❸ Data-Pattern



Errors affected by data stored in other cells

Naive Solutions

1. *Throttle accesses to same row*
   - Limit access-interval: $\geq 500\text{ns}$
   - Limit number of accesses: $\leq 128\text{K}$ $(=64\text{ms}/500\text{ns})$

2. *Refresh more frequently*
   - Shorten refresh-interval by $\sim 7\text{x}$

Both naive solutions introduce significant overhead in performance and power

Characterization Results

1. Most Modules Are at Risk
2. Errors vs. Vintage
3. Error = Charge Loss
4. Adjacency: Aggressor & Victim
5. Sensitivity Studies
6. Other Results in Paper

6. Other Results in Paper

- *Victim Cells ≠ Weak Cells (i.e., leaky cells)*
  - Almost no overlap between them

- *Errors not strongly affected by temperature*
  - Default temperature: $50°C$
  - At $30°C$ and $70°C$, number of errors changes $<15\%$

- *Errors are repeatable*
  - Across ten iterations of testing, $>70\%$ of victim cells had errors in every iteration

6. Other Results in Paper (cont'd)

- *As many as 4 errors per cache-line*
  - Simple ECC (e.g., SECDED) cannot prevent all errors

- *Number of cells & rows affected by aggressor*
  - Victims cells per aggressor: ≤ 110
  - Victims rows per aggressor: ≤ 9

- *Cells affected by two aggressors on either side*
  - Very small fraction of victim cells (< 100) have an error when either one of the aggressors is toggled

1. Historical Context

2. Demonstration (Real System)

3. Characterization (FPGA-Based)

4. Solutions

Several Potential Solutions

- Make better DRAM chips — Cost
- Refresh frequently — Power, Performance
- Sophisticated ECC — Cost, Power
- Access counters — Cost, Power, Complexity

Our Solution

- **PARA:** *Probabilistic Adjacent Row Activation*
- **Key Idea**
  - After closing a row, we activate (i.e., refresh) one of its neighbors with a low probability: $\mathrm{p} = 0.005$
- **Reliability Guarantee**
  - When $\mathrm{p}=0.005$, errors in one year: 9.4×10^{-14}
  - By adjusting the value of p, we can provide an arbitrarily strong protection against errors

Advantages of PARA

- *PARA refreshes rows infrequently*
  - Low power
  - Low performance-overhead
    - Average slowdown: 0.20% (for 29 benchmarks)
    - Maximum slowdown: 0.75%
- *PARA is stateless*
  - Low cost
  - Low complexity

- *PARA is an effective and low-overhead solution to prevent disturbance errors*

Conclusion

- *Disturbance errors are **widespread** in DRAM chips sold and used today*
- *When a row is opened repeatedly, **adjacent rows leak charge** at an accelerated rate*
- *We propose a **stateless solution** that prevents disturbance errors with low overhead*
- *Due to difficulties in DRAM scaling, **new and unexpected types of failures** may appear*

Flipping Bits in Memory Without Accessing Them

DRAM Disturbance Errors

Yoongu Kim

Ross Daly, Jeremie Kim, Chris Fallin, Ji Hye Lee,
Donghyuk Lee, Chris Wilkerson, Konrad Lai, Onur Mutlu

Carnegie Mellon SAFARI intel

Example: Capacity, Bandwidth & Latency